# SBC 80/10 AND SBC 80/10A SINGLE BOARD COMPUTER HARDWARE REFERENCE MANUAL 

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## PREFACE

This manual provides general information, installation, programming information, principles of operation, and service information for the Intel SBC 80/10 and SBC 80/10A Single Board Computers. Unless specified otherwise, references to the SBC $80 / 10$ are valid for both systems. The areas where differences occur are identified as "SBC $80 / 10$ only" or "SBC $80 / 10 \mathrm{~A}$ only." Additional systems information and component part details are available in the following documents:

- Intel Microcomputer Systems Data Book, Part No. 98-414
- Inte1 8080 Microcomputer Systems User's Manual, Part No. 98-153
- Inte1 Multibus Interfacing Application Note, AP-28.
- Intel 8255 Programmable Peripheral Interface Application Note, AP-15
- Intel 8251 Universal Synchronous/Asynchronous Receiver/Transmitter

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## CHAPTER 1

## INTRODUCTION

The $\operatorname{SBC} 80 / 10$ and $\operatorname{SBC} 80 / 10 \mathrm{~A}$ are members of Intel's complete line of OEM computer systems which take full advantage of Intel's LSI technology to provide economical, self-contained computer based solutions for OEM applications. The SBC $80 / 10$ and SBC $80 / 10 \mathrm{~A}$ are complete computer systems, each on a single $6.75-b y-12$ inch printed circuit card. The CPU, system clock, read/write memory, non-volatile read-only-memory, I/O ports and drivers, serial communications interface, bus control logic and drivers all reside on the board.

Throughout this manual, reference to the $S B C 80 / 10$ are valid for both the SBC $80 / 10$ and $\operatorname{SBC} 80 / 10 \mathrm{~A}$. The areas where differences occur are identified as "SBC 80/10 only" and SBC 80/10A only."

Intel's powerful 8-bit n-channel MOS 8080A CPU, fabricated on a single LSI chip, is the central processor for the $\operatorname{SBC} 80 / 10$ and SBC 80/10A. The 8080A contains six 8-bit general purpose registers and an accumulator. The six general purpose registers may be addressed individually or in pairs providing both single and double precision operators. The 8080 A has a 16 -bit program counter which allows direct addressing of up to 64 K of memory. An external stack, located within any portion of memory, may be used as a last in/first out stack to store and retrieve the contents of the program counter, flags, accumulator and all of the six general purpose registers. A sixteen bit stack pointer controls the addressing of this external stack. This stack provides almost unlimited subroutine nesting. Sixteen-line
address and eight-1ine bi-directional data busses are used to facilitate easy interface to memory and $I / O$.

The powerful 8080A instruction set allows the user to write efficIent programs in a minimum amount of time. The accumulator group instructions include arithmetic and logical operators with direct, register direct, and immediate addressing modes. Move, load, and store instruction groups provide the ability to move either 8 or 16 bits of data between memory, the six working registers and the accumulator using all addressing modes. The ability to branch to different portions of a program is provided with jump, jump conditional, and computed jumps. The ability to conditionally and unconditionally call to and return from subroutines is provided. The RESTART (or single byte call instruction) is used for interrupt operation. Double precision operators such as stack manipulation and double add instructions extend both the arithmetic and interrupt handling capability of the 8080A. The ability to increment and decrement memory, the six general registers, and the accumulator is provided as well as extended increment and decrement instructions to operate on the register pairs and stack pointer.

The difference between the $\operatorname{SBC} 80 / 10$ and $\operatorname{SBC} 80 / 10 \mathrm{~A}$ is in the type and quantity of memory available on each board.

The $\operatorname{SBC} 80 / 10$ contains 1 K 8 -bit words of read/write memory using Intel's 8111 Low Power Static RAMs. Sockets for up to 4 K 8 -bit words of non-volatile read-only memory may be added in 1 K byte increments using Intel's 8708 Erasable and Electrically Reprogrammable ROMs (EPROMs) or Intel's 8308 Metal Masked ROMs.

The SBC 80/10A contains 1 K 8-bit words of read/write memory using Intel's 8102 Low Power Static RAMs. Sockets for up to 4 K or 8 K words of non-volatile read-only memory are provided on the SBC 80/10A. Up to 4 K of read-only memory may be added in 1 K byte increments using Intel's 8708 Erasable and Electrically Reprogrammable ROMs (EPROMs), Intel's 2758 Erasable and Electrically Reprogrammable ROMs (EPROMs), or Intel's 8308 Metal Masked ROMs. Optionally up to 8 K words of read-only memory may be added in 2 K byte increments using Intel's 2716 Erasable and Electrically Reprogrammable ROMs (EPROMs) or Intel's 2316E Metal Masked ROMs.

The SBC $80 / 10$ contains 48 programmable parallel I/O lines implemented using two Intel 8255 Programmable Peripheral Interface devices. The software is used to configure the $\mathrm{I} / 0$ lines in combinations of uni-directional input/output, and bidirectional ports. Therefore, the I/0 interface may be customized to meet specified peripheral requirements. In order to take full advantage of the large number of possible I/O configurations, sockets are provided for interchangable I/O line drivers and terminators. Hence, the flexibility of the $I / 0$ interface is further enhanced by the capability of selecting the appropriate optional line drivers and terminators for each application.

A programmable serial communications interface using Intel's 8251 Universal Synchronous/Asynchronous Receiver/Transmitter (USART) is contained on the board. The USART can be programmed by the systems software to provide virtually any serial data transmission technique presently in use (inciuding IBM Bi-Sync). The mode of operation (i.e., synchronous or asynchronous), data format, control character format, parity, and asynchronous serial transmission rate (within limitations
given later) are all under program control). The 8251 provides full duplex, double buffered transmission and receive capability. Parity, overrun, and framing error detection are all incorporated in the USART. The inclusion of jumper selectable teletype, or RS232C compatible interfaces on the board in conjunction with the USART provide a direct interface to a teletype, CRT, RS232C compatible devices, and asynchronous and synchronous modems.

A single-level interrupt may originate from any one of six sources including the USART, Programmable I/O interface, and two user designated interrupt request lines. When an interrupt request is recognized, a RESTART 7 instruction is generated. The processor responds by suspending program execution and executing a user defined interrupt service routine originating at location $38{ }_{16}$.

Memory and I/O expansion may be achieved using standard Intel boards. Memory may be expanded to 65,536 bytes by adding user specified combinations of SBC 016 16K byte RAM board, SBC 406 6K byte and SBC 416 l6K byte PROM boards. Input/output capacity may be expanded in increments of 4 input ports and 4 output ports using SBC 508 Input/ Output boards. Expandable backplanes and cardcages are available to support multi-board systems.

The development cycle of $\operatorname{SBC} 80 / 10$ based OEM products may be significantly reduced using the Intellec Microcomputer Development System. The resident assembler, text editor, and system monitor greatly simplify the design, development, and debug of SBC 80/10 based system software. A unique In-Circuit Emulator (ICE-80) option provides the capability of executing and debugging OEM system software directly on the $\mathrm{SBC} 80 / 10$.

Intel's high-level language, PL/M, can be used to significantly decrease the time required to develop OEM system software.

FUNCTIONAL DESCRIPTION

For descriptive purposes, the circuitry on the SBC-80/10 can be divided into six functional blocks:

1) CPU Set
2) System Bus Interface
3) Random Access Memory (RAM)
4) Read Only Memory (ROM/PROM) Logic
5) Serial I/O Interface
6) Parallel I/O Interface
as shown in Figure 2-1.
The CPU Set consists of the 8080 A Control Processor, the 8224 Clock Generator and the 8238 System Controller. The CPU set is the heart of the $\mathrm{SBC}-80 / 10$. It performs all system processing functions and provides a stable timing reference for all other circuitry in the system. The CPU Set generates all of the address and control signals necessary to access memory and I/O ports both on the $\mathrm{SBC}-80 / 10$ and external to the $\mathrm{SBC}-80 / 10$. The CPU Set is capable of fetching and executing any of the $8080^{\prime \prime}$ s seventy-eight instructions. The CPU Set responds to interrupt requests originating both on and off the $\mathrm{SBC}-80 / 10$, to HOLD requests from modules wishing to acquire control of the system bus, and to WAIT requests from memory or $I / O$ devices having an access time which is slower than the $8080^{\prime}$ s cycle time.

The System Bus Interface includes an assortment of circuitry which gates interrupt requests, HOLD requests, READY (no wait inputs and the system reset input to the appropriate pins of the CPIJ Set. Other circuits drive the various external system control signals. The


FIGURE 2-1. FUNCTIONAL BLOCK DIAGRAM

System Bus Interface also includes two 8216 bi-directional bus drivers which dri.ve the memory data bus on the SBC-80/10. Six 8226 devices drive the external system data and address busses.

The Random Access Memory (RAM) section provides the SBC $80 / 10$ and SBC 80/10A user with 1024 X 8-bits of on board read/write storage. Eight Intel 8111 Low Power Static RAMs (256 x 4-bit each) are mounted on the SBC 80/10. The SBC 80/10A has eight Intel 8102 Low Power Static RAM chips (1024 x 1-bit each). Both boards contain the necessary acknowledge and memory address decoding logic.

The Read Only Memory (ROM/EPROM) section provides the user with the necessary provisions for installing up to 4096 x 8-bits of ROM or EPROM on the $\operatorname{SBC} 80 / 10$ and up to 8192 x 8 -bits of ROM or EPROM on the $\operatorname{SBC} 80 / 10 \mathrm{~A}$. The $80 / 10$ and $80 / 10 \mathrm{~A}$ have four 24 -pin sockets that can accept either Intel 8708 Erasable and Electrically Reprogrammable ROM (EPROM) chips, or Intel 8308 Metal Masked ROM chips. Optionally, the SBC 80/10A accepts Intel 2716 Erasable and Electrically Reprogrammable ROM (EPROM) chips, Inte1 2758 Erasable and Electrically Reprogrammable ROM (EPROM) chips, or Intel 2316 E Metal Masked ROM chips. The total ROM/EPROM memory capacity using 8208,8308 or 2758 chips is 4 K x 8 -bits and 8 K x 8 -bits using 27.16 or 2316 E chips. Both the $80 / 10$ and $80 / 10 \mathrm{~A}$ boards include the necessary acknowledge and memory address decoding circuitry.

The Serial I/O Interface, using Intel's 8251 USART device, provides a bi-directional serial data communications channel that can be programmed to operate with most of the current serial data transmission protocols. Synchronous or asynchronous mode, buad rate, character length, number of stop bits and the choice of even, odd or no parity are all program selectable. The user also has the option of configurating the Serial I/O Interface as an EIA RS232 interface or as a Teletype-compatible current loop interface.

The Paralle1 I/O Interface, using two Intel 8255 Programmable Peripheral interface devices, provides 48 signal lines for the transfer and control of data to or from peripheral devices. Eight lines already have a bidirectional driver and termination network permanently installed. This bidirectional network allows these eight lines to be inputs, outputs, or bidirectional (selected via jumpers). The remaining 40 lines, however, are uncommitted. Sockets are provided for the installation of drivers or termination networks as required to meet the specific needs of the user system.

## CHAPTER 3

## THEORY OF OPERATION

In the preceding chapter we introduced each of the $\mathrm{SBC}-80 / 10$ functional blocks and defined what each block was capable of doing. In this chapter we shall go one step further and describe how each block performs its particular function(s). The text will constantly refer to the $S B C-80 / 10$ schematics, provided in Appendix $A$.

Note: Both active-high (positive true) and active-low (negative true) signals appear on the $S B C-80 / 10$ schematics. To eliminate any confusion when reading this chapter, the following convention will be adhered to: whenever a signal is active-low, its mnemonic is followed by a slash; for example, MRDC/ means that the level on that line will be low when the memory read command is true (active). If the signal is subsequently inverted, thus making it active-high, the slash is omitted; for example, MRDC means that the level on that line will be high when the memory read command is true.

### 3.1 THE CPU SET

The CPU Set consists of three Intel ${ }^{\circledR}$ integrated circuit devices:

* 8080A Central Processor Unit
* 8224 Clock Generator
* 8238 System Controller
and an 18.432 MHz crystal that establishes the frequency of oscillation for the 8224 device via a 10 pF capacitor, as shown in Figure 3-0. Together, the elements in the CPU Set perform all central processing functions. The following paragraphs describe how the elements within the CPU Set interact with all other logic on the SBC-80/10. The interaction between the IC's within the CPU Set, however, is not described. Instead, the reader is referred to the Intel ${ }^{\circledR}$ "8080 Microcomputer Systems User's Manual" for a detailed description of the 8080,8224 and 8238 devices.


FIGURE 3-0. THE CPU SET

The CPU Set is shown on sheet 1 of the $\mathrm{SBC}-80 / 10$ schematic (Appendix A).

### 3.1.1 INSTRUCTION TIMING

The activities of the CPU Set are cyclical. The CPU fetches an instruction, performs the operations required, fetches the next instruction, and so on. This orderly sequence of events requires precise timing. The 8224 Clock Generator, provides the primary timing reference for the CPU Set. The crystal in conjunction with a 10 pF capacitor tunes an oscillator within the 8224 to precisely 18.432 MHz . The 8224 "divides" the oscillations by nine to produce two-phase timing inputs ( $\phi 1$ and $\phi 2$ ) for the 8080. The $\phi 1$ and $\phi 2$ signals define a cycle of approximately 488 ns . duration. A TTL level phase 2 ( $\varnothing 2$ TTL) signal is also derived and made available to external logic. In addition, the output of the oscillator is buffred and brought out on OSC so that other system timing signals can be derived from this stable, crystal controlled source (e.g., the serial I/O baud rate is derived from OSC). All processing activities of the CPU Set are referred to the period of the $\phi_{1}$ and $\phi 2$ clock signals.

Within the 8080 CPU Set, an instruction cycle is defined as the time required to fetch and execute an instruction. During the fetch, a selected instruction (one, two or three bytes) is extracted from memory and deposited in the CPU's operating registers. During the execution part, the instruction is decoded and translated into specific processing activities.

Every instruction cycle consists of one, two, three, four or five machine cycles. A machine cycle is required each time the CPU accesses
memory or an I./O port. The fetch portion of an instruction cycle requires one machine cycle for each byte to be fetched. The duration of the execution portion of the instruction cycle depends on the kind of instruction that has been fetched. Some instructions do not require any machine cycles other than those necessary to fetch the instruction; other instructions, however, require additional machine cycles to write or read data to/from memory or $I / O$ devices.

Each machine cycle consists of three, four or five states. A state is the smallest unit or processing activity and is defined as the interval between two successive positive-going transitions of the $\not \varnothing_{1}$ clock pulse.

There are three exceptions to the defined duration of a state. They are the WAIT state, the hold (HLDA) state and the halt (HLTA) state. Because the WAIT, the HLDA, and the HLTA states depend upon external events, they are by their nature of indeterminate length. Even these exceptional states, however, must be synchronized with the pulses of the driving clock. Thus the duration of all states, including these, are integral multiples of the clock pulse.

To summarize, then, each clock period marks a state; three to five states summarize a machine cycle; and one to five machine cycles comprise an instruction cycle. A full instruction cycle requires anywhere from four to seventeen states for its completion, depending on the kind of instruction involved.

There is just one consideration that determines how many machine cycles are required in any given instruction cycle: the number of times that the processor must reference a memory address or an $1 / O$ address, in order to fetch and execute the instruction. Likc many processors, the 8080 is so constructed that
it transmits one address per machine cycle. Thus, if the fetching and execution of an instruction requires two memory references, then the instruction cycle associated with that instruction consists of two machine cycles. If five such references are called for, then the instruction cycle contains five machine cycles.

Every instruction cycle has at least one reference to memory, during which the instruction is fetched. An instruction cycle must always have a fetch, even if the execution of instruction requires no further references to memory. The first machine cycle in every instruction cycle is therefore a FETCH. Beyond that, there are no fast rules. It depends on the kind of instruction. The input (INP) and the output (OUT), instructions each require three machine cycles: a FETCH, to obtain the instruction; a MEMORY READ, to obtain the address of the object peripheral; and an INPUT or an OUTPUT machine cycle. to complete the transfer.

Every machine cycle within an instruction cycle consists of three to five active states (referred to as $\mathrm{T} 1, \mathrm{~T} 2, \mathrm{~T} 3, \mathrm{~T} 4$, and T 5 ). The actual number of states depends upon the instruction being executed, and on the particular machine cycle within the greater instruction cycle. Figure 3-1 shows the timing relationships in a typical FETCH machine cycle. Events that occur in each state are referred to transitions of the $\phi 1$ and $\phi 2$ clock pulses.

At the beginning of each machine cycle (in state T1), the 8080 activates its SYNC output and issues status information on its data bus. The 8224 accepts SYNC and generates an active-low status strobe (STSTB/) as soon as the status data is stable on the data bus. The status information indicates the type of machine cycle in progress.


FIGURE 3-1. TYPICAL FETCH MACHINE CYCLE

The 8238 System Controller accepts the status bits from the 8080 and STSTB/ from the 8224 , and uses them to generate the appropriate control signals (MEMR/, MEMW/, IOR/ and IOWR/) for the current machine cycle.

The rising edge of $\varnothing 2$ during T1 loads the processor's address lines ( $A 0$ - A15). These lines become stable within a brief delay of the $\varnothing 2$ clocking pulse, and they remain stable until the first $\varnothing 2$ pulse after state $T 3$. This gives the processor ample time to read the data returned from memory.

Once the processor has sent an address to memory, there is an opportunity for the memory to request a WAIT. This it does by pulling the 8224's RDYIN line low. As long as the RDYIN line remains low, the CPU Set will idle, giving the memory time to respond to the addressed data request. The 82.24 synchronizes $R D Y I N$ with internal processor timing and applies the result to the $8080^{\circ}$ s READY input. The processor responds to a wait request by entering an alternative state (TW) at the end of $T 2$, rather than proceeding directly to the $T 3$ state. $A$ wait period may be of indefinite duration. The 8080 remains in the waiting condition until its READY line again goes high. The cycle may then proceed, beginning with the rising edge of the next $\not \varnothing 1$ clock. A WAIT interval will therefore consist of an integral number of TW states and will always be a multiple of the clock period.

The events that take place during the T3 state are determined by the kind of machine cycle in progress. In a FETCH machine cycle, the CPU Set interprets the data on its data bus as an instruction. During a MEMORY READ, signals on the same bus are interpreted as a data word.

The CPU Set itself outputs data on this bus during a MEMORY WRITE machine cycle. And during $I / O$ operations, the CPU Set may either transmit or receive data, depending on whether an INPUT or an OUTPUT operation is involved. Consider the following two examples.

Figure 3-2 illustrates the timing that is characteristic of an input instruction cycle. During the first machine cycle (M1), the first byte of the two-byte $I N$ instruction is fetched from memory. The 8080 places the 16 -bit memory address on the system bus near the end of state T1. The 8238 activates the memory read control signal (MEMR/) during states T 2 and T 3 (and any intervening wait states, if required). During the next machine cycle (M2), the second byte of the instruction is fetched. During the third machine cycle (M3), the IN instruction is executed. The 8080 duplicates the 8 -bit $1 / 0$ address on address lines ADRO-7 a`d ADR8-F. The 8238 activates the $I / 0$ read control signal (IOR/) during states $T 2$ and $T 3$ of this cycle. In all cases the system bus enable input (BUSEN/) to the 8238 allows for normal operation of the data bus buffers and the read/write control signals. If BUSEN/ goes high the data bus output buffers and control signal buffers are forced into a high-impedance state.

Figure 3-3 illustrates an instruction cycle during which the CPU Set outputs data. During the first two machine cycles (M1 and M2), the CPU Set fetches the two-byte OUT instruction. During the third machine cycle (M3), the OUT instruction is executed. The 8080 duplicates the 8-bit $\mathrm{I} / \mathrm{O}$ address on lines ADRO-7 and ADR8-F. The 8238 activates an advanced $I / O$ write control signal (IOWR/) at the beginning of state $T 2$ of this cycle. The nature and implications of the 8238 timing


FIGURE 3-2. INPUT INSTRUCTION CYCLE


FIGURE 3-3. OUTPUT INSTRUCTION CYCLE
will be explained later (p. 3-17). The 8238 outputs the data onto the system bus at the end of state T 2 . Data on the bus remains stable throughout the remainder of the machine cycle. BUSEN/ must be low to prevent the output and control buffers from being forced into the highimpedance state.

Observe that a RDYIN signal is necessary for completion of an output machine cycle. Unless such an indication is present, the processor enters the TW state, following the T2 state. Data on the output lines remains stable in the interim, and the processing cycle will not proceed until the RDYIN line again goes high.

The 8080 generates a WR/ output for qualification of the advanced I/O write (IOWR/) and memory write (MEMW/) control signals from the 8238, during those machine cycles in which the CPU Set outputs data. The negative-going leading edge of WR/ is referred to the rising edge of the first $\varnothing 1$ clock pulse following T2. WR/ remains low until re-triggered by the leading edge of $\varnothing 2$, during the state following T3. Note that any TW states intervening between T2 and T3 of the output machine cycle will necessarily extend WR/.

All processor machine cycles consist of at least three states: T1, T2, and T3 as just described. If the CPU Set has to wait for a RDY IN response, then the machine cycle may also contain one or more TW states. During the three basic states, data is transferred to or from the CPU Set.

After the T 3 state, however, it becomes difficult to generalize. T4 and T5 states are available, if the execution of a particular instruction requires them. But not all machine cycles make use of these states. It depends upon the kind of instruction being executed, and
on the particular machine cycle within the instruction cycle. The processor will terminate any machine cycle as soon as its processing activities are completed, rather than proceeding through the $T 4$ and T5 states every time. Thus the 8080 may exit a machine cycle following the $T 3$, the $T 4$, or the $T 5$ state and proceed directly to the $T 1$ state of the next machine cycle.

### 3.1.2 INTERRUPT SEQUENCES

The 8080 has the built-in capacity to handle external interrupt requests. Peripheral logic can initiate an interrupt simply by driving the processor ${ }^{\text { }} \mathrm{s}$ interrupt (INT) line high. The interrupt (INT) input is asynchronous, and a request may therefore originate at any time during any instruction cycle. Internal logic re-clocks the external request, so that a proper correspondence with the driving clock is establishec'. An interrupt request (INT) arriving during the time that the interrupt enable line (INTE) is high, acts in coincidence with the $\varnothing 2$ clock to set the internal interrupt latch. This event takes place during the last state of the instruction cycle in which the request occurs, thus ensuring that any instruction in progress is completed before the interrupt can be processed.

The INTERRUPT machine cycle which follows the arrival of an enabled interrupt request resembles an ordinary $F E T C H$ machine cycle in most respects. The contents of the program counter are latched onto the address lines during $T 1$, but the counter itself is not incremented during the INTERRUPT machine cycle, as it otherwise would be. In this way, the pre-interrupt status of the program counter is preserved, so that data in the counter may be saved in the stack.

This in turn permits an orderly return to the interrupted program after the interrupt request has been processed.

Because the $8238^{\prime}$ s INTA/ output (pin 23) is tied to +12 volts, the 8238 blocks incoming data and automatically inserts a Restart (RST 7) instruction onto the 8080 data bus during state T3, when the interrupt is acknowledged by the 8080. RST is a special onebyte call instruction that facilitates the processing of interrupts (the ordinary program call instruction is three bytes long). The RST 7 instruction causes the 8080 to branch program control to the instruction being stored in memory location $38{ }_{16}{ }^{\circ}$

### 3.1.3 HOLD SEQUENCES

By activating the $8080^{\text {t }}$ s HOLD input, an external device can cause the CPU Set to suspend its normal operations and relinquish control of the address and data busses. The CPU Set responds to a request of this kind by floating its address and data outputs, so that these exhibit a high impedance to other devices sharing the busses. At the same time, the processor acknowledges the HOLD by placing a high on on its HLDA output pin. During an acknowledged HOLD, the address and data busses are under control of the peripheral which originated the request, enabling it to conduct off board memory transfers without processor intervention.

### 3.1.4 HALT SEQUENCES

When a halt instruction (HLT) is executed, the 8080 enters the halt state after state $T$ 2 of the next machine cycle. There are only three ways in which the 8080 can exit the halt state:

- A high on the 8224 reset input (RESIN/) will always reset the 8080 to state T1; reset also clears the program counter.
- A HOLD input will cause the 8080 to enter the hold state, as previously described. When the HOLD line goes low, the 8080 re-enters the halt state on the rising edge of the next $\emptyset 1$ clock pulse.
. An interrupt (i.e., INT goes high while INTE is enabled) will cause the 8080 to exit the halt state and enter state $T 1$ on the rising edge of the next $\varnothing 1$ clock pulse. NOTE: The interrupt enable (INTE) flag must be set when the halt state is entered; otherwise, the 8080 will only be able to exit via a reset signal.


### 3.1.5 START-UP SEQUENCE

When power is applied initially to the 8080 , the processor begins operating immediately. The contents of its program counter, stack pointer, and the other working registers are naturally subject to random factors and cannot be specified. For this reason, the CPU Set power-up sequence begins with a reset. An external RC network is connected to the $8224^{\prime}$ 's RESIN/ input. The slow transition of the power supply rise is sensed by an internal Schmitt Trigger which converts the slow transition into a clean, fast edge on the RESIN/ line when the input level reaches a predetermined value.

An active RESIN/ input to the 8224 produces a synchronized RESET signal which restores the processor's internal program counter to zero. Program execution thus begins with memory location zero, following
a reset. Systems which require the processor to wait for an explicit start-up signal will store a halt instruction (HLT) after enabling interrupts in this location. A manual or an automatic INTERRUPT will be used for starting. In other systems, the processor may begin executing its stored program immediately. Note, however, that the reset has no effect on status flags, or on any of the processor's working registers (accumulator, indices, or stack pointer). The contents of these registers remain indeterminate, until initialized explicitly by the program.

In addition to generating a RESET signal, the RESIN/ input causes the $8224^{\prime} \mathrm{s}$ status strobe (STSTB/) output to remain true (low). This allows both the 8080 and 8238 to be reset by a power-up sequence or an externally generated RESIN/ condition.

### 3.2 SYSTEM BUS INTERFACE LOGIC

The System Bus Interface logic consists of three general groups of circuitry:

1) assorted gates that accept the various bus control signals, the interrupt request lines, the ready indications and then applies these signals to the CPU Set,
2) the system bus drivers, and
3) the Failsafe circuitry which generates an acknowledgment during interrupt sequences and during those cycles in which an acknowledgment is not returned because a non-existent device was inadvertently addressed.

Each group is described in the following paragraphs.

### 3.2.1 SYSTEM CONTROL SIGNAL LOGIC

Interrupt Requests:
Four interrupt request 1 ines are ORed together at A17-6 (ref. Appendix
A) and applied to the $8080^{\prime}$ s INT input. Two of the interrupt request
lines are from external sources: EXT INTR $1 /$ which enters the $\operatorname{SBC}-80 / 10$
at connector J1 pin 49 and EXT INTR 2/ which enters the SBC-80/10 at P1-42. The other two interrupt requests originate on the $S B C-80 / 10$ : INT 55/ is an interrupt request from ports 1 or 2 in the parallel I/O Interface (see Section 3.6.2); and INT 51/ is an interrupt request from the 8251 USART in the Serial I/O Interface (see Section 3.5.4).

Hold Requests:
If the $\mathrm{SBC}-80 / 10$ is operating in a system with other modules sharing a common external bus, another module can acquire control of the external bus by activating the $8080^{\text {'s }}$ HOLD/ input (connector pin P1-15). HOLD/ is inverted and applied to the 8080's HOLD pin. As described in Section 3.1.3, the 8080 will subsequently activate its hold acknowledge (HLDA) output. HLDA is, in turn, latched by a 74LS74 flip flop (at A29). The Q output from the D-type latch (DHLDA) disables the 8097 circuits (A47) that drive the external read/ write control outputs: MRDC/, MWTC/, IORC/ and IOWC/. DHLDA also disables the external system address and data bus drivers by asserting a high at their active-low chip select (CS/) input pins. As a result of DHLDA, all of the above-mentioned drivers enter the highimpedance state. The $\bar{Q}$ output from the DHLDA output informs other modules of this condition via the BUSY/ output (connector pin P1-17). BUSY/ is driven by transistor Q5.

## System Reset:

Connector pin P1-14 on the $\mathrm{SBC}-80 / 10$ can be used to accept an externally generated SYSTEM RESET signal and to transfer a SBC-80/10
generated RESET signal to other modules in the system. If jumper pair 54-55 is connected, a RESET from the 8224 will be gated through the Q4 transistor to connector pin P1-14, thus resetting other modules in, the system during power-up sequences. An externally generated SYSTEM RESET is accepted at P1-14, buffered, applied to the $8080^{\circ} \mathrm{s}$ RESET input and made available to other logic on the SBC-80/10.

I/O Ready Generation
During each serial or parallel I/O cycle, a "ready" indication (IORDYIN/) is returned to the CPU Set. The three chip select lines for the 8251 and the two 8255 devices are ORed together (at A17-8 on sheet 3 of the schematic). The resultant output is then NANDed (at A44-11) with the $I / O$ read (IOR) or the advanced $I / O$ write (ADV IOW) signal to produce IORDYIN/. Recall from Section 3.1 that the 8238 System Controller (in the CPU Set) generates the I/O write control output at the beginning of all $\mathrm{I} / \mathrm{O}$ write cycles. The IOW/ signal occurs earlier than the 8080's WR/ output. The 8238's IOW/ signal, alone, is labeled ADV IOW/. IOW/ is also synchronized with the $8080^{\circ}$ s WR/ output to produce the system write command IOWC/. ADV IOW/ allows the ready indication to be returned early enough to avoid an unnecessary wait state (see Figure 3-4). The IOWC/ signal causes an I/O device to actually write the data, later in the $\mathrm{I} / \mathrm{O}$ cycle.

## Ready Inputs:

Recall from Section 3.1.1 that the CPU Set must see a ready indication before proceeding to internal state T 3 during all machine cycles. The 74520 section at A57 on sheet 1 of the schematic $O R^{\prime} s$
the following ready indications:

1) INT ACK/ or TIME OUT ACK/ from the Failsafe logic (see Section 3.2.3),
2) IORDYIN/ from the Serial and Parallel I/O Interfaces,
3) PROM RDYIN/ from the ROM/PROM logic (see Section 3.4), and
4) RAM RDYIN/ from the RAM section (see Section 3.3). The resultant output indicates an on-board memory or $1 / 0$ access and is used to disable the external data bus drivers at A53 and A54. This output from A57-8 is also ORed (at A30-3) with the externally generated AACK/ (connector pin P1-25) and $\mathrm{XACK} /$ (connector pin P1-23) inputs. The output from A30-3 is then applied to the CPU Set's RDYIN input (pin 3 on the 8224). When the SBC-80/10 CPU Set accesses an extermal module, the $A A C K /$ or $X A C K /$ input informs the CPU Set that the external device is ready. AACK/ is an advanced acknowledge that allows certain OEM modules to be accessed faster.

Figure 3-4 illustrates basic timing for the ready indications.

Bus Clock Generation:
The OSC output from the CPU Set ( 18.432 MHz frequency) is applied to the clock input of a 74LS74 D-type flip flop (at A29-11 on sheet 1 of the schematic). The $\bar{Q}$ output from this latch is tied to its own D input. Consequently, the $Q$ output exhibits half the frequency of the OSC input. This 9.216 MHz output is buffered and made available to external modules on the common clock (CCLK/) line (via connector pin P1-31) and the bus clock (BCLK/) line (via connector pin P1-13).

### 3.2.2 SYSTEM BUS DRIVERS

The SBC-80/10 internal memory data bus (DMO-DM7) is driven by


FIGURE 3-4. READY TIMING
two 8216 bidirectional bus drivers, shown at A55 and A56 on sheet 3 of the schematic. All data being transferred to/from the RAM memory (see Section 3.3) or ROM/PROM memory (see Section 3.4) is routed through these two devices. The chip select (CS/) input is provided by the MEM CMD/ signal which is the result of ORing RAM RDYIN/ and PROM RDYIN/. The direction enable (DIEN) input to the $826^{\prime \prime} \mathrm{s}$ is provided by the memory read (MEMR) signal.

When the $\mathrm{SBC}-80 / 10$ communicates with an external module, the data is driven by two 8226 bidirectional data bus drivers at A53 and A54 on sheet 1 of the schematic. The direction input to the $8226^{\prime \prime}$ s is provided by the $O R$ of memory read (MEMR) and I/O read (IOR). The 8226 devices will be disabled during 8080 HOLD sequences. The eight data bus lines to the 8226 bus drivers enter/leave the SBC-80/10 via the P1 edge connectnr.

The external 16 -bit system address bus is driven by four 8226 bidirectional bus drivers. However, because the direction enable pin (EN/) on these 8226 devices is tied to ground, they can only be used to transmit addresses to external modules; they will not receive addresses from external modules. Consequently, the $\mathrm{SBC}-80 / 10$ can access other modules, but other modules cannot access the memory or I/O controllers on the $\mathrm{SBC}-80 / 10$. Like the data bus drivers, these 8226 devices are disabled during 8080 HOLD sequences.

### 3.2.3 FAILSAFE TIMER

When the 8080 acknowledges an interrupt request, the 8238 System Controller "forces" an RST 7 instruction onto the 8080's data bus
(see Section 3.1.2). In order to read this RST 7 instruction, however, the 8080 must sense a ready indication. The 8080 acknowledges an interrupt by setting status bit 0 (DO) during the status output portion of each machine cycle (i.e., when STATUS STROBE is true). When this occurs, the 9602 one-shot (shown at A28 on sheet 5 of the schematic) is reset causing a low signal on its output (INTR ACK/). This output is then gated through to the RDYIN pin on the 8224 as described in Sections 3.2.1.

The Failsafe timer also performs another function. If the CPU Set tries to access a memory or $I / O$ device but that device, for some reason, does not return a ready indication, then the 8080 remains in a wait state until ready is received. The Failsafe timer is designed to prevent hanging the system up in this way. The 9602 one-shot is triggered by STATUS STROBE at the beginning of each machine cyclı. If the one-shot is not re-triggered (i.e., if another cycle does not begin) within 9 ms ., then the 9602 times out and its output (also labeled TIME OUT ACK/) is gated through to the RDYIN pin on the 8224, thus allowing the 8080 to exit the wait state. This can be very helpful during system debugging.

### 3.3 RANDOM ACCESS MEMORY (RAM)

The Random Access Memory (RAM) provides the user with 1024
(1K) x 8-bits of read/write storage that requires no clocks or refresh to operate. The SBC $80 / 10$ and $\operatorname{SBC} 80 / 10 \mathrm{~A}$ utilize two different configurations, therefore each configuration is discussed separately in paragraphs 3.3.1 and 3.3.2.

### 3.3.1 SBC 80/10 RAM

The RAM logic consists of eight Intel 8111256 x 4-bit Low Power Static RAM chips, an Intel 3205 three-to-eight decoder for chip selection and assorted gates as shown on sheet 2 of the SBC80/10 schematic (Figure A-1).

The 8111 RAM devices used on the SBC $80 / 10$ have a maximum access time of 500 nsec . Each chip has eight address inputs (A0-A7) that select one of the 256 four-bit segments, active-10w write (W/) and chip enable (CE/) inputs and an output disable (OD) input. Each chip also has four common data input/output pins (I/01-I/04). A high on the OD input disables output and allows the $I / O$ pins to be used for input. During memory read accesses, the data is read out nondestructively and has the same polarity as the input data.

The least significant system address lines (ADR0-ADR7) are applied to the eight address input pins on each 8111 RAM. F.ae most significant eight system address lines (ADR8-ADRF) feed a 3205 decoder. Each of the four most significant decoder outputs are applied to the chip enable (CE/) inputs on two RAM chips. One RAM in each pair reads or writes data bits 0 to 3 (DMO-DM3) while the other RAM reads or writes data bits 4 to 7 (DM4-DM7) for each RAM access. One of the decoder outputs will be activated (low) whenever the value on the system address bus is within the range 3C00-3FFF (hexadecimal).

During memory write cycles, the advanced memory write signal (ADV MEMW/) is applied to the write input (W/) on each RAM. A high on the active-1ow memory read line (MEMR/) allows the selected RAM's I/O pins to be used to accept the data which is to be written into the addressed location. During memory read cycles, the level on ADV MEMW/ is high but is low on MEMR / thus allowing the addressed data to be ready out and onto the data bus.

During all RAM access cycles, the active decoder output is NANDed with ADV MEMW or MEMR (at A44-3) to produce a ready indication for the CPU Set (RAM RDYIN/). The 8238 System Controller (see Section 3.1) generates $A D V$ MEMW or MEMR early enough in the memory cycle to allow RAM RDYIN/ to appear at the CPU Set in time to prevent the occurrence of any wait states. Figure 3-5 illustrates RAM access timing.

Whenever SBC $80 / 10$ RAM is accessed, the data is transferred to/ from the RAM chips on the memory data bus (DM0-DM7). Lines DM0-DM7 are interfaced to the system data bus through two Intel 8216 bidirectional bus drivers (shown at A55 and A56 on sheet 3 of the schematic) as described in Section 3.2.

### 3.3.2 SBC 80/10A RAM

The SBC 80/10 RAM logic consists of eight Intel 81021024 x 1-bit Low ${ }^{\text {Power }}$ Static RAM chips, an Intel 3205 three-to-eight decoder, and assorted gates as shown on sheet 2 of the SBC $80 / 10 \mathrm{~A}$ schematic (Figure A-2).

The 8102 RAM devices used on the SBC $80 / 10 \mathrm{~A}$ have a maximum access time of 450 nsec . Each RAM chip has ten address inputs (ADRO-ADR9) that select one of the 1024 bits, an active low write (ADV MEMW/) and chip enable. A high on the ADV MEMW/ input allows a memory read access.

The ten least significant address lines (ADRO-ADR9) are applied to the ten address input pins on each 8102 RAM. The six most significant address lines (ADRA-ADRF) feed a 3205 decoder. The output of the 3205 decoder is applied to each Chip Enable (CE/) input to the eight 8102 RAM's. When the value on the system address bus is within the range 3 C00-3FFF the decoder output will be activated (1ow).

During all RAM access cycles, the active decoder output produces a ready indication for the CPU set (RAM RDYIN/). The 8238 System Controller (see Section 3.1) generates ADV MEMW/ or MEMR/ early enough in the memory cycle to allow RAM RDYIN/ to appear at the CPU set in time to prevent the occurrence of any wait states. Figures 3-5 illustrates RAM access timing.

Whenever SBC $80 / 10 \mathrm{~A}$ RAM is accessed, the data is transferred to/from the RAM chips on the memory data bus (DMO-DM7). Lines DM0-DM7 are interfaced to the system data bus through two Intel 8216 bidirectional bus drivers (shown at A55 and A56 on sheet 3 of the schematic) as described in section 3.2.

### 3.4 READ ONLY MEMORY (ROM/EPROM)

The SBC $80 / 10$ and $80 / 10 \mathrm{~A}$ have provisions for installing 4096 (4K) $\times 8$-bit words of read only memory in sockets already on the PC board. Four Intel $87081 \mathrm{~K} \times 8$-bit Erasable and Electrially Reprogrammable Read Only Memory (EPROM) chips or four 8308 IK x 8-bit Metal Masked Read Only Memory (ROM) chips can be installed in the four 24 -pin sockets shown on sheet 3 of the schematics (APPENDIX A). Optionally the SBC 80/10A has provisions for installing 4096 (4K) $x$-bits of read only memory in the sockets using four Intel 2758 (1K x 8-bits) Erasable and Electrically Reprogrammable Read Only Memory (EPROM) chips or installing 8192 ( 8 K ) $\times 8$-bit words of read only memory using either Intel 2716 2K x 8-bit Erasable and Electrically Reprogrammable Read Only Memory (EPROM) chips or Intel 2316E 2K x 8-bit Metal Masked Read Only Memory (ROM) chips.

In addition to the four 24 -pin sockets, the ROM/PROM logic. includes an Intel 3205 Decoder for address decoding and several assorted gates used in generating the ready indication.

When addressing up to 4 K of ROM , address lines ADRO-ADR9 are applied to the address pins A0-A9 at each of the four sockets. The remaining address lines, ADRA-ADRF are decoded by the 3205 device at A42. Each of the four least significant decoder outputs are applied to the chip select (CS/) pin at one of four sockets. One chip select line will be activated whenever the value on the system address bus is between 0000 and OFFF (hexadecimal). In addition, when the four most significant address lines are low (i.e., the address is less than OFFF) during a memory read cycle, the output from the 74LS00 section at A39-3 is NANDed with MEMR to produce a ready indication (PROM RDYIN/) for the CPU Set. PROM RDYIN/ is thus generated in time to allow a:1 ROM/PRUM reads to occur without any wait states. PROM RDYIN/ has the same timing as RAM DRYIN/, as shown in Figure 3-5.

When using the optional 2716 or 2316 E chips with the $80 / 10 \mathrm{~A}$, address lines ADRO-ADRA are applied to the address pins at each of the four sockets. The remaining address lines, ADRB-ADRF are decoded by the 3205 three-to-eight decoder. Each of the four least significant decoder outputs are applied to the Chip Select (CS/) pin at one of four sockets. One chip select line will be enabled when the value on the system address bus is between 0000 and 1FFF (hexadecimal).


DATA BUS DURING READ

DATA BUS DURING WRITE


FIGURE 3-5. RAM ACCESS TIMING

In addition when the three most significant address lines are low (i.e., the address is less than 1 FFF ) during a memory read cycle, the output from the 74 LS 00 at A39-3 is NANDed with MEMR/ to produce a ready indication PROM RDYIN/ for the CPU set. PROM RDYIN/ is generated in time to allow all ROM/PROM reads to occur without any wait states. PROM RDYIN/ has the same timing as RAM RDYIN/, as shown in figure 3-5.

Whenever one of the ROM/PROM devices are read, the data from the chips output pins (01-08( is placed on the memory data bus (DMO-DM7) which is interfaced to the system bus via two Intel 8216 bidirectional bus drivers (at A55 and A56), as described in Section 3.2.

### 3.5 SERIAL I/O INTERFACE

The Serial I/O Interface logic provides the SBC $80 / 10$ with a serial data communications channel that can be programmed to operate with most of the current serial data transmission protocols, synchronous or asynchronous. Baud rate, character length, number of stop bits and even/odd parity are program selectable. In addition, the serial I/O Interface can be configured (through jumper connections) as an EIA RS232C interface or as a Teletype-compatible current loop interface.

The Serial I/O Interface logic consists primarily of an Intel 8251 USART device and a counting network for baud rate selection, as shown on sheet 4 of the SBC $80 / 10$ schematic (Appendix A). Before describing the specific operation of the Serial I/O logic however, we will summarize the general operational characteristics of the 8251

USART, because it essentially defines the character of the Serial I/O Interface.

### 3.5.1 INTEL 8251 OPERATIONAL SUMMARY

The 8251 is a Universal Synchronous/Asynchronous Receiver/Transmitter designed specifically for the 8080 Micro-computer System. Like other $I / O$ devices in the 8080 Micro-computer System its functional configuration is programmed by the systems software for maximum flexiibility. The 8251 can support virtually any serial data technique currently in use (including IBM "Bi-Sync").

## Modem Control

The 8251 has a set of control inputs and outputs that can be used to simplify the interface to almost any Modem. The modem control signals are general purpose in nature and can be used for functions other than Modem control, if necessary.
$\overline{\text { DSR }}$ (Data Set Ready)
The $\overline{\mathrm{DSR}}$ input signal is general purpose in nature. Its condition can be tested by the CPU using a Status Read operation. The $\overline{\mathrm{DSR}}$ input is normally used to test Modem conditions such as Data Set Ready.
$\overline{\text { DTR }}$ (Data Terminal Ready)
The $\overline{\mathrm{D} \Gamma \mathrm{R}}$ output signal is general purpose in nature. It can be set "low" by programming the appropriate bit in the Command Instruction word. The $\overline{D T R}$ output signal is normally used for Modem control such as Data Terminal Ready or Rate Select.
$\overline{\mathrm{RTS}}$ (Request to Send)
The $\overline{\mathrm{RTS}}$ output signal is general purpose in nature. It can be set "low" by programming the appropriate bit in the Command Instruction word. The $\overline{R T S}$ output signal is normally used for Modem control such as Request to Send.
$\overline{\text { CTS }}$ (Clear to Send)

A "low" on this input enables the 8251 to transmit data (serial) if the TXEN bit in the Command byte is set to a "one". This is very important to remember?

## USART <br> PIN CONFIGURATION



FIGURE 3-6. 8251 PIN ASSIGNMENTS

TXRDY (Transmitter Ready)

This output signals the CPU that the transmitter is ready to accept a data character. It can be used as an interrupt to the system or for polled operation when the CPU can check TXRDY using a status read operation. TXRDY is active only when $\overline{\mathrm{CTS}}$ is enabled. TXRDY is automatically reset when a character is loaded from the CPU.

When the 8251 has no characters to transmit, the TxE output will go "high". It resets automatically upon receiving a character from the CPU. TXE can be used to indicate the end of a transmission mode, so that the CPU "knows" when to "turn the line around" in the half-duplexed operational mode.

In SYNChronous mode, a "high" on this output indicates that a character has not been loaded and the SYNC character or characters are about to be transmitted automatically as "fillers".

TXC (Transmitter Clock)
The Transmitter Clock controls the rate at which the character is to be transmitted. In the Synchronous transmission mode, the frequency of $\overline{T X C}$ is equal to the actual Baud Rate (1X). In Asynchronous transmission mode, the frequency of $\overline{\text { TXC }}$ is a multiple of the actual Baud Rate. A portion of the mode instruction selects the value of the multiplier; it can be $1 \mathrm{X}, 16 \mathrm{X}$ or 64 X the Baud Rate.

For Example:
If Baud Rate equa1s 4800 Baud,
$\overline{\text { TXC }}$ equals 4800 Hz (1X)

$\overline{\text { TXC }}$ equals 307.2 kHz (64X).
The falling edge of $\overline{T X C}$ shifts the serial data out of the 8251 .

RXRDY (Receiver Ready)

This output indicates that the 8251 contains a character that is ready to be input to the CPU. RXRDY can be connected to the interrupt structure of the CPU or for polled operation the CPU can check the condition of RXRDY using a status read operation. RXRDY is automatically reset when the character is read by the CPU.

## $\overline{\text { RXC }}$ (Receiver Clock)

The Receiver Clock controls the rate at which the character is to be received. In Synchronous Mode, the frequency of $\overline{\mathrm{RXC}}$ is equal to the actual Baud Rate (1X). In Asynchronous Mode, the frequency of $\overline{R X C}$ is a multiple of the actual Baud Rate. A portion of the mode instruction selects the value of the multiplier; it can be $1 \mathrm{X}, 16 \mathrm{X}$ or 64 X the Baud Rate.

For Example:
If Baud Rate equals 300 Baud, $\overline{\mathrm{RXC}}$ equals 300 Hx (1X) $\overline{\mathrm{RXC}}$ equals 4800 Hz ( 16 X ) $\overline{\mathrm{RXC}}$ equals 19.2 kHz (64X). If Baud Rate equals 2400 Baud, $\overline{\mathrm{RXC}}$ equals 2400 Hz (1X) $\overline{\mathrm{RXC}}$ equals 38.4 kHz (16X)


Data is sampled into the 8251 on the rising edge of $\overline{\mathrm{RXC}}$.

Note: In most ommunications systems, the 8251 will be handling both the trarsmission and reception operations of a single link. Consequently, the Receive and Transmit Baud Rates will be the Same. Both $\overline{\mathrm{TXC}}$ and $\overline{\mathrm{RXC}}$ will require identical frequencies for this operation and can be tied together and connected to a single frequency source (Baud Rate Generator) to simplify the interface.

* SYNDET (SYNC Detect)

This pin is used in SYNCHronous Mode only. It is used as either input or output, programmable through the Control Word. It is reset to "low" upon RESET. When used as an output (internal Sync mode), the SYNDET pin will go "high" to indicate that the 8251 has located the SYNC character in the Receive mode. If the 8251 is programmed to use double Sync characters, then SYNDET will go "high" in the middle of the last bit of the second Sync character. SYNDET is automatically reset upon a Status Read operation.

When used as an input, (external SYNC detect mode), a positive going signal will cause the 8251 to start assembling data characters on the falling edge of the next $\overline{\mathrm{RXC}}$. Once in SYNC, the "high" input signal can be removed. The duration of the high signal should be at least equal to the period of $\overline{\mathrm{RXC}}$.

Programming the 8251

Prior to starting data transmission or reception, the 8251 must be loaded with a set of control words generated by the CPU. These control signals define the complete functional definition of the 8251 and must immediately follow a Reset operation (internal or external).

The control words are split into two formats:

1. Mode Instruction,
2. Command Instruction.

Both the Mode and Command instructions must conform to a specified sequence for proper device operation. The Mode Instruction must be inserted immediately following a Reset operation, prior to using the 8251 for data communication.

* This function is not used or made available to the user on the SBC $80 / 10$.

All control words written into the 8251 after the Mode Insiruction will load the Command Instruction. Command Instructions can be written into the 8251 at any time in the data block during the operation of the 8251. To return to the Mode Instruction format a bit in the Command Instruction word can be set to initiate an internal Reset operation which automatically places the 8251 back into the Mode Instruction format. Command Instructions must follow the Mode Instructions or Sync characters (see Figure 3-7).


FIGURE 3-7. TYPICAL 8251 DATA BLOCK

Mode Instruction:

This format defines the general operational characteristics of the 8251. It must follow a Reset operation (internal or external). Once the Mode instruction has been written into the 8251 by the CPU, SYNC characters or Command instructions may be inserted.

The 8251 can be used for either synchronous or asynchronous
lata communications. The two least significant bits of the Mode Instruction control word specify synchronous or asynchronous operation. The format for the remaining bits in the control word depends on the mode chosen by bits 0 and 1 . Figure $3-8$ shows the control word format for the asynchronous mode, while Figure 3-9 illustrates the control word format for the synchronous mode.

Command Instruction:
Once the functional definition of the 8251 has been programmed by the Mode Instruction and the Sync Characters are loaded (if in Sync Mode) then the device is ready to be used for data communication. The Command Instruction controls the actual operation of the selected format. Functions such as: Enable Transmit/Receive, Error Reset and Modem Controls are provided by the Command Instruction.

Once the Mode instruction has been written into the 8251 and Sync characters inserted, if necessary, then all further "control writes" $(C / \bar{D}=1)$ will load the Command Instruction. A Reset operation (internal or external) will return the 8251 to the Mode Instruction Format.

Figure 3-10 illustrate the format of a Command Instruction control word.

Status Read Definition
In data communication systems it is often necessary to examine the "status" of the active device to ascertain if errors have occurred or other conditions that require the processor's attention. The 8251 has facilities that allow the programmer to "read" the status of the device at any time during the functional operation.


Mode Instruction Format, Asynchronous Mode

## TRANSMITTER OUTPUT

TxD


TRANSMISSION FORMAT


RECEIVE FORMAT


- NOTE: If ChARACTER LfNGTH IS DEFINED AS 5.6OR 7 BITS THE UNUSED BITS ARE SET TO 'ZERO

FIGURE 3-8. ASY NCHRONOUS MODE.


Mode Instruction Format, Synchronous Mode


RECEIVE FORMAT


FIGURE 3-9. SYNCHRONOUS MODE.


FIGURE 3-10. COMMAND INSTRUCTION FORMAT

A normal "read" command is issued by the CPU with the $C / \bar{D}$ input at one to accomplish this function.

Some of the bits in the Status Read Format have identical meanings to external output pins so that the 8251 can be used in a completely Polled environment or in an interrupt driven environment (refer to Figure 3-11).


FIGURE 3-11. STATUS READ FORMAT

Once programmed, the 8251 is ready to perform its communication functions. The TXRDY output is raised "high" to signal the CPU that the 8251 is ready to receive a character. This output (TXRDY) is reset automatically when the CPU writes a character into the 8251. On the other hand, the 8251 receives serial data from the MODEM or

I/O device; upon receiving an entire character the RXRDY output is raised "high" to signal the CPU that the 8251 has a complete character ready for the CPU to fetch. RXRDY is reset automatically upon the CPU read operation.

The 8251 cannot begin transmission until the TXEN (Transmitter Enable) bit is set in the Command Instruction and it has received a Clear To Send (CTS) input. The TXD output will be held in the marking state upon Reset.

Asynchronous Mode (Transmission):

Whenever a data character is sent by the CPU the 8251 automatically adds a Start bit (low level) and the programmed number of Stop bits to each character. Also, an even or odd Parity bit is inserted prior to the Stop bit(s), as defined by the Mode Instruction. The character is then transmitted as a serial dat- stream on the TXD output. The serial data is shifted out on the falling edge of $\overline{\text { TXC }}$ at a rate equal to $1,1 / 16$ or $1 / 64$ that of the $\overline{T X C}$, as defined by the Mode Instruction. BREAK characters can be continuously sent to the TXD if commanded to do so.

When no data characters have been loaded into the 8251 the TXD output remains "high" (marking) unless a BREAK (continuously low) has been programmed.

Asynchronous Mode (Receive):

The RXD line is normally high. A falling edge on this line triggers the beginning of a START bit. The validity of this START bit is checked by again strobing this bit at its nominal center. If a low is detected again, it is a valid START bit, and the bit
counter will start counting. The bit counter locates the center of the data bits, the parity bit (if it exists) and the stop bits. If parity error occurs, the parity error flag is set. Data and parity bits are sampled on the RXD pin with the rising edge of $\overline{\mathrm{RXC}}$. If a low level is detected as the STOP bit, the Framing Error flag will be set. The STOP bit signals the end of a character. This character is then loaded into the parallel I/O buffer of the 8251. The RXRDY pin is raised to signal the CPU that a character is ready to be fetched. If a previous character has not been fetched by the CPU, the present character replaces it in the $I / O$ buffer, and the OVERRUN flag is raised (thus the previous character is lost). All of the error flags can be reset by a command instruction. The occurrence of any of these errors will not stop the operation of the 8251.

Synchronous Mode (Transmission):
The TXD output is continuously high until the CPU sends its first character to the 8251 which usually is a SYNC character. When the $\overline{\text { CTS }}$ line goes low, the first character is serially transmitted out. All characters are shifted out on the falling edge of $\overline{T X C}$. Data is shifted out at the same rate as the $\overline{\mathrm{TXC}}$.

Once transmission has started, the data stream at TXD output must continue at the $\overline{T X C}$ rate. If the CPU does not provide the 8251 with a character before the 8251 becomes empty, the SYNC characters (or character if in single SYNC word mode) will be automatically inserted in the TXD data stream. In this case, the TXEMPTY pin will momentarily go high to signal that the 8251 is empty and SYNC characters are being sent out. The TXEMPTY pin is internally reset by the next character being written into the 8251.

Synchronous Mode (Receive):

In this mode, character synchronization can be internally or externally achieved. If the internal SYNC mode has been programmed, the receiver starts in a HUNT mode. Data on the RXD pin is then sampled in on the rising edge of RXC. The content of the RX buffer is continuously compared with the first SYNC character until a match occurs. If the 8251 has been programmed for two SYNC characters, the subsequent received character is also compared. When both SYNC characters have been detected, the USART ends the HUNT mode and is in character synchronization. The SYNDET pin is then set high, and is reset automatically by a STATUS READ.

Parity error and overrun error are both checked in the same way as in the Asynchronous receive mode.

The CPU can command the receiver to enter the HUNT mode if synchronization is lost.

### 3.5.2 Serial I/O Configurations

The 8251 USART presents a parallel, eight-bit interface to the CPU Set via the system data bus (DB0-DB7) and presents an EIA RS232C* or TTY current loop* interface to an external device (via edge connector J3). The 8251's interface with the CPU Set is enabled by a low
*Electrical interfaces provided on SBC 80/10.
level on its chip select (CS/) pin. $C S /$ is low when the $1 / 0$ address on the system address bus is between EC and EF (hexadecimal). Address bits 2 through 7 are decoded (at A14) to produce the CS/ input. The

TABLE 3-0. SERIAL COMMUNICATION (8251) ADDRESS ASSIGNMENTS

| I/O ADDRESS <br> (BASE 16) | COMMAND | FUNCTION |
| :---: | :---: | :--- |
| ED OR EF | OUTPUT | CONTROL WORD |
| EC OR EE | OUTPUT | DATA |
| ED OR EF | INPUT | STATUS |
| בC OR EE | INPUT | DATA |

least significant address bit, ADRO, is applied to the $8251^{\prime} \mathrm{s} C / \bar{D}$ input (pin 12) thus indicating a control (if set) or data (if reset) byte on the data bus.

An output instruction (IOW/ is true) to port ED or EF (CS/ is low and ADRO is high) causes the 8251 to accept a control byte through its data bus pins. The control byte can be either a mode instruction or a command instruction, depending on the sequence in which it is sent. The various bits in the mode control word specify the baud rate multiplexer, character length, parity and the number of stop bits as described in Section 3.5.1. Note that the actual baud rate selected is dependent on the configuration of the baud rate jumper network (refer to Section 3.5.3). The various bits in the command control word instruct the USART to enable/disable the receiver and transmitter, to reset errors, to reset internal control and return to the mode control cycle, and to set/clear the Data Terminal Ready output.

An output instruction to portEC or EE (CS/ and ADRO are low) causes the 8251 USART to accept a data byte through its data bus pins. Bit 0 is the least significant bit and bit 7 is the most significant bit. The 8251 will subsequently transmit the data byte (if the transmitter is enabled), in serial fashion, to the external device as described in Section 3.5.1.

An input instruction (IOR/ is true) to port ED or EF (CS/ is low and ADRO is high) causes the 8251 USART to place a status byte onto the system bus. The status bits are the result of status and error checking functions performed within the USART (see Section 3.5.1).

An input instruction (IOR/ is true) to port EC or EE (CS/ and ADRO are low) causes the USART to output a data byte (previously
received from the external device) from its data bus pins. Bit 0 is the least significant bit and bit 7 is the most significant bit.

Timing for the USART's internal function is provided by the \$2TTL signal (see Section 3.1.1). The USART is reset by the occurrence of a high level on the RESET line.

The 8251 USART transmits and receives serial data, synchronously or asynchronously, as described in Section 3.5.1. By jumper-connecting the 8251 pins to different external lines, the Serial I/O logic can present either a Teletype-compatible current loop interface or an EIA RS232C interface to an external device. If the TTY-compatible current loop interface is used, the connections listed in Table 4-1 are required (see Section 4.1).

If the EIA RS232C interface is used, the connections listed in Table 4-2 are requir ${ }^{\text {d }}$ (see Section 4.1).

### 3.5.3 BAUD RATE CLOCK GENERATION

The baud rate clock network consists of a $93 \mathrm{~S}^{16}{ }^{\text {' }}$ divide-by-15' counter, two 74161 'divide-by-16' counters and wire-wrap jumpers for baud rate clock selection. The $93 S 16$ counter is driven by the oscillator output (OSC) from the CPU Set. The QD output from this counter, in turn, drives the two 74161 counters. The outputs from these counters, each providing a different clock frequency, are tied to jumper pins that can be connected to the BAUD RATE CLK line. The available frequencies are listed in Table 4-3 (located in Section 4.2). Recall that the effective baud rate of the 8251 USART is also dependent on the state of the $8251^{\prime \prime}$ s internal frequency divider and the mode of operation (refer to Section 3.5.1).. The 8251 is capable of dividing the baud rate clock by 1,16 or 64 .

### 3.5.4 SERIAL I/O INTERRUPTS

The Serial I/O logic can be configured with different forms of an interrupt request mechanism. By connecting jumper pair 16-17 and disconnecting 15-16, the user can allow the 8251's Receiver Ready (RXRDY) output (pin 14) to generate an interrupt request (INT51/) to the CPU Set. RXRDY goes high whenever the receiver enable bit of the command word has been set and the 8251 contains a character that is ready to be input to the CPU Set. The user can also choose to have the 8251's Transmitter Ready (TXRDY) or the Transmitter Empty (TXE) output activate the INT51/ interrupt request. If jumper pair 19-21 is connected, a high on TXRDY (pin 15) will activate INT51/. If jumper pair 18-19 is connected instead, an active TXE (pin 18) output will generate INT51/. TXE goes high when the 8251 has no characters to transmit. TXRDY is high when the 8251 is ready to accept a character from the CPU Set. Both TXE and TXRDY are enabled by setting the transmit enable bit of the command word. Notice on the schematic that, if jumper pairs 19-20 and 15-16 are connected, Serial I/O interrupts are inhibited.

Upon receiving an interrupt, the program can determine the actual condition which is responsible for the interrupt (RXRDY, TXRDY or TXE) by reading the status of the 8251 device as described in Section 3.5.1. The interrupt request will be removed when the data is transferred to/ from the 8251 , as required. Note that the TXE or TXRDY output will be high, and consequently maintain an interrupt request, during all idle periods, 'since the 8251's transmit buffer will remain empty. To disable the transmitter, and the resultant interrupt request, the program can issue a command instruction to the 8251 with the TXEN bit (bit 0 ) equal to zero (refer to Section 3.5.1). The transmitter should not be disabled until TXE is high.

### 3.6 PARALLEL I/O INTERFACE

The Parallel I/O Interface logic on the SBC-80/10 provides forty- eight (48) signal lines for the transfer and control of data to or from peripheral devices. Eight lines have a bidirectional driver and termination network permanently installed. The remaining forty lines are uncommitted. Sockets are provided for the installation of active driver networks or passive termination networks. The optional drivers and terminators are installed in groups of four by insertion into the 14 -pin sockets.

All forty-eight signal lines emanate from the $I / O$ ports on two Intel 8255 Programmable Peripheral Interface devices, as shown on sheet 5 of the $\mathrm{SBC}-80 / 10$ schematic (Appendix A). The two 8255 devices allow for a wide variety of $I / O$ configurations. Before describing ths possible configurations, howevir, we will summarize the general operational characteristics of the 8255 device.

### 3.6.1 INTEL 8255 OPERATIONAL SUMMARY

The 8255 contains three 8 -bit ports ( $A, B$, and $C$ ). All can be configured in a wide variety of functional characteristics by the system software but each has its own special features or "personality" to further enhance the power and flexibility of the 8255.

Port A: One 8-bit data output latch/buffer and one 8-bit data input 1atch.

Port B. One 8-bit data input/output latch/buffer and one 8-bit data input buffer.

Port C: One 8-bit data output latch/buffer and one 8-bit data input buffer (no latch for input). This port can be divided into
two 4-bit ports under the mode control. Each 4-bit port contains a 4-bit latch and it can be used for the control signal outputs and status signal inputs in conjunction with Ports A and B .

The 8080 CPU dictates the operating characteristics of the ports by outputting two different types of control words to the 8255:
(1) mode definition control word (bit $7=1$ )
2) port $C$ bit set/reset control word (bit $7=0$ )

Bit 7 of each control word specifies its format, as shown in Figures 3-13 and 3-14, respectively.

Mode Selection

There are three basic modes of operation that can be selected by the system software:

Mode 0 - Basic Input/Output
Mode 1 - Strobed Input/Output
Mode 2 - Bi-Directional Bus
When the RESET input goes "high" all ports will be set to the Input mode 0 (i.e., all 24 lines will be in the high impedance state). After the RESET is removed the 8255 can remain in the Input mode with no additional initialization required. During the execution of the system program, the other modes may be selected using a single oUTput instruction. This allows a single 8255 to service a variety of peripheral devices with a simple software maintenance routine.

The modes for Port $A$ and Port $B$ can be separately defined, while Port C is divided into two portions as required by the Port A and Port B definitions. All of the output registers, including the status flip-flops, will be reset whenever the mode is changed except for $\overline{\mathrm{OBF}}$ in modes 1 and 2 .

## PIN CONFIGURATION

| $\operatorname{Pa3}[\sqrt{1}$ |  | 40 | $\square^{P A 4}$ |
| :---: | :---: | :---: | :---: |
| $P^{\prime} 2 \square_{1}{ }^{2}$ |  | 39 | $]^{P A 5}$ |
| PA, ${ }^{\text {a }}$ |  | 38 | ]Pag |
| PaO ${ }^{\text {d }}$ |  | 37 | $]^{\text {Pa }}$ |
| - |  | 36 | ] $\overline{\text { wR }}$ |
| $\overline{\mathrm{cs}} \mathrm{CH}_{6}$ |  | 35 | - meset |
| GND-1, |  | 34 | $\mathrm{D}_{0}$ |
| A $C^{\text {a }}$ |  | 33 | $1 \mathrm{D}_{1}$ |
| AOC, ${ }^{\text {a }}$ |  | 32 | $\mathrm{Cl}_{2}$ |
| PC7C 10 |  | 31 | $]_{0}$ |
| PCES ${ }^{\text {c }} 11$ | 8255 | 30 | -1 $0_{4}$ |
| PCS[ 12 |  | 29 | $\mathrm{J}_{5}$ |
| $\cdots \mathrm{Ca}$ [13 |  | 28 | $10_{5}$ |
| PCOC, 14 |  | 27 | 10, |
| PC, ${ }^{\text {c }}$ 15 |  | 26 | 7 cc |
| PC2 [ 15 |  | 25 | ] ${ }^{\text {P }}$ ) |
| PC3 [1] |  | 24 | $\square^{\text {P86 }}$ |
| P8o ${ }^{\text {¢ }} 18$ |  | 23 | 7 Pes |
| PRIt 19 |  | 27 | \| PRA |
| Ph\%1 0 |  | $\because$ | \| ${ }^{18} 3$ |

PIN NAMES

| $\mathrm{D}_{3}-\mathrm{D}_{0}$ | DATA BUS (BI DIRECTIONAL) |
| :---: | :---: |
| RESET | AfSft infut |
| CS | Chimstlfet |
| HD | READ INPUT |
| WA | WRITE INPUT |
| A0, A1 | PORT ADDRESS |
| PA7.PAO | PORT A (BIT) |
| P87.PB0 | PORT B (BIT) |
| PC7.PCO | PORT C (BIT) |
| Vcc | +5 VOLTS |
| GND | 9 VOLTS |

CONTROL WORD


FIGURE 3-12. 8255 PIN ASS IGNMENTS.

FIGURE 3-13. MODE DEFINITION CONTROL WORD FORMAT.

Modes may be combined so that their functional definition can be "tailored" to almost any $I / 0$ structure. For instance; Group $B$ can be programmed in Mode 0 to monitor simple switch closings or display computational results, Group A could be programmed in Mode 1 to monitor a keyboard or tape reader on an interrupt-driven basis.

Single Bit Set/Reset Feature
Any of the eight bits of Port $C$ can be Set or Reset using a single ouTput instruction (see Figure 3-14). This feature reduces software requirements in Control-based applications.

When Port $C$ is being used as status/control for Port $A$ or $B$, these bits can be set or reset by using the Bit Set/Reset operation just as if they were data output ports.

## Interrupt Control Functions

When the 8255 is programmed to operate in Mode 1 or Mode 2, control signals are provided that can be used as interrupt request inputs to the CPU. The interrupt request signals, generated from Port C, can be inhibited or enabled by setting or resetting the associated INTE flip-flop, using the Bit set/reset function of Port $C$.

This function allows the Programmer to disallow or allow specific $I / O$ devices to interrupt the CPU without effecting any other device in the interrupt structure.

INTE flip-flop definition:
(BIT-SET) - INTE is SET - Interrupt enable (BIT-RESET) - INTE is RESET - Interrupt disable

Note: All Mask flip-flops are automatically reset during mode selection and device Reset.


FIGURE 3-14. BIT SET/RESET CONTROL WORD FORMAT.

Operating Modes

Mode 0 (Basic Input/Output):

This functional configuration provides simple Input and output operations for each of the three ports. No "hand-shaking" is required, data is simply written to or read from a specified port.

Mode 0 timing is illustrated in Figure 3-15.

Mode 0 Basic Functional Definitions:

- Two 8-bit ports and two 4-bit ports.
- Any port can be input or output.
- Outputs are latched.
- Inputs are not latched.
- 16 different Input/Output configurations are possible in this Mode. Figure 3-16 shows two possible configurations.

BASIC INPUT TIMING (D7. $D_{0}$ FOLLOWS INPUT, NO LATCHING)


BASIC OUTPUT TIMING IOUTPUTS LATCHED)


FIGURE 3-15. 8255 MODE 0 TIMING

| $D_{1}$ | $D_{6}$ | $D_{5}$ | $D_{4}$ | $D_{3}$ | $D_{2}$ | $D_{1}$ | $D_{0}$ |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| 1 | 0 | 0 | 1 | 1 | 0 | 0 | 0 |



FIGURE 3-16. EXAMPLES OF MODE 0 CONFIGURATION.

Mode 1 (Strobed Input/Output):
This functional configuration provides a means for transferring I/O data to or from a specified port in conjunction with strobes or "handshaking" signals. In Mode 1, Port A and Port B use the lines on Port $C$ to generate or accept these "handshaking" signals.

Mode 1 Basic Functional Defintions:

- Two transfer ports (A and B).
- Each transfer port contains one 8-bit data port and 4 bits from one half of the control/data port (Port C).
- The 8-bit data port can be either input or output. Both inputs and outputs are latched.

Input Control Signal Defintion for Mode 1

STB (Strobe Input)
A "low" on this input loads data into the input latch.

IBF (Input Buffer Full F/F)
A "high" on this output indicates that the data has been loaded into the input latch; in essence, an acknowledgement. IBF is set by the falling edge of the $S T B$ input and is reset by the rising edge of the $\overline{\mathrm{RD}}$ input.

## INTR (Interrupt Request)

A "high" on this output can be used to interrupt the CPU when an input device is requesting service. INTR is set by the rising edge of $\overline{S T B}$ if $I B F$ is a "one" and INTE is a "one". It is reset by the falling edge of $\overline{\mathrm{RD}}$. This procedure allows an input device to
request service from the $C P U$ by simply strobing its data into the port.

INTE A

Controlled by bit set/reset of PC4.

INTE B
Controlled by bit set/reset of PC2.

Figure 3-17 illustrates the Mode 1 input configuration, while Figure 3-18 shows the basic timing for Mode 1 input.

Output Control Signal Definition for Mode 1
$\overline{\mathrm{OBF}}$ (Output Buffer Full $\mathrm{F} / \mathrm{F}$ )
The $\overline{O B F}$ output will go "low" to indicate that the CPU has written data out to the specified port. The $O B F F / F$ will be set by the rising edge of the $\overline{W P}$ input and reset by the falling edge of the $\overline{A C K}$ input signal.
$\overline{A C K}$ (Acknowledge Input)
A "low" on this input informs the 8255 that the data from Port A or Port $B$ has been accepted. In essence, a response from the peripheral device indicating that it has received the data output by the CPU.

INTR (Interrupt Request)
A "high" on this output can be used to interrupt the CPU when an output device has accepted data transmitted by the CPU. INTR is set by the rising edge of $\overline{\mathrm{ACK}}$ if $\overline{\mathrm{OBF}}$ is a "one" and INTE is a "one". It is reset by the falling edge of $\overline{W R}$.

INTE A

Controlled by bit set/reset of PC6.


FIGURE 3-17. MODE 1 INPUT CONFIGURATION

## MODE 1 (Strobed input)

## basic timing

1BF
(INPUT BUFFER FULL)


FIGURE 3-18. 8255 MODE 1 INPUT TIMING

INTE B

Controlled by bit set/reset of PC2.
Figure 3-19 illustrates the Mode 1 output configuration, while Figure $3-20$ shows basic Mode 1 output timing.


FIGURE 3-19. MODE 1 OUTPUT CONFIGURATION.


FIGURE 3-20. MODE 1 BASIC OUTPUT TIMING

Mode 2 (Strobed Bi-Directional Bus I/O):

This functional configuration provides a means for communicating with a peripheral device or structure on a single 8-bit bus for both transmitting and receiving data (bi-directional bus $1 / 0$ ). "Handshaking" signals are provided to maintain proper bus flow discipline in a similar manner to Mode 1. Interrupt generation and enable/disable functions are also available.

Mode 2 Basic Functional Definitions:

- Used in Port A only.
- One 8-bit, bi-directional data Port (Port A) and a 5-bit control Port (Port C).
- Both inputs and outputs are latched.
- The 5-bit control port (Port $C$ ) is used for control and status for the 8-bit, bi-directional data port (Port A).

Bi-Directional Bus I/O Control Signal Definition

INTR (Interrupt Request)
A high on this output can be used to interrupt the CPU for both input or output operations.

Output Operation Control Signals
$\overline{\mathrm{OBF}}$ (Output Buffer Full)
The $\overline{O B F}$ output will go "1ow" to indicate that the CPU has written data out to Port $A$.

## $\overline{\mathrm{ACK}}$ (Acknowledge)

A "low" on this input enables the tri-state output buffer of Port A to send out the data. Otherwise, the output buffer will be in the high-impedance state.

INTR $A$ and $B$ (The INTE flip-flop associated with $\overline{O B E}$ )
Controlled by bit set/reset of PC6 (INTE1)
Input Operation Control Signals
$\overline{S T B}$ (Strobed Input)
A "low" on this input indicates that data has been loaded into the input latch.

IBF (Input Buffer Full F/F)
A "high" on this output indicates that data has been loaded into the input latch.

INTE 2 (The INTE flip-flop associated with IBF)
Controlled by bit set/reset PC4 (INTE 2)
$\mathrm{INTR}_{\mathrm{A}}=\mathrm{PC6} \cdot \mathrm{OBF}_{\mathrm{A}}+\mathrm{PC} 4 \cdot \mathrm{IBF}_{\mathrm{A}}$
Figure 3-21 illustrates the port configuration for Mode 2, Figure
3-22 shows Mode 2 timing, and Table 3-1 summarizes 8255 More definition.

CONTROL WORD



FIGURE 3-21. MODE 2 PORT CONE [GURATION


FIGURE 3-22. MODE 2 TIMING

MODE DEFINITION SUMMARY TABLE

| $\mathrm{PA}_{0}$ | MODE 0 |  |
| :---: | :---: | :---: |
|  | IN | OUT |
|  | IN | OUT |
| $P A_{1}$ | IN | OUT |
| $\mathrm{PA}_{2}$ | IN | OUT |
| $\mathrm{PA}_{3}$ | IN | OUT |
| $\mathrm{PA}_{4}$ | IN | OUT |
| $P A_{5}$ | IN | OUT |
| $P A_{6}$ | in | OUT |
| $\mathrm{PA}_{7}$ | IN | OUT |
| $\mathrm{PB}_{0}$ | IN | OUT |
| $\mathrm{PB}_{1}$ | IN | OUT |
| $\mathrm{PB}_{2}$ | IN | OUT |
| $\mathrm{PB}_{3}$ | IN | OUT |
| $\mathrm{PB}_{4}$ | IN | OUT |
| $\mathrm{PB}_{5}$ | IN | OUT |
| $\mathrm{PB}_{6}$ | IN | OUT |
| $\mathrm{PB}_{7}$ | IN | OUT |
| ${ }^{P} \mathrm{C}_{0}$ | IN | OUT |
| $\mathrm{PC}_{1}$ | IN | OUT |
| $\mathrm{PC}_{2}$ | IN | OUT |
| $\mathrm{PC}_{3}$ | IN | OUT |
| $\mathrm{PC}_{4}$ | IN | OUT |
| $\mathrm{PC}_{5}$ | IN | OUT |
| $\mathrm{PC}_{6}$ | IN | OUT |
| $\mathrm{PC}_{7}$ | IN | OUT |


| MODE 1 |  |
| :---: | :---: |
| IN | OUT |
| IN | OUT |
| IN | OUT |
| in | OUT |
| IN | OUT |
| IN | OUT |
| IN | OUT |
| IN | OUT |
| IN | OUT |
| IN | OUT |
| IN | OUT |
| IN | OUT |
| IN | OUT |
| IN | OUT |
| IN | OUT |
| IN | OUT |
| IN | OUT |
| $\mathrm{INTR}_{\mathrm{B}}$ | INTR $_{8}$ |
| ${ }^{18 F_{B}}$ | $\overline{\mathrm{OBF}}_{\mathrm{B}}$ |
| $\overline{S T B}_{B}$ | $\overline{\mathrm{ACK}}_{\mathrm{B}}$ |
| INTR $_{A}$ | $\mathrm{INTR}_{A}$ |
| $\overline{S T B A}_{A}$ | I/O |
| ${ }^{1 B F_{A}}$ | 1/0 |
| 1/O | $\overline{\mathrm{ACK}}_{\mathrm{A}}$ |
| 1/0 | $\overline{O B F}_{A}$ |



TABLE 3-1. 8255 MODE DEFINITION SUMMARY

### 3.6.2 PARALLEL I/O CONFIGRATIONS

Referring to sheet 5 of the schematic, we see that there are two 8255 devices, one located at A19, the other at A20. For convenience the following device designations will be used: The device at A19 is called the "group 1 " device; while the device at A20 is referred to as the "group 2 " device. Each device has three eight-bit ports. The "group 1" ports are designated Ports 1,2 and 3 while the "group 2" ports are designated Ports 4,5 and 6.

The group 1 and group 2 devices both communicate with the CPU Set using the same signal lines: the 8 -bit data bus, DBO-DB7, and seven control/address lines; ADRO, ADR1, RESET, IOR/, IOW/, CS1/, and CS2/. The data lines bring control bytes or data bytes to an 8255 or deliver data from an 8255 to the CPU Set. The chip select control signals (CS1, and CS2/) select the group 1 and group 2 devices, respectively, when the proper $1 / 0$ address appears on the system address bus. CS1/ and CS2/ are the result of decoding address bits 2 through 7 (ADR2-ADR7), as shown on sheet 4 of the schematic (at A14). The two least significant address bits select the control register (when programming an 8255 ) or one of the three $\mathrm{I} / \mathrm{O}$ ports (when reading or writing data). IOR/ (8255 $\rightarrow$ CPU Set) and IOW/ (CPU Set $\rightarrow 8255$ ) indicate the direction of data flow, as summarized in Table 3-2. Specific $1 / 0$ addresses for the six ports and two 8255 control registers on the $\mathrm{SBC}-80 / 10$ are listed in Table 3-3.

A high on the RESET line clears all internal 8255 registers including the control register; all ports (A, B and C) are set for input.

Though both 8255's maintain the same interface (at different

TABLE 3-2. 8255 BASIC OPERATION


TABLE 3-3. PARALLEL I/O PORT ADDRESSES


I/O addresses) with the CPU Set, the interface between the group 1 device and edge connector J 1 is significantly different than the interface between the group 2 device and its associated edge connector (J2). This gives the user a great deal of flexibility when configuring the system's external parallel I/O devices. Because of those flexible "external" interfaces, however, not all ports are capable of operating in each 8255 mode, though all ports can be programmed as either input or output. The group 1 ports can fully utilize the 8255 's multi-mode and external interrupt capabilities as described in Section 3.6.1. The group 2 ports, however, are limited to a single mode of operation. The allowable port configurations for both groups are sumnarized below:

Port 1 (Group 1 Port A)
Mode 0 Input
Mode O Output (Latched)
Mode 1 Input (Strobed)
Mode 1 Output (Latched)
Mode 2 Bidirectional

Port 2 (Group 1 Port B)
Mode 0 Input
Mode O Output (Latched)
Mode 1 Input (Strobed)
Mode 1 Output (Latched)

Port 3 (Group 1 Port C)
Mode 08 Bit Input
Mode 08 Bit Output (Latched)
Note: Control mode dependent upon Port A and B mode.

Ports 4 and 5 (Group 2 Port A, B)
Mode 0 Input
Mode O Output (Latched)

Port 6 (Group 2 Port C)
$\begin{array}{llllll}\text { Mode } 0 & 8 & \text { Bit Input } \\ \text { Mode } & 0 & 8 & \text { Bit Output } & \\ \text { Mode } 0 & 4 & \text { Bit Input/4 Bit Output (Unlatched/latched) } \\ \text { Mode } 0 & 4 & \text { Bit Output/4 Bit Input (Latched/unlatched) }\end{array}$

## Group 1

Port 1 is the most versatile of the six ports. It can be programmed to function in any one of the three 8255 operating modes. This first port is the only port that already includes a permanent bidirectional driver/termination network (two 8226 bus driver devices at A1 and A2).

Before Port 1 is programmed for input or output in any one of three operating modes (as described in Section 3.6.1), certain jumper connections must be made to allow the port to function properly in the chosen mode. The 40-41-42-43 jumper pad specifies the direction of data flow for the two 8226 bidirectional bus drivers. If input in mode 0 or mode 1 is to be programmed for Port 1 , jumper pair 41-42 should be connected. If output in mode 0 or mode 1 is to be used, jumper pair $40-41$ should be connected. If Port 1 is to be programmed for bidirectional mode 2 , then jumper pair 4l-43 should be connected. This connection allows the output acknowledge, ACK/, that is input on bit 6 of Port 3 to dynamically dictate direction for the two 8226 devices.

Another jumper pad (48-49-50-51) enables interrupts for Port 1 when it is in mode 1 or mode 2. Jumper pair $49-50$ should be connected to allow the INTR output (see Section 3.6.1) from bit 3 of Port 3 to activate an interrupt request (INT55/) from the 74 LSO 2 gate at A 45. In mode 0 , during which there is no provision for interrupts, jumper pairs 48-49 and 50-51 must be connected to allow use of bit 3 of port 3 and to inhibit Port 1 interrupts.

Because the 8226 bus drivers are inverting devices, all data input to or output from Port 1 is considered to be negative true with respect to the levels at the J 1 edge connector.

Port 2 can be programmed for input or output in either mode 0 or mode 1 (see Section 3.6.1). If Port 2 is to be used for input (in either mode), terminator networks must be installed in the sockets at A5 and A6. Because these networks must be passive, data that is input to Port 2 will be positive true. If Port 2 is to be used for output (in either mode), driver networks must be installed in the sockets at A5 and A6. Assuming that the drivers are inverting devices, then the data being output will be negative true at the Jl edge connector.

When Port 2 is programmed for mode 1 , interrupts can be enabled by connecting jumper pair 45-46. This connection allows the INTR output from bit 0 of Port 3 to activate the interrupt request (INT55/) to the CPU set. When Port 2 is in mode 0 , jumper pairs $44-45$ and 46-47 must be connected to allow use of bit 0 of Port 3 and to inhibit Port 2 interrupts.

As was described in Section 3.6 .1 , the use of Port 3 is dependent on the modes programmed for Ports 1 and 2. If Port 1 is in mode 1 or mode 2 , bits $3,4,5,6$ and 7 of Port 3 can have dedicated control functions.

```
Port 3 bit \(3 \rightarrow\) INTR (interrupt request) - input or output
Port 3 bit \(4 \leftarrow S T B /\) (input strobe) \(\quad\) mode 1 input
Port 3 bit \(5 \rightarrow\) IBF (input buffer full flag) or mode 2
Port 3 bit \(6 \leftarrow\) ACK / (output acknowledge) mode 1 output
Port 3 bit \(7 \rightarrow\) OBF/ (output buffer full flag) or mode 2
```

If Port 2 is in mode 1 , bits 0,1 and 2 of Port 3 have dedicated control functions:

```
Port 3 bit \(0 \rightarrow\) INTR (interrupt request) - input or output
Port 3 bit \(1 \rightarrow\) IBF (input buffer full)) input only
Port 3 bit \(2 \leftarrow\) STB/ (input strobe
Port 3 bit \(2 \leftarrow\) STB/ (input strobe
Port 3 bit \(1 \rightarrow\) OBF/ (output buffer full) ) output only
Port 3 bit \(2 \leftarrow A C K /\) (output acknowledge) ) output only
```

While certain Port 3 bits are available if Port 1 is in mode 1 or if Port 2 is in mode 0 , the use of Port 3 as an eight-bit data path is restricted to those configurations that have both Port 1 and Port 2 programmed for mode 0 . In this case all 8 bits of Port 3 can be programmed for mode 0 input (termination networks must be installed in the sockets at A3 and A4) or output (driver networks must be installed at A3 and A4). Note: If Port 1 and 2 are not both in mode 0 , then a driver network must be installed in the sockets at A3 and a termination network must be installed at A4, so that the Port 3 control lines can function properly.

## Group 2

The three ports on the group 2 device can be programmed for input or output, but only in mode 0 . If Port 4 is programmed for input, termination networks must be installed in the sockets at A7 and A8. The data being input will be in positive true form. If Port 4 is programmed for output, driver networks must be installed at A7 and A8. Assuming that inverting drivers are used, then the data will be considered negative true at the J 2 edge connector.

If Port 5 is programmed for input, termination networks must be installed in the sockets at A21 and All. If Port 5 is programmed for output, driver networks must be installed at A21 and All.

All eight bits of Port 6 can be programmed for input or output, or four bits can be programmed for input while the other four bits are programmed for output (see Section 3.6.1). Driver termination networks must be installed in the sockets at A9 and A10 as listed in Table 3-4.

TABLE 3-4. Port 6 I/O CONFIGURATIONS

|  | Sockets at A9 | Sockets at A10 |
| :---: | :---: | :---: |
| 8-bit Input | Terminators* | Terminators* |
| 8-bit Output | Drivers** | Drivers** |
| Upper 4-bits Input/ Lower 4-bits Output | Terminators* | Drivers** |
| Lower 4-bits Input/ Upper 4-bits Output | Drivers** | Terminators* |
| Posilive-true data * Negative-true data | inverting dri |  |

In Section 4.2, all of the user options for configuring parallel I/ 0 on the $S B C-80 / 10$ are summarized for convenient reference.

CHAPTER 4

## USER SELECTABLE OPTIONS

The SBC-80/10 provides the user with a powerful, but flexible I/O capability for both parallel and serial transfers. The serial I/O Interface, using Intel's 8251 USART, provides a serial data communications channel that can be programmed to operate with most of the current serial data transmission protocols. Synchronous or asynchronous mode, baud rate, character length, number of stop bits and even/odd parity are all program selectable. In addition, the user has the option, through jumper connections; of configuring the Serial I/O Interface as an EIA RS232C interface or as a Teletypecompatible current loop interface.

The Parallel I/O Interface, using two Intel 8255 Programmable Peripheral Interface devices, provides 48 signal lines for the transfer and control of data to or from peripheral devices. Eight lines already have a bidirectional driver and termination network permanently installed. The remaining 40 lines, however, are uncommitted. Sockets are provided for the installation of active driver networks or passive termination networks as required to meet the specific needs of the user system.

In this chapter, we will reiterate each of the options available to the user, and summarize, for easy reference, the specific information required to implement the user ${ }^{\text {s }}$ s tailored I/O configuration. Section 4.1 deals with the Serial I/O Interface, while Section 4.2 covers Parallel I/O options. Section 4.3 will describe general options not covered in the other two sections.

### 4.1 SERIAL I/O INTERFACE OPTIONS

There are three general areas of Serial I/O options:

1) choice of interface type, RS232C or current loop,
2) baud rate and program-selectable mode options,
3) choice of an interrupt request mechanism.

The first two are covered in the following paragraphs; the third, choice of interrupt mechanism, is quite simple and is fully explained in Section 3.5.4.

### 4.1.1 INTERFACE TYPE

The user has the choice of configuring the Serial I/O logic to present either an EIA RS232C or a 20 mA current loop interface to an external device. If a Teletype-compatible current loop interface is used, the 8251 I/O pins should be connected to the external Teletype lines as listed in Table 4-1. The reader control logic is controlled by the output DSR/ from the 8251. If an EIA RS232C interface is used, the 8251 can assume the role of a "data set" (see Table 4-2a) or a partial "data processing terminal" (see Table 4-2b) ${ }^{1}$. Pin definitions for the 8251 USART are listed in Section 3.5.1.

### 4.1.2 BAUD RATE AND PROGRAM-SELECTABLE SERIAL I/O OPTIONS

Before beginning Serial I/O operations, the 8251 must be pro-gram-initialized to support the desired mode of operation. The CPU initializes the 8251 by outputting a set of control bytes to the USART device. These control words specify:

* synchronous or asynchronous operation,
* baud rate factor,
* character length,
* number of stop bits,
* even/odd parity.
* parity/no parity
${ }^{1}$ In this role, cable modifications must be made to conform with RS232 standards.

TABLE 4-1. 20 mA CURRENT LOOP SERIAL I/O INTERFACE

| 8251 PIN <br> MNEMONIC | $\begin{aligned} & \text { PIN } \\ & \text { NO. } \end{aligned}$ |  | $\begin{aligned} & \text { CONNECTOR } \\ & \text { PIN NO. } \end{aligned}$ | $\begin{aligned} & \text { JUMPER } \\ & \text { CONNECTIONS } \end{aligned}$ |
| :---: | :---: | :---: | :---: | :---: |
|  TXD <br>  DTR/ <br> (1) RTS/ <br> (1) CTS/ <br> (2) TXC <br> (2) RXC <br>  TXD <br>  - <br>  - <br>  - | $\begin{array}{r} 19 \\ 24 \\ 23 \\ 17 \\ 9 \\ 25 \\ 3 \\ - \end{array}$ | TTY Tx <br> TTY RD CONTROL <br> (CTS/) <br> (RTS/) <br> (Baud Rate Clk) <br> (Baud Rate Clk) <br> TTY RX <br> TTY Rx RET <br> TTY Tx RET <br> TTY RD CTL RET | $\begin{gathered} \text { J3-25 } \\ \text { J3-6 } \\ - \\ - \\ - \\ - \\ \text { J3-22 } \\ \text { J3-23 } \\ \text { J3-24 } \\ \text { J3-16 } \end{gathered}$ | $\begin{gathered} 1-2 \\ 23-24 \\ 27-29,30-31 \\ 27-29 \\ 33-34(8-4,56-57) \\ 35-36(8-4,56-57) \\ 38-39 \\ - \\ - \end{gathered}$ |

Notes: (1) The 8251's RTS/ output is connected to the CTS/ input through jumper pair 27-28. The command instruction word for the 8251 must enable RTS/.
(2) TXC and RXC are connected to the Baud Rate Clk line via jumpers 33-34 and 35-36. The Baud Rate Clk should be configured for 110 baud by connecting jumpers 8-4 and 56-57 (see Table 4-3), and the 8251 should be programmed for a baud rate factor of 64 (see Section 4.2).
(3) The $\mathrm{SBC} 80 / 10$ comes with these jumper connections made.

TABLE 4-2a. RS232C INTERFACE, "DATA SET" ROLE

| 8251 PIN MNEMONIC |  | $\begin{aligned} & \text { PIN } \\ & \text { NO. } \end{aligned}$ | LINE FUNCTION | CONNECTOR PIN NO. | JUMPER CONNECTIONS | JUMPER <br> REMOVAL |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| (1) | RXD | 3 | TRANSMITTED DATA | J3-3 | 37-38 | 39-38 |
|  | TXD | 19 | RECEIVED DATA | J3-5 | 2-3 | 1-2 |
|  | CTS/ | 17 | REQ TO SEND | J3-7 | 27-28 | 27-29 |
|  | RTS/ | 23 | CLEAR TO SEND | J3-9 | 29-30 | - |
|  | DTR/ | 24 | DATA SET READY | J3-11 | 22-23 | 23-22 |
|  | DSR/ | 22 | DATA TERMINAL RDY | J3-14 | 25-26 | - |
|  | - | - | PROTECTIVE GROUND SIGNAL GROUND | $\begin{aligned} & \text { J3-1 } \\ & \text { J3-13 } \end{aligned}$ | - | - |

TABLE 4-2b. RS232C INTERFACE, "DATA PROCESSING TERMINAL" ROLE ${ }^{1}$


Notes: (1) The CTS/ input pin on the 8251 must be "low" to enable the 8251 to transmit.
(2) When connector pin J3-14 is jumpered (25-26) to the DSR/ input, J3-14 cannot be used to supply an external transmit clock.
(3) In the asynchronous mode, TXC and RXC can be connected to externally supplied clocks via jumpers $32-33$ and $36-39$, or they can be connected to the internal Baud Rate Clk via jumpers 33-34 and 35-36, regardless of the mode.

[^0]As explained in Section 3.5.1, there are two types of control words: (1) Mode instruction and (2) Command instruction. The Mode instruction initializes the 8251 USART. Because the USART supports either synchronous or asynchronous operation, the Mode instruction has one format for synchronous operation and another for asynchronous. The two least significant bits of the Mode instruction byte specify the format. If DO and D1 both equal 0 , synchronous operation is indicated; otherwise, it is asynchronous. The Mode instruction format for asynchronous operation is illustrated in Figure 3-8. The Mode instruction for synchronous operation is shown in Figure 3-9.

Notice in Figure 3-8 that the baud rate factor is specified by the two least significant bits of the instruction byte (labeled B1 and B2). During asynchronous communications, the Baud Rate Clock frequency supplied to the $8251^{\prime}$ s TXC and RXC input pins is divided by the baud rate factor to produce the effective baud rate (i.e., the frequency at which data bits are serially transmitted by the 8251 USART). Consequently, the Baud Rate Clock, as well as the program-selected baud rate factor, must be considered in implementing the desired effective baud rate. The Baud Rate Clock frequency is selected through various jumper connections as shown on sheet 4 of the $\operatorname{sBC}-80 / 10$ schematic (Appendix A). The selection of an effective baud rate is summarized in Table 4-3.

Notice from the schematic that TXC and RXC inputs can be supplied by externally supplied clocks (via connector pins J3-14 and J3-22, respectively), instead of using the Baud Rate Clock, if jumpers 32-33 and 36-39 are connected and jumpers 33-34 and 35-36 are disconnected.

TABI, 4-3. BAUD RATE SELECTION

| JUMPER CONNECTION | EFFECTIVE BAUD RATE ( Hz ) |  |  |
| :---: | :---: | :---: | :---: |
|  | SYNCHRONOUS MODE | ASYNCIIRONOUS MODE |  |
|  |  | BAUD RATE FACTOR=16 ${ }^{(2)}$ | BAUD RATE FACTOR=64 ${ }^{\text {(2) }}$ |
| 10-4 | - |  | 4800 |
| 11-4 | - | 9600 | 2400 |
| 12-4 | - | 4800 | 1200 |
| 5-4 | 38,400 | 2400 | 600 |
| 6-4 | 19,200 | 1200 | 300 |
| 7-4 | 9600 | 600 | 150 |
| (1) 8-4 | 4800 | 300 | 75 |
| (1) $\left.\begin{array}{r}8-4, \\ 56-57\end{array}\right\}$ | 6980 | - | 110 (TTY) |

Note: (1) If jumper pair 56-57 is not connected, the frequency at jumper pole 8 is 4.8 KHZ . If jumper $56-57$ is connected, however, the frequency at jumper pole 8 is 6.98 KHZ which, with a programmed baud rate factor of 64 , provides an effective baud rate of approximately 110 baud for Teletype use.
(2) Baud rate factor is software selectable.
(3) Caution: Baud Rate Factor $=16$

### 4.2 PARALLEL I/O OPTIONS

The Parallel $1 / O$ Interface consists of six 8 -bit $1 / 0$ ports implemented with two Intel 8255 Programmable Peripheral Interface devices. The primary user considerations in determining how to use each of the six $I / O$ ports are:

1) Choice of operating mode (as defined in Section 3.6.1),
2) direction of data flow (input, output or bidirectional),
3) choice of driver/termination networks for port's data path.

In the following paragraphs, we will define the capabilities of each port and summarize, in tables, that information which is necessary to use the port in each of its potential configurations. Each table will list the port $I / O$ address, the control register address and the format for the control word which is output to the 8255 by the CPU Set and which specifics the particular configuration to be uscd. Each
table will also summarize all of the relevant information concerning the choice and use of driver/termination networks, the data polarity, the connecting of jumpers and what they enable, and any restrictions on the use of the other two ports in each group. Examples of suitable driver/ termination networks are listed in Section 5.1 .

### 4.2.1 PORT 1 (GROUP 1 PORT A)

Port 1 is the only port that already includes a permanent bidirectional driver/termination network (two 8226 Bidirectional Bus Drivers). Port 1 is also the only port which can be programmed to function in any one of the three 8255 operating modes, which were defined in Section 3.6.1. Before Port 1 is programmed for input or output in any one of the three modes, certain jumper connections must be made to allow the port to function properly in the chosen mode. Other jumper connections must be made to enable interrupts when Port 1 is in mode 1 or mode 2. In all, there are five potential configurations for Port 1. All of the necessary information for implementing each configuration has been summarized in the following tables:

| PORT 1 CONFIGURATIONS |  |
| :--- | :--- |

TABLE 4-4. PORT 1, MODE 0 INPUT CONFIGURATION

PORT 1 ADDRESS: E4, CONTROL REGISTER ADDRESS: E7

CONTROL WORD FORMAT: $\quad$| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| 1 | 0 | 0 | 1 | x | x | x | x |

DRIVER/TERMINATION NETWORKS: Two Intel ${ }^{\oplus} 8226$ Bidirectional Bus Drivers permanently installed at A1 and A2.

DATA POLARITY: Negative-true.
JUMPER CONNECTIONS: $41-42$ to enable input at $8226^{\prime} \mathrm{s}$. Remove $40-41$.
PORT 2 RESTRICTIONS: None; port 2 can be programmed for mode 0 or mode 1, input or output (see Section 4.2.2)

PORT 3 RESTRICTIONS: None; port 3 can be programmed for mode 0 , $\overline{8-b i t}$ input or output, unless port 2 is in mode 1. (see Section 4.2.3).

TABLE 4-5. FORT 1 , MODE 0 LATCHED OUTPUT CONFIGURATION

PORT 1 ADDRESS: E4, CONTROL REGISTER ADDRESS: E7

CONTROL WORD FORMAT: | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |



DRIVER/TERMINATION NETWORKS: Two Intel ${ }^{\circledR} 8226$ Bidirectional Bus Drivers permanently installed at A1 and A2.

DATA POLARITY: Negative-true.
JUMPER CONNECTIONS: $40-41$ to enable output at $8226^{\prime} \mathrm{s}$.
PORT 2 RESTRICTIONS: None; port 2 can be programmed for mode 0 or mode 1, input or output (see Section 4.2.2)

PORT 3 RESTRICTIONS: None; port 3 can be programmed for mode 0 , input or output, unless port 2 is in mode 1 (see Section 4.2.3).

TABLE 4-6. PORT 1, MODE 1 STROBED INPUT CONFIGURATION

PORT 1 ADDRESS: E4, CONTROI REGISTER ADDRESS: E7
CONTROL WORD FORMAT:


DRIVER/TERUINATION NETWORKS: Two Intel ${ }^{\oplus} 8226$ Bidirectional Bus Drivers permanently installed at A1 and A2. A driver network must be instilled at A3 and a termination network must be installed at A4.

DATA POLARITY: Negative-true. The polarity of Port 3 control outputs is denendent on the type of driver installed at A3.

JUMPER CONECTICNS: 41-42 to enable input at $8226^{\circ}$ s; commect 49-50 to enable interrupt request via INT55/. Remove 40-41. 48-49. 50-51.

PORT 2 RESTRICTIONS: None; port 2 can be programmed for mode 0 or mode 1, input or outprit (see Section 4.2.2).

PORT 3 RESTRICTIONS: Port 3 bits perform the following dedicated functions:
*Bits 0,1 and 2 - dedicated to control of port 2 if port 2 is in mode 1 (see Tables 4-9 to 4-12).
*Bit 3 - INTR (interrupt request) output for port 1.
*Bit 4 - STB/ (strobe) input for port 1.
*Bit 5 - IBF (input buffer full) output for port 1.
*Bit 6 Only one bit can be used. If input use bit 6; do not
\& - use bit 7. Bit 3 of Control Word=1. If output use bit
*Bit 77 and remove jumper between 13-14; do not use bit 6 . Bit 3 of Control Word=0.

TABLE 4-7. PORT 1, MODE 1 LATCHED OUTPUT CONFIGURATION

PORT 1 ADDPESS: E4, CONTROL REGISTER ADDRESS: E7
CONTROL WORD FORMAT:

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| 1 | 0 | 1 | 0 | $x$ | $x$ | $x$ | $x$ |

DRIVER/TERMINATION NETWORKS: Two Intel ${ }^{\circledR} 8226$ Bidirectional Bus Drivers permanently installed at A1 and A2. A driver network must be installed at A3 and a termination network must be installed at A4.

DATA POLARITY: Negative-truc. The polarity of Port control outputs is dependent on the type of driver installed at A3.

JUMPER CONNECTIONS: $40-41$ to enable output at $8226^{\prime}$ s; connect 49-50 to enable interrupt request via INT55/. Remove 48-49, 50-51.

PORT 2 RESTRICTIONS: None; port 2 can be programmed for mode 0 or mode 1 , input or output (see Section 4.2.2).

PORT 3 RESTRICTIONS: Port 3 bits perform the following dedicated functions:
*Bits 0,1 and 2 - dedicated to the control of port 2 if port 2 is in mode 1 (see Tables $4-11$ and $4-12$ ).
*Bit 3 - INTR (interrupt request) output for port 1.
*Bit 4 - can be used for input if bit 3 of control word $=1$
*Bit 5 - cannot be used if PC4 is used; can be used for output if control word bit $3=0$ (PCA cannot be used then).
*Bit 6 - ACK/ (acknowledge) input for port 1.
*Bit 7 - OBF/ (output buffer full) output for port 1.

TABLE 4-8. PORT 1, MODE 2 BIDIRECTIONAL CONFIGURATION

## PORT 1 ADDRESS: E4, CONTROL REGISTER ADDRESS: E7

CONTROL WORD FORMAT:


DRIVER/TERMINATION NETWORKS: Two Intel ${ }^{\oplus} 8226$ Bidirectional Bus Drivers permanently installed at A1 and A2. A driver network must be installed at A3 and a termination network must be installed at A4.

DATA POLARITY: Negative-true. The polarity of Port C control outputs is dependent on the type of driver installed at A3.

JUMPER CONNECTIONS: 41-43 to allow ACK/ input on PC6 to dynamically change data direction at $8226^{\text { }}$ s (input when $A C K /=1$ and output when ACK $/=0$ ) ; connect $49-50$ to enable interrupt request via INT55/. Remove 40-41, 48-49, 50-51.

PORT 2 RESTRICTIONS: None.
PORT 3 RESTRICTIONS: Port 3 bits perform the following dedicated functions:
*Bits 0 and 1 - can be used for output if bit 3 of control word $=0$
*Bit 2 - cannot be used if PCO and PC1 are used; can be used for input if control word bit $3=1$ (PCO and PC1 cannot be used then).
*Bit 3 - INTR (interrupt request) output for port 1.
*Bit 4 - STB/ (strobe input for port 1.
*Bit 5 - IBF (input buffer full) output for port 1.
*Bit 6 - ACK/ (acknowledge) input for port 1.
*Bit 7 - OBF/ (output buffer full) output for port 1.

### 4.2.2 PORT 2 (GROUP 1 Port B)

Port 2 can be programmed for input or output in either mode 0 or mode 1. If Port 2 is to be used for input, in either mode, terminator networks must be installed in the sockets at A5 and A6. If Port 2 is to be used for output, in either mode, driver networks must be installed in the sockets at A5 and A6. When Port 2 is programmed for mode 1, interrupts can be enabled by connecting jumper pair 45-46. The four potential configurations for Port 2 are summarized in the following tables:

| PORT 2 CONFIGURATIONS |  |  |
| :---: | :---: | :---: |
| Mode | DABLE |  |
| 1. Mode 0 | Input |  |
| 2. Mode 0 | Output (Latched) | Table 4-9 |
| 3. Mode 1 | Input (Strobed) 4-10 | Table 4-11 |
| 4. Mode 1 | Output (Latched) | Table 4-12 |

TABLE 4-9. PORT 2, MODE 0 INPUT CONFIGURATION
PORT 2 ADDRESS: E5, CONTROL REGISTER ADDRESS: E7
CONTROL WORD FORMAT:


DRIVER/TERMINATION NETWORKS: Termination networks must be installed at A5 and A6.

DATA POLARITY: Positive-true.

JUMPER CONNECTION: None.
PORT 1 RESTRICTIONS: None (see Section 4.2.1).
PORT 3 RESTRICTIONS: None, port 3 can be programmed for mode 0 , input or output, unless port 1 is in mode 1 or mode 2 (see section 4.2.3).

TABLE 4-10. PORT 2, MODE 0 LATCHED OUTPUT CONFIGURATION
PORT 2 ADDRESS: E5, CONTROL REGISTER ADDRESS: E7
CONTROL WORD FORMAT:

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| 1 | x | x | x | x | 0 | 0 | x |

DRIVER/TERMINATION NETWORKS: Driver networks must be installed at A5 and A6.

DATA POLARITY: Negative-true, assuming that inverting drivers are JUMPER CONNECTIONS: None.

PORT 1 RESTRICTIONS: None (see Section 4.2.1).
PORT 3 RESTRICTIONS: None, port 3 can be programmed for mode 0 or mode 1,8 -bit input or output, unless port 1 is in mode 1 or mode 2 (see Section 4.2.3).

TABLE 4-11. PORT 2, MODE 1 STROBED INPUT CONFIGURATION
PORT 2 ADDRESS: E5, CONTROL REGISTER ADDRESS: E7
CONTROL WORD FORMAT

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | 0 | $x$ | $x$ | $x$ | 1 | 1 | $x$ |

DRIVER/TERMINATION NETWORKS: Termination networks must be installed at A5 and A6. A driver network must be installed at A3 and a termination network must be installed at A4.

DATA POLARITY: Positive-true. The polarity of Port control outputs is dependent on the type of driver installed at A3.

JUMPER CONNECTIONS: $\quad 45-46$ to enable interrupt request via INT55/. Remove 44-45, 46-47.
PORT 1 RESTRICTIONS: None.
PORT 3 RESTRICTIONS: Port 3 bits perform the following dedicated functions:

```
*Bit 0 - INTR (interrupt request) output for port 2.
*Bit 1 - IBF (input buffer full) output for port 2.
*Bit 2 - STB/ (strobe) input for port 2.
*Bit 3 to Bit 7 - dedicated to control of port 1 if port 1 is in
    mode 1 (see Tables \(4-4\) to 4-7).
```

TABLE 4-12. PORT 2, MODE 1 LATCHED OUTPUT CONFIGURATION

PORT 2 ADDRESS: E5, CONTROL REGISTER ADDRESS: E7
CONTROL WORD FORMAT


DRIVER/TERMINATION NETWORKS: Driver networks must be installed at A5 and A6. A driver network must be installed at A3 and a termination network must be installed at A4.

DATA POLARITY: Negative-true, assuming that inverting drivers are at A5 and A6. The polarity of Port $C$ control outputs is dependent on the type of driver installed at A3.

JUMPER CONNECTIONS: $45-46$ to enable interrupt request via INT55/ Remove 44-45, 46-47.
PORT 1 RESTRICTIONS: None.
PORT 3 RESTRICTIONS: Port 3 bits perform the following dedicated functions:
*Bit 0 - INTR (interrupt request) output for port 2.
*Bit 1 - OBF/ (output buffer full) output for port 2.
*Bit 2 - ACK/ (acknowledge) input for port 2.
*Bit 3 - P3-7 - dedicated to control of port 1 if port 1 is in mode 1 (see Tables 4-4 to 4-7).

### 4.2.3 PORT 3 (GROUP 1 PORT C)

The use of Port 3 is dependent on the modes programmed for Ports
1 and 2 (refer to Tables $4-4$ to $4-12$ ). While certain Port 3 bits
are available if Port 1 is in mode 1 or if Port 2 is in mode 0, the use of Port 3 as an 8 -bit data path is restricted to those configurations that have both Port 1 and Port 2 programmed for mode 0 . In this case, all eight bits of Port 3 can be programmed for mode 0 input (see Table 4-13) or output (see Table 4-14). A 4-bit input/4-bit output configuration is never possible for group 1 Port C.

Note: If Ports 1 and 2 are not both in mode 0 , then a driver network must be installed in the sockets at A3 and a termination network must be installed at A4, so that the Port 3 control lines can function properly.
4.2.4 PORTS 4 AND 5 (GROUP 2 PORTS A AND B)

- Ports 4 and 5 can be programmed for input or output but only
in mode 0 . The two potential configurations for each port are summarized in the following tables:

|  | CONFIGURATIONS |  | TABLE |
| :---: | :---: | :---: | :---: |
| PORT | MODE | DIRECTION |  |
| 1. | Port 4 | Mode 0 | Input |
| 2. Port 4 | Mode 0 | Output (Latched) | Table 4-15 |
| 1. Port 5 | Mode 0 | Input $4-16$ |  |
| 2. | Port 5 | Mode 0 | Output (Latched) |

TABLE 4-13. PORT 3, MODE 0, 8-BIT INPUT CONFIGURATION

PORT 3 ADDRESS: E6, CONTROL REGISTER ADDRESS: E7
CONTROL WORD FORMAT:

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| 1 | 0 | 0 | $x$ | 1 | 0 | $x$ | 1 |

DRIVER/TERMINATION NETWORKS: Termination networks must be installed at A3 and A4.

DATA POLARITY: Positive-true.

JUMPER CONNECTIONS: $46-47$ and 44-45 to disable port 2 interrupts and enable P3-0; connect $48-49$ and $50-51$ to disable port 1 interrupts and enable P3-3.

PORT 1 AND 2 RESTRICTIONS: Both ports 1 and 2 must be in mode 0.

TABLE 4-14. PORT 3, MODE 0,8-BIT LATCHED OUTPUT CONFIGURATION

PORT 3 ADDRESS: E6, CONTROL REGISTER ADDRESS: E7
CONTROL WORD FORMAT:


DRIVER/TERMINATION NETWORKS: Driver networks must be installed at A3 and A4.

DATA POLARITY: Negative-true, assuming that inverting drivers are installed at A3 and A4.

JUMPER CONNECTIONS: 46-47, and 44-45 to disable port 2 interrupts and enable P3-0; connect $48-49$ and $50-51$ to disable port 1 interrupts and enable P3-3.

PORT 1 AND 2 RESTRICTIONS: Both ports 1 and 2 must be in mode 0 .

TABLE 4-15. PORT 4, MODE 0, INPUT CONFIGURATION

PORT 4 ADDRESS: E8, CONTROL REGISTER ADDRESS: EB
CONTROL WORD FORMAT


DRIVER/TERMINATION NETWORKS: Termination networks must be installed at A7 and A8.

DATA POLARITY: Positive-true,

JUMPER CONNECTIONS: None.
PORT 5 AND 6 RESTRICTIONS: None; ports 5 and 6 can be programmed for mode 0 , input or output (also see Section 4.2.5).

TABLE 4-16. PORT 4, MODE 0 LATCHED OUTPUT CONFIGURATION

PORT 4 ADDRESS: E8, CONTROL REGISTER ADDRESS: EB

CONTROL WORD FORMAT: | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |



DRIVER/TERMINATION NETWORKS: Driver networks must be installed at A7 and A8.

DATA POLARITY: Negative-true, assuming that inverting drivers are installed at A7 and A8.

JUMPER CONNECTIONS: None.
PORT 5 AND 6 RESTRICTIONS: None; ports 5 and 6 can be programmed for mode 0, input or output (also see Section 4.2.5).

TABLE 4-17. PORT 5, MODE 0 INPU' CONFIGURATION

PORT 5 ADDRESS: E9, CONTROL REGISTER ADDRESS: EB
CONTROL WORD FORMAT:


DRIVER/TERMINATION NETWORKS: Termination networks must be installed at A11 and A21.

DATA POLARITY: Positive-true.
JUMPER CONNECTIONS: None.
PORT 4 AND 6 RESTRICTIONS: None; ports 4 and 6 can be programmed for mode 0, input or output (also see Section 4.2.5).

TABLE 4-18. PORT 5, MODE 0 LATCHED OUTPUT CONFIGURATION

PORT 5 ADDRESS: E9, CONTROL REGISTER ADDRESS: EB
CONTROL WORD FORMAT:

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | 0 | 0 | $x$ | $x$ | 0 | 0 | $x$ |

$\frac{\text { DRIVER/TERMINATION NETWORKS: }}{\text { at A11 and A21. }}$ Driver networks must be installed

DATA POLARITY: Negative-true, assuming that inverting drivers are installed at A11 and A21.

JUMPER CONNECTIONS: None.
PORT 4 AND 6 RESTRICTIONS: None; ports 4 and 6 can be programmed for mode 0, input or output (also Section 4.2.5).

### 4.2.5 PORT 6 (GROUP 2 PORT C)

All_eight bits of Po ${ }^{-1} 6$ can be programmed for mode 0 input or output, or four bits can be programmed for mode 0 input while the other four bits are programmed for mode 0 output. The four potential configurations for Port 6 are summarized in the following tables:

|  | PORT 6 CONFIGURATIONS | TABLE |
| :---: | :---: | :---: |
| 1. MODE 0 | 8-BIT INPUT | Table 4-19 |
| 2. MODE 0 | 8-BIT OUTPUT (LATCHED) | Table 4-20 |
| 3. MODE 0 | UPPER 4-BIT INPUT/LOWER 4-BIT OUTPUT | Table 4-21 |
| 4. MODE 0 | UPPER 4-BIT OUTPUT/LOWER 4-BIT INPUT | Table 4-22 |

TABLE 4-19. PORT 6, MODE 0, 8-BIT INPUT CONFIGURATION

PORT 6 ADDRESS: EA, CONTROL REGISTER ADDRESS: EB
CONTROL WORD FORMAT:


DRIVER/TERMINATION NETWORKS: Termination networks must be installed at A9 and A10.

DATA POLARITY: Positive-true.
JUMPER CONNECTIONS: None.
PORT 4 AND 5 RESTRICTIONS: None (see Section 4.2.4).

TABLE 4-20. PORT 6, MODE 0, 8-BIT LATCH:D OUTPUT CONFIGURATION

PORT 6 ADDRESS: EA, CONTROL REGISTER ADDRESS: EB
CONTROL WORD FORMAT:

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | 0 | 0 | x | 0 | 0 | x | 0 |

DRIVER/TERMINATION NETWORKS: Driver networks must be installed at A9 and A10.

DATA POLARITY: Negative-true, assuming that inverting drivers are installed at A9 and A10.

JUMPER CONNECTIONS: None.
PORT 4 AND 5 RESTRICTIONS: None (see Section 4.2.4).

TABLE 4-21. PORT 6, MODE 0 UPPER 4-BIT INPUT/LOWER 4-BIT LATCHED OUTPUT CONFIGURATION

PORT 6 ADDRESS: EA, CONTROL REGISTER ADDRESS: EB

CONTROL WORD FORMAT: | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |



DRIVER/TERMINATION NETWORKS: A termination network must be installed at A9 and a driver network must be installed at A10.

DATA POLARITY: The upper 4-bits will be in positive-true form; however, the lower four bits will be in negative-true form if an inverting driver is installed at A10.

JUMPER CONNECTIONS: None.
PORT 4 AND 5 RESTRICTIONS: None (see Section 4.2.4).

TABLE 4-22. PORT 6, MODE 0 UPPER 4-BIT LATCHED OUTPUT/LOWER 4-BIT INPUT CONFIGURATION

PORT 6 ADDRESS: EA, CONTROL REGISTER ADDRESS: EB
CONTROL WORD FORMAT: $\begin{array}{lllllllll}7 & 6 & 5 & 4 & 3 & 2 & 1 & 0\end{array}$


DRIVER/TERMINATION NETWORKS: A driver network must be installed at A9 and a termination network must be installed at A10.

DATA POLARITY: The lower 4-bits will be in positive-true form; however, the upper 4-bits will be in negative-true form if an inverting driver is installed at A9.

JUMPER CONNECTIONS: None.
PORT 4 AND 5 RESTRICTIONS: None (see Section 4.2.4).

TABLE 4-23. PARALLEL I/O ADDRESS AND SOCKET ASSIGNMENTS

| PORT | I/O ADDRESS | SOCKET NUMBERS |
| :---: | :---: | :--- |
| 1 | E4 | BI-DIRECTIONAL DRIVER/ <br> TERMINATOR AT A1, A2 |
| 2 | E5 | A5, A6 |
| 3 | E6 | A3, A4* |
| 4 | E8 | A7, A8 |
| 5 | E9 | A11, A21 |
| 6 | EA | A9, A10** |

*Note requirements specified in Tables 4-4 through 4-14.
**Note requirements specified in Tables 4-15 through 4-22.

### 4.3 GENERAL OPTIONS

There are several other options that may be useful. Details are provided in the following paragraphs.

### 4.3.1 SYSTEM RESET OUTPUT

The user can enable a SYSTEM RESET output from the SBC $80 / 10$ by connecting jumper pair 54-55. This allows the reset signal which is generated on the SBC $80 / 10$ during power-up sequences (see Section 3.1.5) to be made available to other modules in the system via connector Pl-14. Notice on the schematic that a SYSTEM RESET input is accepted by the SBC $80 / 10$ and P1-14 and applied to the 8080 regardless of jumper connections.

### 4.3.2 DISABLE BUS CLOCK SIGNALS

The bus clock BCLK/ (connector pin P1-13) or the constant clock CCLK/ (P-31) outputs can be disabled (if more drive, or a different frequency is needed) by disconnecting jumper pair 61-63 or 62-64, respectively. When connected, both BCLK/ and CCLK/ provide a 9.216 MHz timing reference to other modules.

### 4.3.3 ACKNOWLEDGE INPUTS

The SBC bus has defined two types of acknowledges; transfer acknowledge (XACK/) and advance acknowledge (AACK/). XACK/ is the required response of a memory or I/O port which indicates that the specified read/write operation has been completed. That is, data has been placed on (READ command) or accepted from (WRITE command) the system data bus lines. XACK/ is asynchronous with BCLK/. AACK/ is an advance acknow-


FIGURE 4-1. READ COMMAND WITH XACK/
ledge in response to a memory or $I / O$ port command. This optional acknowledge is used only with 8080 CPU-based systems where maximum system performance is needed. Figure 4-2 shows timing of the SBC 80/10 "READING" memory using the AACK/ signal.

AACK/ is a response to a READ command indicating that data will be valid on the bus by the time the 8080 needs it. Thus, if the access time of the slave device is less than $t_{A C C}$ (command to data needed by the 8080 ), the slave module has $t_{8 K D}$ (command to 8080 sample point of bus acknowledge) to indicate that the data on the bus will be valid when the 8080 needs it. If the access time of a module is less than $t_{8 K D}$ then only XACK/ need be used and the 8080 will run at maximum speed.

If the access time of a module is greater than $t_{8 \mathrm{KD}}$, but less than $t_{\text {ACC }}$, AACK/ must be used, if the 8080 is to run at maximum speed. If AACK/ is not used and instead XACK/ is used, the 8080 will execute one more wait state than is necessary. AACK/ is asynchronous with BCLK/.


FIGURE 4-2. READ COMMAND WITH AACK/

AACK/ is also an advance response to a WRITE command indicating that the slave module will have accepted the data from the system bus by the time the 8080 has completed the WRITE. Figure 4-3 shows timing of the SBC $80 / 10$ "WRITING" memory using the AACK/ signal.


FIGURE 4-3. WRITE COMMAND WITH AACK/

When modules that generate proper AACK/ are used with the SBC $80 / 10$, jumper pair 52-53 should be connected to allow AACK/ to be accepted (at P1-25) and gated to the RDYIN pin on the 8224 clock generator. If this option is used, caution should be taken to insure that all the modules on the bus meet the SBC $80 / 10$ timing requirements.

### 4.3.4 INTERRUPT. SOURCES

There are six sources of interrupts on the SBC $80 / 10$ board, two from the serial I/O section (see 3.5 .4 ), two from the parallel I/O section (see 3.6), and two from external sources. One of the external sources is INTR1/. INTR1/ is connected to the SBC bus (P1-42) and is the only interrupt line that other SBC modules can use to interrupt the $\operatorname{SBC} 80 / 10$. The other external interrupt is EXT INTR $\varnothing /$. This interrupt is connected to the paralle1 I/O connector J1 (pin 49) and can be used by an external device to interrupt the SBC $80 / 10$. Both external interrupts are negative true logic, a TTL low ( $\mathrm{V}_{\mathrm{IN}}<0.4$ volts) will cause the 8080 to interrupt and execute a RST 7 instruction. The processor can then read in the status registers of the possible interrupting devices to determine which device generated the interrupt. Then the processor can jump to the correct interrupt service routine, service that device, enable interrupts, and return.

### 4.4 DEFAULT OPTIONS

Table 4-24 lists the default options.jumpered on the SBC 80/10. These options permit the $\operatorname{SBC} 80 / 10$ to communicate to a TTY; they also provide power-up reset, bus clock, and the communication clock to the system bus. If the SBC $80 / 10$ is driving the bus clock (BCLK/) and/or the communications clock (CCLK/), the system bus must be limited to 7 Inches. This limitation is due to the SBC $80 / 10^{\prime}$ 's limited drive capability on these clock lines. The system bus can be extended beyond 7 inches if the user provides BCLK/ and CCLK/.

TABLE 4-24. DEFAULT OPTION

| DEFAULT JUMPERS | REFERENCE | DESCRIPTION |
| :---: | :---: | :---: |
| 1-2 | 4.1 .1 | Connect 8251 T ${ }_{\text {D }}$ to 20 mA Current Loop Driver |
| 23-24 |  | Connect 8251 DTR/ to TTY Reader Control Circuit |
| 39-38 |  | Connect $8251 \mathrm{R}_{\mathrm{x}} \mathrm{D}$ to 20 mA Current Loop Receiver |
| 4-8 | 4.1 .2 | Generates 6.98K Baud Rate Clock |
| 57-56 |  | Generates 6.98K Baud Rate Clock |
| 34-33 |  | Connect $8251 \mathrm{~T}_{\mathrm{x}}$ Clock to Baud Rate Clock |
| 35-36 |  | Connect $8251 \mathrm{R}_{\mathrm{x}}$ Clock to Baud Rate Clock |
| 27-29 |  | Connect 8251 RTS/ to 8251 CTS/ |
| 19-20 | 3.5 .4 | Disable $\mathrm{T}_{\mathrm{x}} \mathrm{RDY}$ Interrupt from 8251 |
| 16-15 | 3.5 .4 | Disable $\mathrm{R}_{\mathrm{x}} \mathrm{RDY}$ Interrupt from 8251 |
| 26-25 | 4.1 .2 | Connect DTR/ Receiver to 8251 DSR/ Input |
| 30-31 | 4.1.2 | Connect Set Clear to Send Driver to +12 V |
| 40-41 | 4.2 .1 | Enable Port 1 Bi-directional Drivers to Output |
| 54-55 | 4.3 .1 | Connect Power-Up Reset to System Bus |
| 62-64 | 4.3.2 | Connect 9.216 MHz Clock to Communication Clock Line |
| 61-63 | 4.3 .2 | Connect 9.216 MHz Clock to Bus Clock Line |
| *65-66 | 4.5 |  |
| $\text { *68 - } 69$ | 4.5 | Configures SBC $80 / 10 \mathrm{~A}$ for 4 K ROM/PROM |
| *73-74 | 4.5 |  |
| *76-78 | 4.5 |  |
| *Used on | C $80 / 10 \mathrm{~A}$ | 1y. |

### 4.5 JUMPER CONFIGURATION FOR ROM/EPROM INSTALLATION

The SBC $80 / 10 \mathrm{~A}$ has jumpers which allow installation of up to 4 K or up to 8 K bytes of read only memory. Up to 4 K bytes can be installed using Intel's 8708 Erasable and Electrically Reprogrammable ROMs (EPROM), Intel's 8308 Metal Masked ROMs, or Intel's 2758 Erasable and Electrically Reprogrammable ROMs (EPROM). Up to 8 K bytes can be installed using Intel's 2716 Erasable and Electrically Reprogrammable ROMs (EPROM) or Intel's 2316E Metal Masked ROMs. Table 4-25 lists the jumper configurations for 4 K and 8 K bytes of read only memory. Table 4-26 lists the addresses for each PROM socket in 4 K and 8 K configurations.

TABLE 4-25. PROM JUMPER CONFIGURATION

|  | JUMPER |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| 4K | 65-66 | 68-69 | 73-74 | $76 \cdot 78$ |
| 8 K | 66-67 | 69-70 | 74-75 | 77-78 |
| *4K | 66-67 | 69-71 | 73-74 | 76-78 |
| *Using Intel's 2758 Erasable and Electrically Reprogrammable ROMs (EPROM) |  |  |  |  |

TABLE 4-26. PROM ADDRESSES

|  | CHIP ADDRESS |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  | A23 | A24 | A25 | A26 |
|  | $0-3 \mathrm{FF}$ | $400-7 \mathrm{FF}$ | $800-\mathrm{BFF}$ | $\mathrm{C} 00-\mathrm{FFF}$ |
|  | $0-7 \mathrm{FF}$ | $1000-17 \mathrm{FF}$ | $800-\mathrm{FFF}$ | $1800-1 \mathrm{FFF}$ |

The $S B C-80 / 10$, with its memory and $I / 0$ ports, is a complete computer on a single printed circuit board. However, the SBC-80/10 can also serve as a primary master module within an expanded system, communicating with numerous memory and $I / O$ modules. In this chapter we identify each of the SBC-80/10's external connections and define all signals on the external system bus.

### 5.1 ELECTRICAL CONNECTIONS

The SBC-80/10 comes on a $12.00 \times 6.75$ inch printed circuit board, 0.50 inch thick and weighing 12 oz . The DC power requirements are listed in Table 7-1.

The $\operatorname{SBC}-80 / 10$ has five edge connectors, as shown in Figure $5-1$. Edge connectors at the top of the module are designed for compatibility with both flat cable and round cable hardware. All parallel I/O functions are paired with an independent signal ground pin. This allows flat cable implementation to utilize an alternate signal/ground scheme for reduction of cross talk. Round cables may easily be implemented as twisted pair with an individual ground pin for every return wire. The serial connection hardware has similar flexibility but ground return lines are not as extensive. The connector is wired for RS232C compatibility, thus, only one signal ground is provided.

## CAUTION

> All pin numbers listed in the following tables refer to numbers printed on the board, not to mating connector pin positions. When specifying pin numbers for cable harnesses, use caution since pin numbering is not necessarily the same as the connector pin numbering scheme.

The Parallel I/O Interface communicates with external I/O devices via two 50 -pin double-sided $P C$ edge connectors (J1 and $J 2$ ), 0.1 inch centers. External devices can be attached to J1 or J2 using any of the following mating connectors:

J1 and J2 Mating Connectors

| Connector Type | Vendor | Part No. |
| :--- | :--- | :--- |
| Flat Cable | 3M | $3415-0001$ |
|  | AMP | $2-86792-3$ |
| Soldered | AMP | $2-583715-3$ |
|  | VIKING | $3 \mathrm{VH} 25 / 1 \mathrm{JV}-5$ |
|  | TI | H312125 |
| Wire-wrap | TI | H 311125 |
|  | VIKING | $3 \mathrm{VH25/1JND-5}$ |
|  | CDC | VPB01B25D00A1 |
|  | ITT | EC4A050A1A |
| Crimp | AMP | $1-583717-1$ |

Tables $5-1$ and 5-2 provide pin lists for the J1 and J2 connectors, respectively. The following TTL line drivers and Intel terminators are all compatible with the $I / O$ driver sockets in the Parallel I/O Interface:

$$
5-2
$$

| Driver | Characteristic | Sink Current (ma) |
| :--- | :---: | :---: |
| 7438 | I, OC | 48 |
| 7437 | I | 48 |
| 7432 | NI | 16 |
| 7426 | I, OC | 16 |
| 7409 | NI, OC | 16 |
| 7408 | NI | 16 |
| 7403 | I, OC | 16 |
| 7400 | I | 16 |

Note: $\mathrm{I}=$ inverting; $\mathrm{N} . \mathrm{I} .=$ non-inverting
$O C=$ open collector

I/O Terminators:
Terminators: $220 \Omega / 330 \Omega$ divider or $1 \mathrm{k} \Omega$ pull up


SBC-901

SBC-902

See Appendix $C$ for schematics

TABLE 5-1. PIN ASSIGNMENTS FOR CONNECTOR J1
(Parallel I/O Interface - Group 1)

| PIN | SIGNAL | PIN | SIGNAL |
| :---: | :---: | :---: | :---: |
| 1 | PORT 2 - BIT 3 | 2 | GND |
| 3 | PORT 2 - BIT 2 | 4 | A |
| 5 | PORT 2 - BIT 1 | 6 |  |
| 7 | PORT 2 - BIT 0 | 8 |  |
| 9 | PORT 2 - BIT 4 | 10 |  |
| 11 | PORT 2 - BIT 5 | 12 |  |
| 13 | PORT 2 - BIT 6 | 14 |  |
| 15 | PORT 2 - BIT 7 | 16 |  |
| 17 | PORT 3 - BIT 3 | 18 |  |
| 19 | PORT 3- BIT 2 | 20 |  |
| 21 | PORT 3-BIT 4 | 22 |  |
| 23 | PORT 3-BIT 6 | 24 |  |
| 25 | PORT 3-BIT 0 | 26 |  |
| 27 | PORT 3-BIT 5 | 28 |  |
| 29 | PORT 3-BIT 1 | 30 |  |
| 31 | PORT 3 - BIT 7 | 32 |  |
| 33 | PORT 1 - BIT 7 | 34 |  |
| 35 | PORT 1 - BIT 6 | 36 |  |
| 37 | PORT 1 - BIT 5 | 38 |  |
| 39 | PORT 1 - BIT 4 | 40 |  |
| 41 | PORT 1 - BIT 1 | 42 |  |
| 43 | PORT 1- BIT 0 | 44 |  |
| 45 | PORT 1 - BIT 2 | 46 |  |
| 47 | PORT 1 - BIT 3 | 48 | \% |
| 49 | EXT INTR 1/ | 50 | GND |



FIGURE 5-1. EDGE CONNECTORS

| PIN | SI GNAL | PIN | S IGNAL |
| :---: | :---: | :---: | :---: |
| 1 | GND | 2 | GND |
| 3 | PORT 5 - BIT 3 | 4 | , |
| 5 | PORT 5- BIT 0 | 6 |  |
| 7 | PORT 5 - BIT 1 | 8 |  |
| 9 | PORT 5 - BIT 2 | 10 |  |
| 11 | PORT 5- BIT 4 | 12 |  |
| 13 | PORT 5- BIT 5 | 14 |  |
| 15 | PORT 5 - BIT 6 | 16 |  |
| 17 | PORT 5 - BIT 7 | 18 |  |
| 19 | PORT 6-BIT 3 | 20 |  |
| 21 | PORT 6-BIT 2 | 22 |  |
| 23 | PORT 6- BIT 1 | 24 |  |
| 25 | PORT 6-BIT 0 | 26 |  |
| 27 | PORT 6 - BIT 4 | 28 |  |
| 29 | PORT 6-BIT 5 | 30 |  |
| 31 | PORT 6-BIT 6 | 32 |  |
| 33 | PORT 6 - BIT 7 | 34 |  |
| 35 | PORT 4-BIT 7 | 36 |  |
| 37. | PORT 4 - BIT 6 | 38 |  |
| 39 | PORT 4-BIT 5 | 40 |  |
| 41 | PORT 4 - BIT 4 | 42 |  |
| 43 | PORT 4 - BIT 0 | 44 |  |
| 45 | PORT 4-BIT 1 | 46 |  |
| 47 | PORT 4-BIT 2 | 48 | 1 |
| 49 | PORT 4 - BIT 3 | 50 | GND |

The Serial $1 / O$ Interface communicates with an external $1 / O$ device via a 26-pin double-sided PC edge connector (J3), 0.1 inch centers. An external device can be connected to J3 using a 3M 3462-0001 flat cable connector or one of the following soldered connectors: TI H312113 or AMP 1-583715-1. Table 5-3 provides a pin list for connector J3.

The $\operatorname{SBC}-80 / 10$ conmunicates with other system modules via an 86pin double-sided edge connector (P1), 0. 156 inch centers. This
edge connector will accept any of the following mating connectors: CDC VPBOLE43A000A1, Micro Plastics MP-0156-43-BW-4 or ARCO AE 443WP1. Section 5.2 defines each of the external system bus signals and includes a pin list for P1 (Table 5-5).

TABLE 5-3. PIN ASSIGNMENTS FOR CONNECTOR J3
(Serial I/O Interface)

| PIN | SIGNAL NAME | PIN | SIGNAL NAME |
| :---: | :--- | :---: | :--- |
| 1 | CHASSIS GND | 2 |  |
| 3 | TRANSMITTED DATA | 4 |  |
| 5 | RECEIVED DATA | 6 | TTY RD CONTROL |
| 7 | REQ TO SEND | 8 |  |
| 9 | CLEAR TO SEND | 10 |  |
| 11 | DATA SET READY | 12 |  |
| 13 | GND | 14 | TX CLK/DATA TERMINAL RDY |
| 15 | DATA CARRIER RETURN | 16 | TYIY RD CONTROL RETURN |
| 17 |  | 18 |  |
| 19 |  | 20 |  |
| 21 |  | 22 | RECEIVE CLK/TTY RX DATA |
| 23 | TIY RX DATA | 24 | RETURN |
| 25 | TTY TX DATA | 26 | GTY TX DATA RETURN |
|  |  |  |  |

The 60-pin double-sided edge connector labeled p2 in Figure 5-1 allows access to various test points on the $\operatorname{SBC}-80 / 10$ (see Table 5-4). The following wire-wrap connectors will attacl to P 2 :

CDC VP1301B30A00A2, TI H311130 and AMP PE5-14559

TABLE 5-4. PIN ASSIGNMENTS FOR CONNECTOR P2 (Auxilliary Connector)

| SIGNAL NAME | $\begin{gathered} \text { PIN } \\ \text { ASSIGNMENT } \end{gathered}$ | COMMENT |
| :---: | :---: | :---: |
| OSC <br> RAM 3COO ENABLE/ RAM 3DOO ENABLE/ RAM 3E00 ENABLE/ RAM 3FOO ENABLE/ OSC INH/ DATA BUS INH/ baUd rate clk tTy COUNT 1 ENABLE 1 BAUD RATE CLK COUNT 2 ENABLE/ TIME OUT ENABLE/ B \& C CLK SET/ STATUS STROBE RDY IN INH/ BAUD RATE CLEAR/ OSC/2 | $\begin{aligned} & \mathrm{P} 2-28 \\ & \mathrm{P} 2-30 \\ & \mathrm{P} 2-32 \\ & \mathrm{P} 2-34 \\ & \mathrm{P} 2-36 \\ & \mathrm{P} 2-40 \\ & \mathrm{P} 2-42 \\ & \mathrm{P} 2-44 \\ & \mathrm{P} 2-46 \\ & \mathrm{P} 2-50 \\ & \mathrm{P} 2-52 \\ & \mathrm{P} 2-54 \\ & \mathrm{P} 2-55 \\ & \mathrm{P} 2-56 \\ & \mathrm{P} 2-57 \\ & \mathrm{P} 2-58 \\ & \mathrm{P} 2-60 \end{aligned}$ |  |

### 5.2 EXTERNAL SBC 80/10 SYSTEM BUS SUMMARY

A significant measure of the $\mathrm{SBC}-80 / 10^{\prime} \mathrm{s}$ power and flexibility can be attributed to its external system bus. In expanded systems, the external bus structure allows for master-slave relationships between the various system modules. The bus includes its own clock (BCLK/) which is derived independently from the processor clock.

Actual transfers via the bus, however, proceed asynchronously with respect to the bus clock. Thus, the transfer speed is dependent on the transmitting and receiving devices only. Once a module has gained
control of the bus by activating the BPRN input to the $S B C-80 / 10$, single or multiple read/write transfers can proceed at a maximum rate of 5 million data bytes per second. The 16 system address lines allow the $\operatorname{SBC}-80 / 10$ to support up to 65,536 bytes of storage. The signal lines on the external system bus are defined as follows:

BCLK/ Bus clock; used to synchronize bus control circuits on all master modules. BCLK/ has a period of $\sim 110$ nanoseconds ( 9.216 MHz frequency), $30 \%-70 \%$ duty cycle. BCLK/ may be slowed, stopped or single stepped, if desired (see Section 4.4). Initialization signal; resets the entire system to a known internal state.

Bus priority input signal; indicates to the SBC-80/10 that a higher priority master module is requesting use of the system bus. BPRN suspends the processing activity and drivers of the SBC-80/10.

BUSY/ Bus busy signal; indicates that the bus is currently in use. BUSY/ prevents all other master modules from gaining control of the bus. BUSY/ is driven by the HLDA/ output from the $\mathrm{SBC}-80 / 10$ in response to a BPRN input. It indicates that the bus is available. Memory read command; indicates that the address of a memory location has been placed on the system address lines and specifies that the contents of the addressed location are to be read and placed on the system data bus.

| MWTC/ | Memory write command; indicates that the address of |
| :---: | :---: |
|  | a memory location has been placed on the system |
|  | address lines and that a data word has been placed |
|  | on the system data bus. MWTC/ specifies that the |
|  | data word is to be written into the addressed memory |
|  | location. |
| IORC/ | I/O read command; indicates that the address of |
|  | an input port has been placed on the system address |
|  | bus and that the data at that input port is to be |
|  | read and placed on the system data bus. |
| IOWC/ | I/O write command; indicates that the address of |
|  | an output port has been placed on the system address |
|  | bus and that the contents of the system data bus are |
|  | to be output to the addressed port. |
| XACK/ | Transfer acknowledge signal; the required response |
|  | of an external memory location or I/O port which |
|  | indicates that the specified read/write operation |
|  | has been completed. That is, data has been placed |
|  | on, or accepted from, the system data bus 1 ines. |
| AACK/ | Advance acknowledge signal; used with 8080 CPU- |
|  | based systems. AACK/ is an advance acknowledge, |
|  | in response to a memory read command, that allows |
|  | the memory to complete the access without requiring |
|  | the CPU to wait. |

TABLE 5-5. PIN ASSIGNMENTS FOR CONNECTOR P1
(External System Bus)

|  | (COMPONENT SIDE) |  |  | (CIRCUIT SIDE) |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | PIN | MNEMONIC | DESCRIPTION | PIN | MNEMONIC | DESCRIPTION |
| POWER SUPPLIES | $\begin{array}{r} 1 \\ 3 \\ 5 \\ 7 \\ 9 \\ 11 \end{array}$ | $\begin{aligned} & \text { GND } \\ & \text { VCC } \\ & \text { VCC } \\ & \text { VDD } \\ & \text { VBB } \\ & \text { GND } \end{aligned}$ | $\begin{gathered} \text { Signal GND } \\ +5 \mathrm{VDC} \\ +5 \mathrm{VDC} \\ +12 \mathrm{VDC} \\ -5 \mathrm{VDC} \\ \text { Signal GND } \end{gathered}$ | $\begin{array}{r} 2 \\ 4 \\ 6 \\ 8 \\ 10 \\ 12 \end{array}$ | GND <br> VCC <br> VCC <br> VDD <br> VBB <br> GND | $\begin{gathered} \text { Signal GND } \\ +5 V D C \\ +5 V D C \\ +12 V D C \\ -5 V D C \\ \text { Signal GND } \end{gathered}$ |
| BUS CONTROLS | $\begin{aligned} & 13 \\ & 15 \\ & 17 \\ & 19 \\ & 21 \\ & 23 \end{aligned}$ | BCLK/ <br> BPRN <br> BUSY/ <br> MRDC/ <br> IORC/ <br> XACK/ | Bus Clock Bus Pri. In Bus Busy Mem Read Cmd I/O Read Cmd XFER Acknow | $\begin{aligned} & 14 \\ & 16 \\ & 18 \\ & 20 \\ & 22 \\ & 24 \end{aligned}$ | INIT/ $D$ MWTC/ IOWC/ (1) | Initialize <br> Mem Write Cmd I/O Write Cmd |
| SPARES | $\begin{aligned} & 25 \\ & 27 \\ & 29 \\ & 31 \\ & 33 \end{aligned}$ | AACK/ <br> CCLK/ <br> D | Special <br> Constant Clock | 26 28 30 32 34 |  |  |
| NTERRUPTS | $\begin{aligned} & 35 \\ & 37 \\ & 39 \\ & 41 \end{aligned}$ | $\frac{1}{3}$ |  | $\begin{aligned} & 36 \\ & 38 \\ & 40 \\ & 42 \end{aligned}$ | $\underset{\substack{D \\ \text { INTR1/ } \\ D}}{\substack{1 \\ \hline}}$ | Interrupt request |
| ADDRESS | $\begin{aligned} & 43 \\ & 45 \\ & 47 \\ & 49 \\ & 51 \\ & 53 \\ & 55 \\ & 57 \end{aligned}$ | ADRE/ <br> ADRC/ <br> ADRA/ <br> ADR8/ <br> ADR6/ <br> ADR4/ <br> ADR2 / <br> ADRO/ | $\begin{aligned} & \text { Address } \\ & \text { Bus } \end{aligned}$ | $\begin{aligned} & 44 \\ & 46 \\ & 48 \\ & 50 \\ & 52 \\ & 54 \\ & 56 \\ & 58 \end{aligned}$ | ADRF/ <br> ADRD/ <br> ADRB/ <br> ADR9/ <br> ADR7/ <br> ADR5/ <br> ADR3/ <br> ADR1/ | Address Bus |
| DATA | $\begin{aligned} & 59 \\ & 61 \\ & 63 \\ & 65 \\ & 67 \\ & 69 \\ & 71 \\ & 73 \end{aligned}$ | $\begin{aligned} & D \\ & D \\ & D \\ & \text { DAT6/ } \\ & \text { DAT4/ } \\ & \text { DAT4 } \\ & \text { DAT2/ } \\ & \text { DAT0/ } \end{aligned}$ | Data Bus | $\begin{aligned} & 60 \\ & 62 \\ & 64 \\ & 66 \\ & 68 \\ & 70 \\ & 72 \\ & 74 \end{aligned}$ | $\begin{aligned} & \text { D> } \\ & \square \\ & D \\ & D \\ & \text { DAT7/ } \\ & \text { DAT5/ } \\ & \text { DAT3/ } \\ & \text { DAT1/ } \end{aligned}$ | Data Bus |
| POWER YJPPLIES | $\begin{aligned} & 75 \\ & 77 \\ & 79 \\ & 81 \\ & 83 \\ & 85 \end{aligned}$ | $\begin{aligned} & \text { GND } \\ & \text { VBBD } \\ & \text { VAA } \\ & \text { VCC } \\ & \text { VCC } \\ & \text { GND } \end{aligned}$ | Signal GND <br> -10VDC <br> -12VDC <br> $+5 \mathrm{VDC}$ <br> $+5 \mathrm{VDC}$ <br> Signal GND | $\begin{aligned} & 76 \\ & 78 \\ & 80 \\ & 82 \\ & 84 \\ & 86 \end{aligned}$ | $\begin{aligned} & \text { GND } \\ & \text { VBB } \\ & \text { VAA } \\ & \text { VCC } \\ & \text { VCC } \\ & \text { GND } \end{aligned}$ | $\begin{aligned} & \text { Signal GND } \\ & \text {-10VDC } \\ & \text {-12VDC } \\ & +5 \mathrm{VDC} \\ & +5 \mathrm{VDC} \\ & \text { Signal GND } \end{aligned}$ |

(1) Used by Intellec ${ }^{\text {® }}$ MDS Bus.

CCLK/

INTR1/
ADRO/-ADRF/

DATO/-DAT7/

Constant clock; provides a clock signal of constant frequency ( 9.216 MHz ) for use by option memory and I/O expansion boards. CCLK/ coincides with BCLK/ and has a period of $\sim 110$ nanoseconds. 30\%-70\% duty cycie (see Section 4.4). Externally generated interrupt request. 16 Address lines: used to transmit the address of the memory location or $I / O$ port to be accessed. ADRF/ is the most significant bit. Bi-directional data lines; used to transmit/receive information to/from a memory location or $1 / O$ port. DAT7/ is the most significant bit.

### 5.3 RS232C CABLING

When the Serial I/O Interface is configured as an RS232C interface, the J3 edge connector can be cabled such that a RS232C pincompatible connector is presented to the uscr's terminal or modem. A 26-pin mating connector, $3 \mathrm{M} 3462-0001$, should be attached to the J3 edge connector on the SBC-80/10 and to a 25 -wire flat cable, 3M 3349/25. The flat cable is, in turn, attached to the RS232C pincompatible connector, 3 M 3483-1000. Table 5-6 equates the 33 edge connector pins with the associated RS232-compatible pins on the 3M 3483-1000 connector.

Note: Using this 3 M cable assemble, the RS232C connector pin-outs are MDS compatible. That is, if the $\operatorname{SBC} 80 / 10$ is set up to drive a TTY, an MDS modified TTY can be used directly with the SBC $80 / 10$.

TABLE 5-6. J3/RS232C CONNECTOR PIN CORRESPONDENCE

|  | J3 CONNECTOR <br> PIN NO. | RS232C CONNECTOR <br> PIN NO. |
| :--- | :---: | :---: |
|  |  |  |
| CHASSIS GND | 1 | 1 |
| TRANSMITTED DATA | 2 | 14 |
| RECEIVED DATA | 3 | 2 |
| TTY RD CONTROL | 4 | 15 |
| REQ TO SEND | 5 | 3 |
| CLEAR TO SEND | 6 | 16 |
| DATA SET READY | 7 | 4 |
|  | 8 | 17 |
| GND | 9 | 5 |
| Tx CLK/DATA TERMINAL RDY | 10 | 18 |
| DATA CARRIER RETURN | 11 | 6 |
| TTY RD CONTRUL RETURN | 12 | 19 |
|  | 13 | 7 |
|  | 14 | 20 |
|  | 16 | 8 |
| RECEIVE CLK/TTY Rx DATA | 17 | 21 |
| RETURN | 18 | 9 |
| TTY Rx DATA | 19 | 10 |
| TTY Tx DATA RETURN Tx DATA | 20 | 23 |
|  | 21 | 11 |

### 5.4 TELETYPE MODIFICATIONS

The ASR-33 Teletypewriter must be modified for use with the SBC 80/10 Boards. Appendix $B$ is a procedure for modifying the ASR-33 Teletypewriter.

## CHAPTER 6

## INTERFACING TO MULTIBUS MASTERS

The SBC 80/10's system bus structure permits interfacing to one other Multibus-Compatible Master module. This interface is accomplished using the serial priority scheme as shown in figure 6-1 using the Intel SBC 604 Cardcage/Backplane. The SBC 80/10 does not provide the Bus Priority Request Out (BPRO/) signal and therefore, the SBC 80/10 can only be used with one other Multibus master. For these configurations, the SBC $80 / 10$ must always have lower priority than the other Multibus master and a wire must be added from the master's BREQ/ pin (pin 18) to the $\operatorname{SBC} 80 / 10$ BPRN pin (pin 15). In the configuration shown in figure 6-1 the $\operatorname{SBC} 80 / 10$ acquires control of the Multibus whenever BREQ/ generated by the Diskette Controller is in the high state. This occurs whenever the Diskette Controller is not using the Multibus. Similarly BREQ/ is driven to the low state when the Diskette Controller acquires control of the Multibus disabling the SBC 80/10 from accessing the Multibus.

For a detailed description of Multibus interfacing refer to the Inte1 Multibus Interfacing Application Note (AP-28).


Figure 6-1. Serial Priority Configuration with another Multibus Master

## CHAPTER 7

## SPECIFICATIONS

### 7.1 DC POWER REQUIREMENTS

DC Power Requirements are given in Table 7-1.

### 7.2 AC CHARACTERISTICS

Detailed timing diagrams for memory, I/O and Bus exchange operations are provided in Figures 7-1 through 7-3. Tables 7-3 and 7-4 provide design limits for $\operatorname{SBC}-80 / 10$ outputs and requirements for its inputs. These values are theoretical limits based on a "worst-on-worst" case analysis using vendor information and approximations where necessary. Approximations include establishing non-zero propagation delay minimums and extended delays if capacitive loading exceeds vendor ratings. In all such cases, approximations are conservative (e.g., 2 ns minimum for standard TTL, 4 ns minimum for tri-state turn-offs or turn-ons). Rise and fall times are assumed to be zero unless a three-state high impedance state or open collector circuit is involved.

### 7.3 DC CHARACTERISTICS <br> DC Characteristics are given in Table 7-4.

### 7.4 ENVIRONMENT

Temperature extremes can cause instability, or result in permanent damage to the circuits on the module. Ambient temperature must, therefore, be maintained within the limits of $0^{\circ} \mathrm{C}$ to $55^{\circ} \mathrm{C}$. Exercise caution in locating the module, giving particular attention to radiant and conducive sources of heat. Remember that the module itself, when installed,
will contribute some heat to the environment. Maintain an adequate clearance to permit the convective dissipation of heat from the elements on the card.

Relative humidity should not exceed $90 \%$, non-condensing.

### 7.5 BOARD OUTLINE

See Figure 7-4.

### 7.6 COMPATIBLE CONNECTORS

Table 7-5 lists compatible connectors which mate to the $\mathrm{SBC}-80 / 10$ and SBC 80/10A PC edge connectors.

TABLE 7-1. DC POWER REQUIREMENTS

| - | Without <br> EPROM $^{1}$ | With 8708 <br> EPROM $^{2}$ | With 2758 or <br> 2716 EPROM $^{3}$ |
| :---: | :--- | :---: | :---: |
| $\mathrm{~V}_{\mathrm{CC}}+5 \mathrm{~V} \pm 5 \%$ | $\mathrm{I}_{\mathrm{CC}}=2.9 \mathrm{~A}$ | 4.0 A | 4.36 A |
| $\mathrm{~V}_{\mathrm{DD}}+12 \mathrm{~V} \pm 5 \%$ | $\mathrm{I}_{\mathrm{DD}}=150 \mathrm{~mA}$ | 400 mA | $150 . \mathrm{mA}$ |
| $\mathrm{V}_{\mathrm{BB}}-5 \mathrm{~V} \pm 5 \%$ | $\mathrm{I}_{\mathrm{BB}}=2 \mathrm{~mA}^{4}$ | 200 mA | $2 \mathrm{~mA}^{4}$ |
| $\mathrm{~V}_{\mathrm{AA}}-12 \mathrm{~V} \pm 5 \%$ | $\mathrm{I}_{\mathrm{AA}}=175 \mathrm{~mA}$ | 175 mA | 175 mA |

1. Does not include power required for optional ROM/EPROM, I/O drivers or I/O terminators.
2. With four Intel 8708 EPROMs and 2208/3308 terminators installed for 48 input lines; all terminator inputs low.
3. With four Intel 2758 or 2716 EPROMs and $220 \Omega / 330 \Omega$ terminators installed for 48 input ports; all terminator inputs low.
4. Required for RS232C drivers.

TABLE 7-2. AC CHARACTERISTICS WITH BUS EXCHANGE

| Parameter | OVERALL |  | WITH BUS EXCIIANGE |  |  |  | DESCRIPTION | REMARKS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | READ |  | MEMORY WRITE |  |  |  |
|  | $\begin{aligned} & \text { MIN } \\ & \text { (ns) } \end{aligned}$ | $\begin{aligned} & \operatorname{MAX} \\ & (\mathrm{ns}) \end{aligned}$ | $\begin{aligned} & \mathrm{MIN} \\ & \text { (ns) } \end{aligned}$ | $\begin{aligned} & \hline \mathrm{MAX} \\ & (\mathrm{~ns}) \\ & \hline \end{aligned}$ | $\begin{aligned} & \hline \text { MIN } \\ & (\mathrm{ns}) \end{aligned}$ | $\begin{aligned} & \hline \mathrm{MAX} \\ & (\mathrm{~ns}) \end{aligned}$ |  |  |
| ${ }^{t}$ AS | 82 |  | 82 |  | 658 |  | Address Setup Time to Command |  |
| ${ }^{\text {AH }}$ | 61 |  | 0 |  | 61 |  | Address Hold Time |  |
| ${ }^{\text {c }}$ DS | 140 |  | - |  | 140 |  | Data Setup Time to Command |  |
| ${ }^{t}{ }_{\text {DH }}$ | 61 |  | 0 |  | 61 |  | Data Hold Time |  |
| ${ }^{t} \text { ACK } \emptyset$ |  |  | 68 | 191 |  |  | First ACK Sampling Point of Current Cycle | Generates 0 Wait States |
| ${ }^{\text {t }}$ ACK1 |  |  | 551 | 684 | -60 | 132 | Second ACK Sampling Point of Current Cycle | Generates 1 Wait State |
| ${ }^{\text {t }}$ ACK2 |  |  | 1034 | 1174 | 423 | 625 | Third ACK Sampling Point of Current Cycle | Generates 2 Wait States |
| ${ }^{\text {t }}$ CY | 483 | 493 |  |  |  |  | ACK \& BPRN Sample Cycle Time |  |
| ${ }^{\text {W }}$ W |  |  | 596 | 796 | 1412 | 1516 | Command Width | Read, 0 Wait States Write, 2 Wait States |
| ${ }^{\text {t }}$ ACC |  |  |  | 344 |  |  | Read Access Time | D |
| ${ }^{\text {t }}$ 8KD |  |  |  | 68 |  | -60 | . dvanced ACK Response Time for. Minimum Delay | B |
| ${ }^{t_{8 K 0}}$ | 0 | 100 |  | 100 | 0 | 100 | Advanced ACK Turn Off Delay | B |
| ${ }^{\text {t }}$ XKD | 0 |  | 0 |  |  |  | XACK Delay From Valid Data or Write |  |
| ${ }^{\text {xKO }}$ | 0 | 100 | 0 | 100 | 0 | 100 | XACK Turn Off Delay |  |
| ${ }^{\text {t }}$ DBS |  | 3500 |  |  |  |  | Bus Sample to Exchange Initiation | D Assume HOLD/becomes active prior to DAD instruction |
| ${ }^{\text {b }}$ S | 0 | 493 |  |  |  |  | BPRN Sampling Point Delay |  |
| ${ }^{\text {D }}$ D ${ }^{\text {P }}$ | 358 | 700 |  |  |  |  | Bus Busy Turn On Delay |  |

(1) Memory and I/O access occurs with no wait states.

TABLE 7-3. AC CHARACTERISTICS WITH CONTINUOUS BUS CONTROL

| PARAMETER | OVERALL |  | CONTINUOUS BUS CONTROL |  |  |  | DESCRIPTION | REMARKS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | READ |  | MEMORY WRITE |  |  |  |
|  | $\begin{aligned} & \mathrm{MIN} \\ & \text { (ns) } \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{MAX} \\ & \text { (ns) } \end{aligned}$ | $\begin{aligned} & \mathrm{MIN} \\ & \text { (ns) } \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{MAX} \\ & \mathrm{~ns}) \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{MLN} \\ & (\mathrm{~ns}) \end{aligned}$ | $\begin{aligned} & \mathrm{MAX} \\ & \text { (ns) } \end{aligned}$ |  |  |
| ${ }^{\text {t }}$ AS | 82 |  | 82 |  | 658 |  | Address Setup Time to Command |  |
| ${ }^{\text {AH }}$ | 79 |  | 0 |  | 79 |  | Address Hold Time |  |
| ${ }^{\text {DS }}$ | 140 |  | - |  | 140 |  | Data Setup Time to Command |  |
| ${ }^{\text {DH }}$ | 79 |  | 0 |  | 79 |  | Data Hold Time |  |
| ${ }^{\text {ACKM }}$ ¢ |  |  | 68 | 191 |  |  | First ACK Sampling Point of Current Cycle | Generates 0 Wait States |
| ${ }^{\text {t }}$ ACK1 |  |  | 551 | 684 | -60 | 132 | Sec.ad ACK Sampling Point of Current Cycle | Generates 1 Wait State |
| ${ }^{\text {ACK2 }}$ |  |  | 1034 | 1177 | 423 | 625 | Third ACK Sampling Point of Current Cycle | Generates 2 Wait States |
| ${ }^{t}{ }_{C Y}$ | 483 | 493 |  |  |  |  | ACK \& BPRN Sample Cycle Time |  |
| ${ }^{\text {t }}$ SEP | 259 |  | 613 |  | 259 | B | Command Separation |  |
| ${ }^{\text {WC }}$ |  |  | 596 | 796 | 1412 | 1516 | Command Width | Read, 0 Wait States Write, 2 Wait States |
| ${ }^{\text {A }}$ ACC | 344 |  |  | 344 |  |  | Read Access Time | 1> |
| ${ }^{\text {t }}$ 8KD |  |  |  | 68 |  | -60 | Advanced ACK Response Time for Minimum Delay | 1) |
| $\mathrm{t}_{8 \mathrm{KO}}$ | 0 | 100 | 0 | 100 | 0 | 100 | Advanced ACK Turn Off Delay |  |
| ${ }^{\text {t }}$ (KD | 0 |  | 0 |  |  |  | XACK Delay From Valld Data or Write |  |
| ${ }^{\text {xKO }}$ | 0 | 100 | 0 | 100 | 0 | 100 | XACK Turn Off Delay |  |
| $t_{B C Y}$ | 107 | 110 |  |  |  |  | Bus Clock Cycle Time | 80/10 Generator |
| ${ }^{\text {b }}$ BW | 25 | 85 |  |  |  |  | Bus Clock Low or High Periods | 80/10 Generator |
| ${ }^{\text {INTT }}$ | 3000 |  |  |  |  |  | Initialization Width | After all voltages have stabilized |

(1) MAX assumes no acknowledge delays.
(2) Write Command to next Read Command separation.

TABLE 7-4. DC CHARACTERISTICS

| SIGNALS | SYMBOL | PARAMETER DESCRIPTION | TEST CONDITIONS | MIN | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ADR $\varnothing /-A D R F /$ ADDRESS | $\begin{gathered} \mathrm{V}_{\mathrm{OL}} \\ \mathrm{~V}_{\mathrm{OH}} \\ \mathrm{~V}_{\mathrm{IL}} \\ \mathrm{~V}_{\mathrm{IH}} \\ \mathrm{I}_{\mathrm{IL}} \\ \mathrm{I}_{\mathrm{IH}} \\ * \mathrm{C}_{\mathrm{L}} \end{gathered}$ | Output Low Voltage <br> Output High Voltage <br> Input Low Voltage <br> Input High Voltage <br> Input Current at Low $V$ <br> Input Current at High $V$ <br> Capacitive Load | $\begin{aligned} & \mathrm{I}_{\mathrm{OL}}=50 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=-10 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{IN}}=0.45 \\ & \mathrm{~V}_{\mathrm{IN}}=5.25 \mathrm{~V} \end{aligned}$ | 2.4 2.0 | $\begin{aligned} & 0.6 \\ & 0.95 \\ & -0.25 \\ & 10 \\ & 18 \end{aligned}$ | V <br> V <br> V <br> V <br> mA <br> $\mu \mathrm{A}$ <br> pF |
| MROC/,MWTC/ IORC/, IOWC/ | $\begin{gathered} \mathrm{V}_{\mathrm{OL}} \\ \mathrm{~V}_{\mathrm{OH}} \\ \mathrm{I}_{\mathrm{LH}} \\ \mathrm{I}_{\mathrm{LL}} \\ * \mathrm{C}_{\mathrm{L}} \end{gathered}$ | Output Low Vol.tage Output High Voltage Output Leakage High Output Leakage Low Capacitive Load | $\begin{aligned} & \mathrm{I}_{\mathrm{OL}}=32 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=-.5 .2 \mathrm{~mA} \\ & \mathrm{v}_{\mathrm{O}}=2.4 \\ & \mathrm{v}_{\mathrm{O}}=0.4 \end{aligned}$ | 2.4 | $\begin{array}{r} 40 \\ -40 \\ 15 \end{array}$ | V <br> V <br> $\mu A$ <br> $\mu \mathrm{A}$ <br> $\mathrm{p} F$ |
| DATD/-DAT7/ | $\begin{gathered} \mathrm{v}_{\mathrm{OL}} \\ \mathrm{v}_{\mathrm{OH}} \\ \mathrm{v}_{\mathrm{IL}} \\ \mathrm{v}_{\mathrm{IH}} \\ \mathrm{I}_{\mathrm{IL}} \\ \mathrm{I}_{\mathrm{LH}} \\ \mathrm{I}_{\mathrm{LL}} \\ * \mathrm{C}_{\mathrm{L}} \end{gathered}$ | Output Low Voltage <br> Output High Voltage <br> Input Low Voltage <br> Input High Voltage <br> Input Current at Low $V$ <br> Output Leakage High <br> Output Leakage Low <br> Capacitive Load | $\begin{aligned} & \mathrm{I}_{\mathrm{OL}}=50 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=-10 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{IN}}=0.45 \\ & \mathrm{~V}_{\mathrm{O}}=5.25 \\ & \mathrm{v}_{\mathrm{O}}=0.45 \end{aligned}$ | 2.4 2.0 | $\begin{aligned} & 0.6 \\ & 0.95 \\ & -0.25 \\ & 100 \\ & 100 \\ & 18 \end{aligned}$ | V <br> V <br> V <br> V <br> mA <br> $\mu A$ <br> $\mu \mathrm{A}$ <br> pF |
| INT1/ | $\begin{gathered} \mathrm{V}_{\mathrm{II}} \\ \mathrm{~V}_{\mathrm{IH}} \\ \mathrm{I}_{\mathrm{IL}} \\ \mathrm{I}_{\mathrm{IH}} \\ * \mathrm{C}_{\mathrm{L}} \end{gathered}$ | Input Low Voltage <br> Input High Voltage <br> Input Current at Low V <br> Input Current at High V <br> Capacitive Load | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=0.4 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{IN}}=5.5 \mathrm{~V} \end{aligned}$ | 2.0 | $\begin{gathered} 0.8 \\ -2.2 \\ 1 \\ 18 \end{gathered}$ | V <br> V <br> mA <br> mA <br> pF |
| BPKN, XACK AACK | $\begin{gathered} \mathrm{V}_{\mathrm{IL}} \\ \mathrm{~V}_{\mathrm{IH}} \\ \mathrm{I}_{\mathrm{IL}} \\ { }^{\mathrm{I}_{\mathrm{IH}}} \mathrm{C}_{\mathrm{L}} \end{gathered}$ | Input Low Voltage <br> Input High Voltage <br> Input Current at Low V <br> Input Current at High V <br> Capacitive Load | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=0.5 \\ & \mathrm{~V}_{\mathrm{IN}}=2.7 \mathrm{~V} \end{aligned}$ | 2.0 | $\begin{aligned} & 0.8 \\ & -2.6 \\ & 0.30 \\ & 18 \end{aligned}$ | V <br> V <br> mA <br> mA <br> pF |
| BUSY/ <br> OPEN COLLECTOR | $\begin{gathered} \mathrm{V}_{\mathrm{OL}} \\ { }^{*} \mathrm{C}_{\mathrm{L}} \end{gathered}$ | Output Low Voltage Capacitive Load | $\mathrm{I}_{0 \mathrm{~L}}=25 \mathrm{~mA}$ |  | $\begin{aligned} & 0.4 \\ & 20 \end{aligned}$ | $\begin{gathered} \mathrm{V} \\ \mathrm{pF} \end{gathered}$ |
| INT <br> (SYSTEM RESET) | $\begin{aligned} & v_{\mathrm{OL}} \\ & \mathrm{v}_{\mathrm{OH}} \\ & \mathrm{v}_{\mathrm{IL}} \\ & \mathrm{v}_{\mathrm{IH}} \\ & \mathrm{I}_{\mathrm{IH}} \\ & \mathrm{I}_{\mathrm{IL}} \\ & * \mathrm{C}_{\mathrm{L}} \end{aligned}$ | Output Low Voltage <br> Output High Voltage <br> Input Low Voltage <br> Input High Voltage <br> Input Current at High V <br> Input Current at Low V <br> Capacitive Load | $I_{\mathrm{OL}}=32 \mathrm{~mA}$ <br> OPEN COLLECTOR $\begin{aligned} & \mathrm{v}_{\mathrm{IN}}=5.5 \\ & \mathrm{v}_{\mathrm{IN}}=0.3 \end{aligned}$ | 2.0 | $\begin{aligned} & 0.6 \\ & 0.7 \\ & 0.2 \\ & -0.9 \\ & 38 \end{aligned}$ | V <br> V <br> $v$ <br> mA <br> mA <br> pF |
| BCLK/ + CCLK/ | $\begin{gathered} \mathrm{V}_{\mathrm{OL}} \\ \mathrm{~V}_{\mathrm{OH}} \\ * \mathrm{C}_{\mathrm{L}} \end{gathered}$ | Output Low Voltage Output High Valtage Capacitive Load | $\begin{aligned} & \mathrm{I}_{\mathrm{OL}}=20 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=-1 \mathrm{~mA} \end{aligned}$ | 2.7 | $\begin{aligned} & 0.5 \\ & 18 \end{aligned}$ | $\begin{gathered} \mathrm{V} \\ \mathrm{~V} \\ \mathbf{p F} \end{gathered}$ |

*Cap ${ }^{\prime}+$ Ive values are approximazions only.

| SIGNALS | SYMBOL | PARAMETER DESCRIPTION | $\begin{aligned} & \text { TEST } \\ & \text { CONDITIONS } \end{aligned}$ | MIN | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| EXT INTRø/ | $\begin{gathered} \mathrm{V}_{\mathrm{IL}} \\ \mathrm{v}_{\mathrm{IH}} \\ \mathrm{I}_{\mathrm{IL}} \\ \mathrm{I}_{\mathrm{IH}} \\ * \mathrm{C}_{\mathrm{L}} \end{gathered}$ | Input Low Voltage <br> Input High Voltage <br> Input Current at Low V <br> Input Current at High V <br> Capacitive Load | $\begin{aligned} \mathrm{v}_{\mathrm{IN}} & =0.4 \mathrm{~V} \\ \mathrm{v}_{\mathrm{IN}} & =5.5 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 6.8 \end{aligned}$ | $\begin{gathered} 0.8 \\ 2 \\ 18 \end{gathered}$ | V <br> v <br> mA <br> mA <br> pF |
| PORT E4 <br> BIDIRECTIONAL <br> DRIVERS | $\begin{gathered} \mathrm{v}_{\mathrm{OL}} \\ \mathrm{v}_{\mathrm{OH}} \\ \mathrm{v}_{\mathrm{IL}} \\ \mathrm{v}_{\mathrm{IH}} \\ \mathrm{I}_{\mathrm{IL}} \\ \mathrm{I}_{\mathrm{LH}} \\ { }^{C_{\mathrm{C}}} \end{gathered}$ | Output Low Voltage Output High Voltage Input Low Voltage Input High Voltage Input Current at Low V Output Leakage High Capacitive Load | $\begin{aligned} & I_{\mathrm{OL}}=20 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=-12 \mathrm{~mA} \end{aligned}$ $\begin{aligned} & \mathrm{v}_{\mathrm{IN}}=0.45 \\ & \mathrm{v}_{0}=5.25 \end{aligned}$ | $\begin{aligned} & 2.4 \\ & 2.0 \end{aligned}$ | $\begin{gathered} .45 \\ .95 \\ -5.25 \\ .30 \\ .18 \end{gathered}$ | $\begin{gathered} \mathrm{V} \\ \mathrm{~V} \\ \mathrm{~V} \\ \mathrm{~V} \\ \mathrm{~mA} \\ \mathrm{~mA} \\ \mathrm{pF} \end{gathered}$ |
| 8255 <br> DRIVER/ RECEIVER | $\begin{gathered} \mathrm{v}_{\mathrm{OL}} \\ \mathrm{v}_{\mathrm{OH}} \\ \mathrm{v}_{\mathrm{IL}} \\ \mathrm{v}_{\mathrm{IH}} \\ \mathrm{I}_{\mathrm{IL}} \\ \mathrm{I}_{\mathrm{IH}} \\ { }^{*} \mathrm{C}_{\mathrm{L}} \end{gathered}$ | Output Low Voltage <br> Output High Voltage <br> Input Low Voltage <br> Input High Voltage <br> Input Current at Low V <br> Input Current at High V <br> Capacitive Load | $\begin{aligned} & I_{\mathrm{OL}}=1.7 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=-50 \mathrm{HA} \end{aligned}$ $\begin{aligned} \mathrm{V}_{\mathrm{IN}} & =0.45 \\ \mathrm{~V}_{\mathrm{IN}} & =5.0 \end{aligned}$ | $\begin{aligned} & 2.4 \\ & 2.0 \end{aligned}$ | $.45$ <br> . 8 <br> 10 <br> 10 <br> 18 | $\begin{gathered} \mathrm{V} \\ \mathrm{~V} \\ \mathrm{~V} \\ \mathrm{~V} \\ \mu \mathrm{~A} \\ \mu \mathrm{~A} \\ \mathrm{pF} \end{gathered}$ |

*Capacitive values are approximations only.

TABLE 7-5. COMPATIBLE CONNECTOR HARDWARE

| FUNCTION | \# OF PINS | CENTERS <br> (inches) | CONNECTOR TYPE | VENDOR | VENDOR PART \# | INTEL PART \# |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PARALLEL I/O | 25/50 | 0.1 |  | $\begin{gathered} \text { 3M } \\ \text { 3M } \\ \text { AMP } \\ \text { ANSLEY } \\ \text { SAE } \end{gathered}$ | ```3415-0000 WITH EARS 3415-0001 W/O EARS 88083-1 609-501'5 SD6750 SERIES``` | $\begin{gathered} \text { SBC- } 955 \\ \text { (CABLE ASSY.) } \end{gathered}$ |
| SERIAL I/O | 13/26 | 0.1 | FLAT CRIMP $\dagger$ | $\begin{gathered} 3 M \\ \text { AMP } \\ \text { ANSLEY } \\ \text { SAE } \end{gathered}$ | $\begin{aligned} & 3462-0001 \text { CRIMP } \\ & 88106-1 \\ & 609-2615 \\ & \text { SD6726 SERIES } \end{aligned}$ | $\begin{gathered} \text { SBC-956 } \\ \text { (CABLE ASSY.) } \end{gathered}$ |
| Parailel I/O | 25/50 | 0.1 |  | $\begin{gathered} \text { AMP } \\ \text { VIKING } \\ \text { TI } \end{gathered}$ | $\begin{aligned} & 2-583485-6 \\ & 3 \mathrm{VH} 25 / 1 \mathrm{JV} 5 \\ & \mathrm{E} 312125 \end{aligned}$ | N/A |
| SERIAL I/O | 13/26 | 0.1 | SOLDERED | $\underset{\text { AMP }}{\text { TI }}$ | $\begin{aligned} & \text { H312113 } \\ & 1-583485-5 \end{aligned}$ | N/A |
| $\text { AUXILIARY }{ }^{\text {D }}$ | 30/60 | 0.1 | SOLDERED | $\begin{gathered} \text { VIKING } \\ \text { TI } \end{gathered}$ | $\begin{aligned} & 3 \mathrm{VH} 30 / 1 \mathrm{NN} 5 \\ & \mathrm{H} 312130 \end{aligned}$ | N/A |
| BUS D | 43/86 | 0.156 |  | $\begin{gathered} \text { CDC } \\ \text { MICRO PLASTICS } \\ \text { ARCO } \\ \text { VIKING } \end{gathered}$ | VPB01E43D00AI $\mathrm{MP}-0156-43-\mathrm{BW}-4$ <br> AE443WPI LESS EARS $2 \mathrm{VH} 43 / \mathrm{I} \cdot \mathrm{~V} 5$ | N/A |
| $\begin{array}{rr}  & 0 \\ \text { PARALLEL } & \text { I } / 0 \end{array}$ | 25/50 | 0.1 |  | $\begin{gathered} \text { TI } \\ \text { VIKING } \\ \text { CDC } \\ \text { ITT }{ }^{\text {CANNON }} \end{gathered}$ | $\begin{aligned} & \text { E311125 } \\ & \text { 3VH25/1JND5 } \\ & \text { VPBO1B25D00A1 } \\ & \text { EC4A050A1A } \end{aligned}$ | N/A |
| SERIAL I/0 | 13/26 | 0.1 | WIREWRAP | TI | H311113 | N/A |
| AUXILIARY | 30/60 | 0.1 | WIREWRAP | $\begin{gathered} \mathrm{CDC} \\ \mathrm{TI} \end{gathered}$ | VPBOIB30A00A2 H311130 | MDS-980 |
| Bus | 43/86 | 0.156 |  | $\begin{gathered} \text { CDC } \\ \text { CDC } \\ \text { VIKING } \end{gathered}$ | VFBOIE43DOOAL or $D$ VPBOIE43A00A1 2VH43/1anD5 | MDS-985 |
| SBC 201 |  |  | SOLDER TAIL | VIKING | 3VH50/1JN5 | MDS-990 |
| $\left\lvert\, \begin{aligned} & \text { SBC 501 } \\ & \text { SBC 508 } \\ & \text { SBC } 905 \text {, etc. } \end{aligned}\right.$ | 50/100 | 0.1 | SOLDER PAK (RAYCHEM) | CDC | VPB04B50EOOAIE | N/A |

(1) Connector heights are not guaranteed to conform to OEM packaging equipment.

Intel OEM and Intellec ${ }^{®^{®}}$ Development System motherboards offer complete mechanical compatibility.
(8) Wirewrap pin lengths are not guaranteed to conform to OEM packaging equipment.

Intel connectors and OEM and Intellec ${ }^{\text {® }}$ Development System motherboards offer complete nechanical compatibility.
(1) CDC VPBO1 ..., VPB02 ..., VPBO4 ..., etc. are identical connectors with different electroplating thicknesses or metal surfaces.

NOTE: See next page for vendor addresses, telephone numbers and TWX numbers.

## VENDORS ADDRESSES

The following information is for our customers' convenience only. Intel does not represent these vendors, guarantee availability nor continued quality of their products.

CDC CONNECTOR DIVISION
31829 W. LaTienda Drive
Westlake Village, CA 91361
213-889-3535
TWX 910-494-1224

VIKING INDUSTRIES, INC.
21001 Nordhoff Street
Chatsworth, CA 91311
213-341-4330
TWX 910-494-2094

Connector Systems
TEXAS INSTRUMENTS, INC.
34 Forest Street
Attleboro, MA 02703
617-222-2800

AMP Incorporated
P.O. Box 3608

Harrisburg, PA 17105
717-564-0100
TWX 510-657-4110

## T\&B/ANSLEY

Subsidiary of Thomas \& Betts Corporation
3208 Humbolt Street
Los Angeles, CA 90031
213-223-2331
TWX 910-321-3938

STANFORD APPLIED ENGINEERING, INC. (SAE)
340 Martin Avenue
Santa Clara, CA 95050
408-243-9200
TWX 910-338-0132

3M Connectors
Electronic Products Division, Bldg. 223-4E
3M COMPANY
3M Center
St. Paul, MN 55101
612-733-1110


* FIGURE 7-1. MEMORY AND I/O READ TIMING (CONTINUOUS BUS CONTROL)
*NOT DRAWN TO SCALE.


EXTERNAL DEVICE
COMPLETED WRITE
*FIGURE 7-2. MEMORY AND I/O WRITE TIMING (CONTINUOUS BUS CONTROL)
*NOT DRAWN TO SCALE.

*NOT DRAWN TO SCALE.


Figure 7-4. SBC $80 / 10$ and SBC 80/10A Dimension
Drawing - Page 1 of 2


Figure 7-4. SBC 80/10 and SBC 80/10A Dimension Drawing - Page 2 of 2

## notes:

1. MATERIAL : 062 THK, 1 OZ COPPER CLAD NATURAL EPOXY

GLASS, TYRE S:O (ZEEAFTER PLATINETHRU)
2. ECAEL EDGES APE LOCATED FPOM INDEX HOLES. NOEX HOLES LRE CN OSO GFID MTEPSECTICH HIMC ARE USEO FOF ARTWAFK REGISTEATIOUSNMO MAY
TOOLNG HOLES, PLATING OFTIONAL.
3. HOLES ARE PLATED TIRU WITH COPDER WALL THICKHESS
4. HOLE SIZES SPESIFIEO ARE AFTER PLATIHG; $\pm .009$ TOLERANCE

G CONTACT FIIGERS ARE OVERDIATEO WITH A MINIMUM OF SO MILLIONTHS ARE OVER NICKEL TO DIMEASION ShCown.
(6) MLPLY SOLDER MASK OVER SOLDER PLATE USING
7.
8. DRILL FROM CIPCUIT SIDE.
9. TRACE WIOTHS MUST BE YHTHIN . OO4 OF ARTWORK

1. NEGATIVES.
2. AOPLY SIIKSCREEN ON COMPDNEHT SIDE, AFTER SOLDER

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## APPENDIX A <br> SCHEMATICS

Schematic drawings for the SBC-80/80 and SBC $80 / 10 \mathrm{~A}$ are provided in this appendix. Information and diagrams in this section are subject to change without notice. References should be made to schematics shipped with this module.



FIGURE A-2. SBC 80/10A SCHEMATIC (SHEET 5 OF 5)


FIGURE A-1. SBC 80/10 SCHEMATIC (SHEET 1 OF 5)








## APPENDIX B TELETYPEWRITER MODIFICATIONS

## B-1. INTRODUCTION

This appendix provides information required to modify a Model ASR-33 Teletypewriter for use with certain Intel SBC 80 computer systems.

## B-2. INTERNAL MODIFICATIONS



Hazardous voltages are exposed when the top cover of the teletypewriter is removed. To prevent accidental shock, disconnect the teleprinter power cord before proceeding beyond this point.

Remove the top cover and modify the teletypewriter as follows:
a. Remove blue lead from 750 -ohm tap on current source register; reconnect this lead to 1450 -ohm tap. (Refer to figures B-1 and B-2.)
b. On terminal block, change two wires as follows to create an internal full-duplix loop (refer to figures B-1 and B-3):

1. Remove brown/yellow lead from terminal 3; reconnect this lead to terminal 5.
2. Remove white/blue lead from terminal 4 ; reconnect this lead to terminal 5.
c. On terminal block, remove violet lead from terminal 8 ; reconnect this lead to terminal 9 . This changes the receiver current level from 60 mA to 20 mA .

A relay circuit card must be fabricated and connected to the paper tape reader drive circuit. The relay circuit card to be fabricated requires a relay, a diode, a thyractor, a small 'vector' board for mounting the components, and suitable hard ware for mounting the assembled relay card.

A circuit diagram of the relay circuit card is included in figure B-4; this diagram also includes the part numbers of the relay, diode, and thyractor. (Note that a 470 -ohm resistor and a $0.1 \mu \mathrm{~F}$ capacitor may be substituted for the thyractor.) After the relay circuit card has been
assembled, mount it in position as shown in figure B-5. Secure the card to the base plate using two self-tapping screws. Connect the relay circuit to the distributor trip magnet and mode switch as follows:
a. Refer to figure B-4 and connect a wire (Wire ' $A$ ') from relay circuit card to terminal L2 on mode switch. (See figure B-6.)
b. Disconnect brown wire shown in figure $\mathrm{B}-7$ from plastic connector. Connect this brown wire to terminal L2 on mode switch. (Brown wire will have to be extended.)
c. Refer to figure B-4 and connect a wire (Wire ' $B$ ') from relay circuit board to terminal Ll on mode switch.

## B-3. EXTERNAL CONNECTIONS

Connect a two-wire receive loop, a two-wire send loop, and a two-wire tape reader control loop to the external device as shown in figure B-4. The external col.nector pin numbers shown in figure B-4 are for interface witil an RS232C device.

## B-4. SBC 530 TTY ADAPTER

The SBC 530, which converts RS232C signal levels to an optically isolated 20 mA current loop interface, provides signal translation for transmitted data, received data, and a paper tape reader relay. The SBC 530 interfaces an Intel SBC 80 computer system to a teletypewriter as shown in figure B-8.

The $\operatorname{SBC} 530$ requires +12 V at 98 mA and -12 V at 98 mA . An auxiliary supply must be used if the SBC 80 system does not supply this power. A schematic diagram of the SBC 530 is supplied with the unit. The following auxiliary power connector (or equivalent) must be procured by the user:

Connector, Molex 09-50-7071
Pins, Molex 08-50-0106
Polarizing Key, Molex 15-04-0219


Figure B-1. Teletype Component Layout


Figure B-2. Current Source Resistor


Figure B-3. Terminal Block


Figure B-4. Teletypewriter Modifications


Figure B-5. Relay Circuit


Figure B-6. Mode Switch


Figure B-7. Distributor Trip Magnet


Figure B-8. TTY Adapter Cabling.

## 8080 INSTRUCTION SET SUMMARY

A computer, no matter how sophisticated, can only do what it is "told" to do. One "tells" the computer what to do via a series of coded instructions referred to as a Program. The realm of the programmer is referred to as Software, in contrast to the Hardware that comprises the actual computer equipment. A computer's software refers to all of the programs that have been written for that computer.

When a computer is designed, the engineers provide the Central Processing Unit (CPU) with the ability to perform a particular set of operations. The CPU is designed such that a specific operation is performed when the CPU control logic decodes a particular instruction. Consequently, the operations that can be performed by a CPU define the computer's Instruction Set.

Each computer instruction allows the programmer to initiate the performance of a specific operation. All computers implement certain arithmetic operations in their instruction set, such as an instruction to add the contents of two registers. Often logical operations (e.g., OR the contents of two registers) and register operate instructions (e.g., increment a register) are included in the instruction set. A computer's instruction set will also have instructions that move data between registers, between a register and memory, and between register and an I/O device. Most instruction sets also provide Conditional Instructions. A conditional instruction specifies an operation to be performed only if certain conditions have been met; for example, jump to a particular instruction if the result of the last operation was zero. Conditional instructions provide a program with a decision-making capability.

By logically organizing a sequence of instructions into a coherent program, the progranımer can "tell" the computer to perform a very specific and useful function.

The computer, however, can only execute programs whose instructions are in a binary coded
form (i.e., a series of I's and 0's), that is called Machine Code. Becaluse it would be extremely cumbersome to program in machine code, programming languages have beell developed. There are programs available which convert the programming language instructions into machine code that can be interpreted by the processor.

One type of programming language is Assembly Language. A unique assembly language memonic is assigned to each of the computer's instructions. The programmer can write a program (called the Source Program) using these memonics and certain operands; the source program is then converted into machine instructions (called the Object Code). Each assembly language instructions is converted into one machine code instruction (1 or more bytes) by an Assembler program. Assembly languages are usually machine dependent (i.e., they are usually able to run on only one type of computer).

## THE 8080 INSTRUCTION SET

The 8080 instruction set includes five different types of instructions:

- Data Transfcr Group - move data between registers or between memory and registers.
- Arithmetic Group - add, subtract, increment or decrement data in registers or in memory.
- Logical Group - AND, OR, EXCLUSIVEOR, compare, rotate or complement data in registers or in memory.
- Branch Group - conditional and unconditional jump instructions, subroutine call instructions and return instructions.
- Stack, I/O and Machine Control Group - includes I/O instructions, as well as instructions for maintaining the stack and internal control flags.


## Instruction and Data Formats

Memory for the 8080 is organized into 8 -bit quanjties, called Bytes. Each byte has a unique 16 -bit binary address corresponding to its sequential position in memory.

The 8080 can directly address up to 65,536 bytes of memory, which may consist of both read-only memory (ROM) elements and random-access memory (RAM) elements (read/write memory).

Data in the 8080 is stored in the form of 8 -bit binary integers:


When a register or data word contains a binary number, it is necessary to establish the order in which the bits of the number are written. In the Intel 8080, BIT 0 is referred to as the Least Significant Bit (LSB), and BIT 7 (of an 8 -bit number) is referred to as the Most Significant Bit (MSB).

The 8080 program instructions may be one, two or .hree 'jytes in length. Multiple byte instructions must be stored in successive memory locations; the address of the first byte is always used as the address of the instructions. The exact instruction format will depend on the particular operation to be executed.



## Addressing Modes

Often the data that is to be operated on is stored in memory. When multi-byte numeric data is used, the data, like instructions, is stored in successive memory locations, with the least significant byte first, followed by increasingly significant bytes. The 8080 has four different modes for addressing data stored in memory or in registers:

- Direct - Bytes 2 and 3 of the instruction contain the exact memory address of the data item (the low-order bits of the address are in byte 2 , the high-order bits in byte 3 ).
- Register - The instruction specifies the regis-ter-pair in which the data is located.
- Register Indirect - The instruction specifies a register-pair which contains the memory address where the data is located (the highorder bits of the address are in the first register of the pair, the low-order bits in the second).
- Immediate - The instruction contains the data itself. This is either an 8 -bit quantity or a 16 -hit quantity (least significant byte first, most significant byte second).

Unless directed by an interrupt or branch instruction, the execution of instructions proceeds through consecutively increasing memory locations. A branch instruction can specify the address of the next instruction to be executed in one of two ways:

- Direct - The branch instruction contains the address of the next instruction to be executed. (Except for the 'RST' instruction, byte 2 contains the low-order address and byte 3 the high-order address.)
- Register Indirect - The branch instruction indicates a register-pair which contains the address of the next instruction to be executed. (The high-order bits of the address are in the first register of the pair, the loworder bits in the second.)

The RST instruction is a special one-byte call instruction (usually used during interrupt sequences).

RST includes a three-bit field; program control is transferred to the instruction whose address is eight times the contents of this three-bit field.

## Condition Flags

There are five condition flags associated with the execution of instructions on the 8080 . They are Zero, Sign, Parity, Carry, and Auxiliary Carry, and are each represented by a l-bit register in the CPU. A flag is "set" by forcing the bit to 1 ; "reset" by forcing the bit to 0 .

Unless indicated otherwise, when an instruction affects a flag, it affects it in the following manner:

Zero: If the result of an instruction has the value 0 , this flag is set; otherwise it is reset.

Sign: If the most significant bit of the result of the operation has the value 1 , this flag is set; otherwise it is reset.

Parity: If the modulo 2 sum of the bits of the result of the operation is 0 (i.e., if the result has even parity), this flag is set; otherwise it is reset (i.e., if the result has odd parity).

Carry: If the instruction resulted in a carry (from addition), or a borrow (from subtraction of a comparison) out of the high-order bit, this flag is set; otherwise it is reset.

## Auxiliary

Carry: If the instruction caused a carry out of bit 3 and into bit 4 of the resulting value, the auxiliary carry is set; otherwise it is reset. This flag is affected by single precision additions, subtractions, increments, decrements, comparisons, and logical operations, but is principally used with additions and increments preceding a DAA (Decimal Adjust Accumulator) instruction.

Symbols and Abbreviations
The following symbols and abbreviations are used in the subsequent description of the 8080 instructions:

SYMBOLS
accumulator Register A
addr
data
data 16
byte 2
byte 3
port
r, r 1,r2
DDD,SSS
rp

RP
rh
rl designated pair.

16-bit address quantity
8 -bit data quantity
16-bit data quantity
The second byte of the instruction
The third byte of the instruction 8 -bit address of an I/O device
One of the registers $A, B, C, D, E, H, L$
The bit pattern designating one of the registers $\mathrm{A}, \mathrm{B}, \mathrm{C}, \mathrm{D}, \mathrm{E}, \mathrm{H}, \mathrm{L}$. (DD= destination, SSS=source):

DDD or SSS REGISTER NAME

| 111 | A |
| :--- | :--- |
| 000 | B |
| 001 | C |
| 010 | D |
| 011 | E |
| 100 | H |
| 101 | L |

One of the register pairs:
$B$ represents the $B, C$ pair with $B$ as the high-order register and $\mathbf{C}$ as the low-order register;
D represents the D,E pair with D as the high-order register and E as the low-order register;
H represents the $\mathrm{H}, \mathrm{L}$ pair with H as the high-order register and L as the low-order register;
SP represents the 16 -bit stack pointer register.
The bit pattern designating one of the register pairs $\mathrm{B}, \mathrm{D}, \mathrm{H}, \mathrm{SP}$ :

| RP | REGISTER PAIR |
| :---: | :---: |
| 00 | B-C |
| 01 | D-E |
| 10 | H-L |
| 11 | SP |

The first (high-order) register of a

The second (low-order) register of a designated register pair.

PC 16-bit program counter register (PCH and PCL are used to refer to the high-order and low-order 8 bits, respectively).
SP 16-bit stack pointer register (SPH and SPL are used to refer to the high-order and low-order 8 bits, respectively).
$r_{m} \quad$ Bit $m$ of the register $r$ (bits are number 7 through 0 from left to right).
Z,S,P,CY,AC The condition flags:
Zero,
Sign,
Parity,
Carry, and
Auxiliary Carry, respectively.
() The contents of the memory location or registers enclosed in the parentheses.
"Is transferred to"A
Logical AND
Exclusive OR
Inclusive OR
Addition
Two's complement subtraction

* Multiplication
$\leftrightarrow \quad$ "Is exchanged with"
- 

n
NNN

The one's complement (e.g., ( $\overline{\mathrm{A}}$ ))
The restart number 0 through 7
The binary representation 000 through 111 for restart number 0 through 7, respectively.

## Description Format

The following pages provide a detailed description of the instruction set of the 8080 . Each instruction is described in the following manner:

1. The MAC 80 assembler format, consisting of the instruction mnemonic and operand fields, is printed in BOLDFACE on the left side of the first line.
$\curlywedge$ The name of the instruction is enclosed in parenthesis on the right side of the first line.
2. The next line(s) contain a symbolic description of the operation of the instruction.
3. This is followed by a narative description of the operand of the instruction.
4. The following line(s) contain the binary fields and patterns that comprise the machine instruction.
5. The last four lines contain incidental information about the execution of the instruction. The number of machine cycles and states required to execute the instruction are listed first. If the instruction has two possible execution times, as in a Conditional Jump, both times will be listed, separated by a slash. Next, any significant data addressing modes (see Page A-2) are listed. The last line lists any of the five Flags that are affected by the execution of the instruction.

## Data Transfer Group

This group of instructions transfer data to and from registers and memory. Condition flags are not affected by any instruction in this group.

> MOV r1, r2 (Move Register)
$(\mathrm{rl}) \leftarrow(\mathrm{r} 2)$
The content of register r 2 is moved to register rl .


```
            Cycles: 1
            States: 5
Addressing: register
            Flags: none
```

MOV r,M (Move from memory) $(\mathrm{r}) \leftarrow((\mathrm{H})(\mathrm{L}))$
The content of the memory location, whose address is in registers $\mathbf{H}$ and $\mathbf{L}$, is moved to register r.


MOV M, $r$ (Move to memory)
$((\mathrm{H})(\mathrm{L})) \leftarrow(\mathrm{r})$
The content of register $r$ is moved to the memory location whose address is in registers H and L.

| 0 | 1 | 1 | 1 | 0 | $s^{T}$ | $s^{\prime}$ | $s$ |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

Cycles: 2
States: 7
Addressing: reg. indirect
Flags: none

## MVI r, data (Move Immediate)

$(\mathrm{r}) \leftarrow$ (byte 2 )
The content of byte 2 of the instruction is moved to register r .


Cycles: 2
States: 7
Addressing: immediate
Flags: none

MVI M, data (Move to memory immediate) $((\mathrm{H})(\mathrm{L})) \leftarrow$ (byte 2)
The content of byte 2 of the instruction is moved to the memory location whose address is in registers H and L .


LXI rp, data 16 (Load register pair immediate)
(rh) $\leftarrow$ (byte 3),
(rl) $\leftarrow$ (byte 2)
Byte 3 of the instruction is moved into the highorder register (rh) of the register pair rp. Byte 2 of the instruction is moved into the low-order register (rl) of the register pair rp.

| 0 | $\mathrm{R}^{\text {P }}$ | 0 0 | 011 |
| :---: | :---: | :---: | :---: |
| low-ordar data |  |  |  |
| high-order data |  |  |  |
| Cycles: |  |  |  |
| States: 10 |  |  |  |
| Addressing: immediate |  |  |  |
| Flags: none |  |  |  |

LDA addr (Load Accumulator direct)
(A) $\leftarrow($ (byte 3$)$ (byte 2$)$ )

The content of the memory location, whose address is specified in byte 2 and byte 3 of the instruction, is moved to register A.


STA addr (Store Accumulator direct)
((byte 3)(byte 2)) $\leftarrow$ (A)
The content of the accumulator is moved to the memory location whose address is specified in byte 2 and byte 3 of the instruction.


MOV M, $r$ (Move to memory)
$((\mathrm{H})(\mathrm{L})) \leftarrow(\mathrm{r})$
The content of register $r$ is moved to the memory location whose address is in registers H and L.

| 0 | 1 | 1 | 1 | 0 | $s$ | $s$ | $s$ |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

Cycles: 2
States: 7
Addressing: reg. indirect
Flags: none

MVI r, data (Move Immediate)
(r) $\leftarrow$ (byte 2)

The content of byte 2 of the instruction is moved to register r.

| 0 | 0 | $D$ | $D$ | $D$ | 1 | 1 | 0 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| data |  |  |  |  |  |  |  |

Cycles: 2
States: 7
Addressing: immediate
Flags: none

MVI M, data (Move to memory immediate)
$((\mathrm{H})(\mathrm{L})) \leftarrow$ (byte 2)
The content of byte 2 of the instruction is moved to the memory location whose address is in registers H and L .


LXI rp, data 16 (Load register pair immediate)
(rh) $\leftarrow$ (byte 3 ),
(rl) $\leftarrow$ (byte 2)
Byte 3 of the instruction is moved into the highorder register (rh) of the register pair rp. Byte 2 of the instruction is moved into the low-order register (rl) of the register pair rp.

| 0 10 | $\mathrm{R}^{1} \mathrm{P}$ | 010 | $0^{1}$ |
| :---: | :---: | :---: | :---: |
| low-order data |  |  |  |
| high-order data |  |  |  |
| Cycles: 3 |  |  |  |
| States: 10 |  |  |  |
| Addressing: immediate |  |  |  |
| Flags: none |  |  |  |

LDA addr (Load Accumulator direct)
(A) $\leftarrow(($ byte 3$)$ (byte 2$)$ )

The content of the memory location, whose address is specified in byte 2 and byte 3 of the instruction, is moved to register A.

| low-order addr |  |  |  |
| :---: | :---: | :---: | :---: |
| high-order addr |  |  |  |
| Cycles: 4 |  |  |  |
| States: 13 |  |  |  |
| Addressing: direct |  |  |  |
| Flags: none |  |  |  |

STA addr (Store Accumulator direct) ((byte 3)(byte 2)) $\leftarrow$ (A)
The content of the accumulator is moved to the memory location whose address is specified in byte 2 and byte 3 of the instruction.


| 0 | 0 | $R$ | $P$ | 0 | 0 | 1 | 1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |$|$| Cycles: | 1 |
| ---: | :--- |
| States: | $\mathbf{5}$ |
| Addressing: | register |
| Flags: | none |

## Arithmetic Group

This group of instructions performs arithmetic operations on data in registers and memory.

Unless otherwise indicated, all instructions in this group affect the Zero, Sign, Parity, Carry, and Auxiliary Carry flags according to the slandard rules.

All subtraction operations are performed va two's complement arithmetic, and set the carry flag to one to indicate a borrow and clear it to indicate no borrow.

ADD r (Add Register)
$(\mathrm{A}) \leftarrow(\mathrm{A})+(\mathrm{r})$
The content of register $r$ is added to the content - of the accumulator. The result is placed in the accumulator.


Cycles: 1
States: 4
Addressing: register
Flags: Z,S,P,CY,AC

ADD M (Add Memory)
$(\mathrm{A}) \leftarrow(\mathrm{A})+((\mathrm{H})(\mathrm{L}))$
The content of the memory location whose address is contained in the H and L register is added to the content of the accumulator. The result is placed in the accumulator.


ADI data (Add Immediate)
(A) $\leftarrow(\mathrm{A})+($ byte 2$)$

The content of the second byte of the instruction is added to the constant of the accumulator. The result is placed in the accumulator.


Cycles: 2
States: 7
Addressing: immediate
Flags: Z,S,P,CY,AC

ADCr (Add Register with Carry)
$(\mathrm{A}) \leftarrow(\mathrm{A})+(\mathrm{r})+(\mathrm{CY})$
The content of register $r$ and the content of the carry bit are added to the content of the accumulator. The result is placed in the accumulator.


Cycles: 1
States: 4
Addressing: register
Flags: Z,S,P,CY,AC

## ADC M (Add Memory with Carry)

$(\mathrm{A}) \leftarrow(\mathrm{A})+((\mathrm{H})(\mathrm{L}))+(\mathrm{CY})$
The content of the memory location whose address is contained in the H and L registers and the content of the CY flag are added to the accumulator. The result is placed in the accumulator.


Cycles: 2
States: 7
Addressing: reg, indirect
Flags: Z,S,P,CY,AC

ACI data (f.dd Immediate with Carry)
(A) $\leftarrow$ (A) + (byte 2) $+(\mathrm{CY})$

The content of the second byte of the instruction and the content of the CY flag are added to the contents of the accumulator. The result is placed in the accumulator.


Cycles: 2
States: 7
Addressing: immediate
Flags: 2,S,P,CY,AC

SUB r (Subtract Register)
$(A) \leftarrow(A)-(r)$
The content of register $r$ is subtracted from the content of the accumulator. The result is placed in the accumulator.


SUB M (Subtract Memory)
$(\mathrm{A}) \leftarrow(\mathrm{A})-((\mathrm{H})(\mathrm{L}))$
The content of the memory location whose address is contained in the H and L registers is subtracted from the content of the accumulator. The result is placed in the accumulator.


SUI data (Subtract Immediate)
(A) $\leftarrow$ (A) - (byte 2)

The content of the second byte of the instruction is subtracted from the content of the accumulator. The result is placed in the accumulator.

| 1 | 1 | 0 | 1 | 0 | 1 | 1 | 0 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| data |  |  |  |  |  |  |  |

Cycles: 2
States: 7
Addressing: immediate
Flags: 2,S,P,CY,AC

SBB r (Subtract Register with Borrow)
$(A) \leftarrow(A)-(r)-(C Y)$
The content of register $r$ and the content of the CY flag are both subtracted from the accumulator. The result is placed in the accumulator.


Cycles: 1
States: 4
Addressing: register
Flags: Z,S,P,CY,AC

SBB M (Subtract Memory with Borrow)
$(\mathrm{A}) \leftarrow(\mathrm{A})-((\mathrm{H})(\mathrm{L}))-(\mathrm{CY})$
The content of the memory location whose address is contained in the H and L registers and the content of the CY flag are both subtracted from the accumulator. The result is placed in the accumulator.


Cycles: 2
States: 7
Addressing: reg. indirect
Flags: Z,S,P,CY,AC

SBI data (Subtract Immediate with Borrow)
(A) $\leftarrow$ (A) - (byte 2) - (CY)

The contents of the second byte of the instruction and the contents of the CY flag are both subtracted from the accumulator. The result is placed in the accumulator.


INR $\mathbf{r}$ (Increment Register)
$(\mathrm{r}) \leftarrow(\mathrm{r})+1$
The content of register $r$ is incremented by one. Note: All condition flags except CY are affected.

| 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

Cycles: 1
States: 5
Addressing: register
Flags: Z,S,P,AC

INR M (Increment Memory)
$((\mathrm{H})(\mathrm{L})) \leftarrow((\mathrm{H})(\mathrm{L}))+1$
The content of the memory location whose address is contained in the H and L registers is incremented by one. Note: All condition flags except CY are affected.


Cycles: 3
States: 10
Addressing: reg. indirect
Flags: 2,S,P,AC

## DCR $r$ (Decrement Register)

$(\mathrm{r}) \leftarrow(\mathrm{r})-1$
The content of register $r$ is decremented by one.
Note: All condition flags except CY are affected.


Cycles: 1
States: 5
Addressing: register
Flags: Z,S,P,AC
DCX rp (Decrement register pair)
$(\mathrm{rh})(\mathrm{rl}) \leftarrow(\mathrm{rh})(\mathrm{rl})-1$
The content of the register pair rp is decremented by one. Note: No condition flags are affected.


Cycles: 1
States: 5
Addressing: register
Flags: none

DAD rp (Add register pair to H and L ) $(\mathrm{H})(\mathrm{L}) \leftarrow(\mathrm{H})(\mathrm{L})+(\mathrm{rh})(\mathrm{rl})$
The content of the register pair rp is added to the content of the register pair H and L . The result is placed in the register pair H and L . Note: Only the CY flag is affected. It is set if there is a carry out of the double precision add; otherwise it is reset.


Cycles: 3
States: 10
Addressing: registar
Flags: CY

DAA (Decimal Adjust Accumulator)
The 8 -bit number in the accumulator is adjusted to form two 4-bit Binary-Coded-Decimal digits by the following process:

1. If the value of the least significant 4 bits of the accumulator is greater than 9 or if the AC flag is set, 6 is added to the accumulator.
2. If the value of the most significant 4 bits of the accumulator is now greater than 9 , or if the CY flag is set, 6 is added to the most significant 4 bits of the accumulator.

NOTE: All flags are affected.

| 0 | 0 | 1 | 0 | 0 | 1 | 1 | 1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

## Logical Group

This group of instructions performs logical (Boolean) operations on data in registers and memory and on condition flags.

Unless indicated otherwise, all instructions in this group affect the Zero, Sign, Parity, Auxiliary Carry, and Carry flags according to the standard rules.

ANA $r$ (AND Register)
$(A) \leftarrow(A) \wedge(r)$
The content of register $r$ is logically ANDed with the content of the aciumulator. The result is placed in the accumulator. The CY flag is cleared.


ANAM (AND memory)
$(\mathrm{A}) \leftarrow(\mathrm{A}) \wedge((\mathrm{H})(\mathrm{L}))$
The contents of the memory location whose address is contained in the H and L registers is logically ANDed with the content of the accumulator. The CY flag is cleared.


ANI data (AND immediate)
$(\mathrm{A}) \leftarrow(\mathrm{A}) \wedge$ (byte 2 )
The content of the second byte of the instruction is logically ANDed with the contents of the accumulator. The result is placed in the accumulator. The CY flag is cleared.


XRA $r$ (Exclusive OR Register)
$(\mathrm{A}) \leftarrow(\mathrm{A}) \forall(\mathrm{r})$
The content $n f$ register $r$ is exclusive-ORed with the content of the accumulator. The result is placed in the accumulator. The CY and AC flags are cleared.


XRA M (Exclusive OR Memory)
$(\mathrm{A}) \leftarrow(\mathrm{A}) \forall((\mathrm{H})(\mathrm{L}))$
The content of the memory location whose address is contained in the $H$ and $L$ registers is exclusive-ORed with the content of the accumulator. The result is placed in the accumulator. The CY and AC flags are cleared.

| 1 | 0 | 1 | 0 | 1 | 1 | 1 | 1 | 0 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

XRI data (Exciusive OR immediate)
$(\mathrm{A}) \leftarrow(\mathrm{A}) \vee$ (byte 2)
The content of the second byte of the instruction is exclusive-ORed with the content of the accumulator. The result is placed in the accumulator. The CY and AC flags are cleared.

| 1 | 1 | 1 | 1 | 0 | 1 | 1 | 1 | 0 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| data |  |  |  |  |  |  |  |  |

Cycles: 2
States: 7
Addressing: immediate
Flags: Z,S,P,CY,AC
ORA $r$ (OR Kegister)
$(\mathrm{A}) \leftarrow(\mathrm{A}) \vee(\mathrm{r})$
The content of register $r$ is inclusive-ORed with the content of the accumulator. The result is placed in the accumulator. The CY and AC flags are cleared.


ORA M (OR Memory)
$(\mathrm{A}) \leftarrow(\mathrm{A}) \vee((\mathrm{H})(\mathrm{L}))$
The content of the memory location whose address is contained in the H and L registers is inclusive-ORed with the content of the accumulator. The result is placed in the accumulator. The CY and AC flags are cleared.


ORI data (OR Immediate)
$(\mathrm{A}) \leftarrow(\mathrm{A}) \vee($ byte 2$)$
The content of the second byte of the instruction is inclusive-ORed with the content of the accumulator. The result is placed in the accumulator. The CY and AC flags are cleared.


CMP r (Compare Register)
(A) - (r)

The content of register $r$ is subtracted from the accumulator. The accumulator remains unchanged. The condition flags are set as a result of the subtraction. The Z flag is set to 1 if $(\mathrm{A})=$ (r). The CY flag is set to 1 if $(A)<(r)$.


## CMP M (Compare memory)

(A) - ((H)(L))

The content of the memory location whose address is contained in the H and L registers is subtracted from the accumulator. The accumulator remains unchanged. The condition flags are set as a result of the subtraction. The Z flag is set to 1 of $(A)=((H)(L))$. The CY flag is set to 1 if (A) $<((\mathrm{H})(\mathrm{L}))$.


Cycles: 2
States: 7
Addressing: reg. indirect
Flags: Z,S.P,CY,AC

CPI data (Compare immediate)
(A) - (byte 2)

The content of the second byte of the instruction is subtracted from the accumulator. The condition flags are set by the result of the subtraction. The Z flag is set to 1 if $(\mathrm{A})=($ byte 2 ). The CY flag is set to 1 if $(\mathrm{A})<$ (byte 2).


Cycles: 2
States: 7
Addressing: immediate
Flags: $\mathbf{Z , S , P , C Y , A C}$

RLC (Rotate left)
$\left(A_{n+1}\right) \leftarrow\left(A_{n}\right) ;\left(A_{0}\right) \leftarrow\left(A_{7}\right)$
$(\mathrm{CY}) \leftarrow\left(\mathrm{A}_{7}\right)$
The content of the accumulator is rotated left one position. The low-order bits and the CY flag are both set to the value shifted out of the highorder bit position. Only the CY flag is affected.


Cycles: 1
States: 4
Flags: CY

RAL (Rotate left through carry)
$\left(\mathrm{A}_{\mathrm{n}+1}\right) \leftarrow\left(\mathrm{A}_{\mathrm{n}}\right) ;(\mathrm{CY}) \leftarrow\left(\mathrm{A}_{7}\right)$
$\left(\mathrm{A}_{0}\right) \leftarrow(\mathrm{CY})$
The content of the accumulator is rotated left one position through the CY flag. The low-order bit is set equal to the CY flag and the CY flag is set to the value shifted out of the high-order bit. Only the CY flag is affected.


Cycles: 1
States: 4
Flag: CY

RAR (Rotate right through carry)
$\left(A_{n}\right) \leftarrow\left(A_{n+1}\right) ;(C Y) \leftarrow\left(A_{0}\right)$
$\left(\mathrm{A}_{7}\right) \leftarrow(\mathrm{CY})$
The content of the accumulator is rotated right one position through the CY flag. The highorder bit is set to the CY flag and the CY flag is set to the value shifted out of the low-order bit. Only the CY flag is affected.


Cycles: 1
States: 4
Flags: CY

CMA (Complement accumulator)
$(\mathrm{A}) \leftarrow(\mathrm{A})$
The contents of the accumulator are complemented (zero bits become 1 , one bits become 0 ). No flags are affected.


Cycles: 1
States: 4
Flags: none

CMC (Complement carry)
$(\mathrm{CY}) \leftarrow(\mathrm{CY})$
The CY flag is complemented. No other flags are affected.


Cycles: 1
States: 4
Flags: CY

STC (Set carry)
$(C Y) \leftarrow 1$
The CY flag is set to 1 . No other flags are affected.


## Branch Group

This group of instructions alter normal sequential program flow.

Condition flags are not affected by an instruction in this group.

The two types of branch instructions are unconditional and conditional. Unconditional transfers simply perform the specified operation on register PC (the program counter). Conditional transfers examine the status of one of the four processor flags to determine if the specified branch is to be executed. The conditions that may be specified are as follows:

| CONDITION | CCC |
| :---: | :---: |
| NZ - not zero ( $\mathrm{Z}=0$ ) | 000 |
| $\mathbf{Z}-\operatorname{zero}(\mathrm{Z}=1)$ | 001 |
| NC - no carry ( $\mathrm{C}=0$ ) | 010 |
| $\mathrm{C}-\operatorname{carry}(\mathrm{CY}=1)$ | 011 |
| PO - parity odd ( $\mathrm{P}=0$ ) | 100 |
| PE - parity even ( $\mathrm{P}=1$ ) | 101 |
| $\mathbf{P} \quad-\mathrm{plus}(\mathrm{S}=0)$ | 110 |
| $\mathrm{M}-\operatorname{minus}(\mathrm{S}=1)$ | 111 |

JMP addr (Jump)
(PC) $\rightarrow$ (byte 3)(byte 2)
Control is transferred to the instruction whose address is specified in byte 3 and byte 2 of the current instruction.


```
Jcondition addr (Conditional jump)
    If (CCC),
        (PC) }\leftarrow\mathrm{ (byte 3)(byte 2)
```

    If the specified condition is true, control is
    transferred to the instruction whose address is
    specified in byte 3 and byte 2 of the current in-
    struction; otherwise, control continues sequen-
    tially.
    
CALL addr (Call)
$((\mathrm{SP})-1) \leftarrow(\mathrm{PCH})$
$((\mathrm{SP})-2) \leftarrow($ PCL $)$
$(\mathrm{SP}) \leftarrow(\mathrm{SP})-2$
(PC) $\leftarrow$ (byte 3 )(byte 2)

The high-order 8 bits of the next instruction address are moved to the memory location whose address is one less than the content of register SP. The low-order 8 bits of the next instruction address are moved to the memory location whose address is two less than the content of register SP. The content of register SP is decremented by 2 . Control is transferred to the instruction whose address is specified in byte 3 and byte 2 of the current instruction.


Ccondition addr (Condition call)
If (CC.C),
$((\mathrm{SP})-1) \leftarrow(\mathrm{PCH})$
$((\mathrm{SP})-2) \leftarrow(\mathrm{PCL})$
$(\mathrm{SP}) \leftarrow(\mathrm{SP})-2$
$(\mathrm{PC}) \leftarrow($ byte 3 )(byte 2$)$
If the specified condition is true, the actions specified in the CALL instruction (see above) are performed; otherwise, control continues sequentially.


RET (Return)
$(\mathrm{PCL}) \leftarrow((\mathrm{SP}))$;
$(\mathrm{PCH}) \leftarrow((\mathrm{SP})+1)$;
$(\mathrm{SP}) \leftarrow(\mathrm{SP})+2$;
The content of the memory location whose address is specified in register SP is moved to the low-order 8 bits of register PC. The content of the memory location whose address is one more than the content of register SP is moved to the high-order 8 bits of register PC. The content of register $S P$ is incremented by 2 .


Cycles: 3
States: 10
Addressing: reg. indirect
Flags: none

Rcondition (Conditional return)
If (CCC),
$(\mathrm{PCL}) \leftarrow((\mathrm{SP}))$
$(\mathrm{PCH}) \leftarrow((\mathrm{SP})+1)$
$(\mathrm{SP}) \leftarrow(\mathrm{SP})+2$
If the specified condition is true, the actions specified in the RET instruction (see above) are performed; otherwise, control continues sequentially.


Cycles: 1/3
States: 5/11
Addressing: reg. indirect
Flags: none

RST $n \quad$ (Restart)
$((\mathrm{SP})-1) \leftarrow(\mathrm{PCH})$
$((\mathrm{SP})-2) \leftarrow(\mathrm{PCL})$
$(\mathrm{SP}) \leftarrow(\mathrm{SP})-2$
(PC) $\leftarrow 8 *$ (NNN)
The high-order 8 bits of the next instruction address are moved to the memory location whose address is one less than the content of register SP . The low-order 8 bits of the next instruction address are moved to the memory location whose address is two less than the content of register SP. The content of register SP is decremented by two. Control is transferred to the instruction whose address is eight times the content of NNN.


Program Counter After Restart
PCHL (Jump H and L indirect - move H and L to PC)
$(\mathrm{PCH}) \leftarrow(\mathrm{H})$
$(\mathrm{PCL}) \leftarrow(\mathrm{L})$
The content of register H is moved to the highorder 8 bits of register PC. The content of register L is moved to the low-order 8 bits of register PC.


This group of instructions performs I/O, manipulates the Stack, and alters internal control flags.

Unless otherwise specified, condition flags are not affected by any instructions in this group.

$$
\begin{aligned}
& \text { PUSH rp } \quad \text { (Push) } \\
& ((\mathrm{SP})-1) \leftarrow(\mathrm{rh}) \\
& ((\mathrm{SP})-2) \leftarrow(\mathrm{rl}) \\
& \text { (SP) } \leftarrow(\mathrm{SP})-2
\end{aligned}
$$

The content of the high-order register of register pair rp is moved to the memory location whose address is one less than the content of register SP . The content of the low-order register of register pair rp is moved to the memory location whose address is two less than the content of register SP. The content of register SP is decremented by 2. Note: Register pair rp=SP may not be specified.


PUSH PSW (Push processor status word)
$((\mathrm{SP})-1) \leftarrow(\mathrm{A})$
$((\mathrm{SP})-2)_{0} \leftarrow\left(\mathrm{CY},((\mathrm{SP})-2)_{1} \leftarrow 1\right.$
$((\mathrm{SP})-2)_{2} \leftarrow(\mathrm{P}),((\mathrm{SP})-2)_{3} \leftarrow 0$
$((\mathrm{SP})-2)_{4} \leftarrow(\mathrm{AC}),((\mathrm{SP})-2)_{5} \leftarrow 0$
$((S P)-2)_{6} \leftarrow(\mathrm{Z}),((S P)-2)_{7} \leftarrow(S)$
(SP) $\leftarrow$ (SP) -2
The content of register A is moved to the memory location whose address is one less than register SP. The contents of the condition flags are assembled into a processor status word and the word is moved to the memory location whose address is two less than the content of register SP. The content of register SP is decremented by two.


POP rp (Pop)
$(\mathrm{rl}) \leftarrow((\mathrm{SP}))$
( rh ) $\leftarrow((\mathrm{SP})+1)$
$(\mathrm{SP}) \leftarrow(\mathrm{SP})+2$
The content of the memory location, whose address is specified by the content of register SP, is moved to the low-order register of register pair rp . The content of the memory location, whose address is one more than the content of register SP , is moved to the high-order register of register pait rp. The content of register SP is incremented by 2. Note: Register pair rp=SP may not be specified.


POP PSW (Pop processor status word)
$(\mathrm{CY}) \leftarrow((\mathrm{SP}))_{0}$
(P) $\leftarrow((\mathrm{SP}))_{2}$
$(\mathrm{AC}) \leftarrow((\mathrm{SP}))_{4}$
$(\mathrm{Z}) \leftarrow((\mathrm{SP}))_{6}$
(S) $\leftarrow((\mathrm{SP}))_{7}$
(A) $\leftarrow((\mathrm{SP})+1)$
$(\mathrm{SP}) \leftarrow(\mathrm{SP})+2$
The content of the memory location whose address is specified by the content of register SP is used to restore the condition flags. The content of the memory location whose address is one more than the content of register SP is moved to register $A$. The content of register $S P$ is incremented by 2 .


XTHL (Exchange stack top with H and L )
(L) $\leftrightarrow((S P))$
$(\mathrm{H}) \leftrightarrow((\mathrm{SP})+1)$
The content of the L register is exchanged with the content of the memory location whose address is specified by the content of register SP. The content of the H register is exchanged with the content of the memory location whose address is one more than the content of register SP .

| 1 | 1 | 1 | 0 | 0 | 0 | 1 | 1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

Cycles: 5
States: 18
Addressing: reg. indirect
Flags: none

SPHL (Move HL to SP)
(SP) $\leftarrow(\mathrm{H})(\mathrm{L})$
The contents of registers H and L ( 16 bits) are moved to register SP.


IN port (Input)
(A) $\leftarrow$ (data)

The data placed on the 8 -bit bidirectional data bus by the specified port is moved to register $A$.


Cycles: 3
States: 10
Addressing: direct
Flags: none

## OUT port (Output)

(data) $\leftarrow(\mathrm{A})$
The content of register $A$ is placed on the 8 -bit bidirectional data bus for transmission to the specified port.

| 1 | 1 | 0 | 1 | 0 | 0 | 1 | 1 |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| port |  |  |  |  |  |  |  |  |

Cycles: 3
States: 10
Addressing: direct
Flags: none

EI (Enable interrupt)
The interrupt system is enabled following the execution of the next instruction.


Cycles: 1
States: 4
Flags: none

DI (Disable interrupts)
The interrupt system is disabled immediately following the execution of the DI instruction.


Cycles: 1
States: 4
Flags: none

## HLT (Halt)

The processor is stopped. The registers and flags are unaffected.


Cycles: 1
States: 7
Flags: none

NOP (No op)
No operation is performed. The registers and flags are unaffected.


## RESILTC F YETWORK SPECIFICATIONS:

RESISTANE VALUES:
$\pm 2 \%$ (MAX)
CPERATINT, TEMPERATURE:
$0^{\circ} \mathrm{C}$ TO $+70^{\circ} \mathrm{C}$
TEMFELRATIIRE COEFFICIENT:
$\pm 200$ PPM ${ }^{\circ} \mathrm{C}$ OVER TEMPERATURE
RANGE OF $0^{\circ} \mathrm{C} T O+70^{\circ} \mathrm{C}$
OHERATING VOLTAGE:
6.0 VLI: (MAX)

RUNER FATING:
AT $70^{\circ} \mathrm{C}, 0.7$ YYATT PER PACK
TFACKING RESISTANCE RATIO: 1 $1.0 \%$ ( $1 \wedge \times$ )
STABルLTY:
$\pm 1 \%$ YEAR MAX
OAI LIFE
4. $1 \%$ ( $1 \%$ ) OVER 1000 HOURS

FACKACJE:
DUAL IN LINE - CERAMIC OR PLASTIC


0
1
$N$


NCTES:
UNLEESS OTHERWISE SPECIFIED,

1. PART NO 154500645 -01.

Z HNK STAMAP PRODUGT COOE,
RESSTOF VALIJE, PAAT NO
AND DASH NUMEER MIITH CONTRASTING
COLOR AND MIN 12 HIGH CHARACTERS.
EXCEPT FOR MANUF BATCH NO.

$$
\begin{array}{ll}
\text { E.Go) } \quad 5 E C-902 \\
& R 1 \mathrm{~K} \\
& 4500645-01
\end{array}
$$

$3-$ FOF PROCUCUEMENT SEE LV 4500045
A IDENTIFY PIN ONE CLEARLY ON
TOP OF FPACKAGE.
Copyright © 1976 Intel Corporation

| descraption |  |  |
| :---: | :---: | :---: |
| PARTS LIST |  |  |
|  |  | 3065 ROWERS Satita clara CALIF. 95051 |
| IERMINATILG bA~Fi |  |  |
| ${ }_{\text {S }}^{\text {SIZE }}$ | [DEPT  <br> 410 DRAWING NO. | 0605 |

Schematic drawings for the $S B C-901$ and $S B C-902$ are provided in this appendix. Information and diagrams in this section are subject to change without notice. References should be made to schematics shipped with this module.

RE＇FISTOR NETWOHK＂JFECIFICATIONS：
RESISTANCE VALUES：
$\pm 2 \%$（MAX）
OPERATINIG TFMPERATUGE：
0 ○ $70+7 C^{\circ}$
TEMFCRKATHAE GOFFFEIENT：
ICOD PIMM／OC．OVER TEMAFERATIHE
RANEE OF $0^{\circ} \mathrm{C}$ TO $+\%^{\circ} \mathrm{C}$
O ERATHSG，V．引TADE．
C．O VE：（FiNA）
menit：hattris：
AT $7 U^{\circ} C, 0.7$ YYATT PER PACK
TRACKING HEOMANSE RAT：O．
$\pm 1.6 \%$（1Ax）

$\pm 1 \%$ YEAF（ 1 AK）
LUAN LIFE：
$\pm 1$＂f（ $\angle R$ ）OVCF 1000 Hothe：
FACKAINE：
daAL in linje chiramarr os plastio



N以だが
UNLESS JTHCRWIJE．SPECIFIED，
1．PAMT NO 15，45COrs44－0t．
IS NIA GTANAP FRODUCT CODE，
HI AT R VAGLUF DAHT NO，ANO
DASH NUMBEK WITH SNITRAOTING
GLive NVK USING MIN .05

－xcirt MANMA「 FAJCl AK．
（c） $\mathrm{BC}-201$
Rとご，330
＋500e44－01

3．PDR PROCLIREMENT＂JEE LV 4ECó44 C）．
$\rightarrow$ HKENTFY WIN ONE CLEARLY GN ON：OF PACKAGE．

## APPENDIX E

SBC 80P MONITOR PROGRAM LISTING

8080 MACRO ASSEMBLER, VER $2.4 \quad$ ERRORS $=0$ PAGE 1
$80 / 10$ MONITOR, VERSION 1.1, 1 NOVEMBER 1976

TITLE $80 / 10$ MONITOR, VERSION $1.1,1$ NOVEMBER 1976'
;
***********************************************************************
; ***********************************************************************
$80 / 10$ MONITOR
M80/10
VERSION 1.1
1 NOVEMBER 1976

```
***************************************************************************
```


(C) 1976 INTEL CORPORATION, ALL RIGHTS RESERVED. NO PART OF THIS PROGRAM OR PUREICTITON NRY EE REPRODUCED, TRANSMITTED, NRANSCRIBED, STORED IN A RENPIEVAL SYSTEM, OR TRANSLATED INTO ANY LANGUAGE OR COMPUTER LANGUAGE, IN ANY FORM OR BY ANY MEANS, ELECTRONIC, MECHAMTCAL, UAGNETIC, OPTICAL, CHEMICAL, MANUAL OR OTHERWISE, WITKOUR TEE PRIOR WRITTEN PERMISSION OF INTEL CORPORARION, 3065 EONERS AVENUE, SANAA CLARA, CALIFORNIA 95051.


ASSTRAC:
$=======$
THIS PROGEAY RUNS ON THE SBC $8 G / 10$ BOARD AND IS DESIGNED TO PROVIDE
THE USER WITH A GTNTYAL MONTTOR BY USING THIS RROGRAM,
TEE USER CTN EXAAIEE AND CFANCE MEMORY OR CPU REGISTERS, LOAD
A FROGRNM (IN hBSOLUTE HEX) INTO RAM, AND EXECUAE INSNRUCTIONS
ALREAEY IN KE:GOX. THE MONITOR ALSO PROVIDES THE USER HITH
ROUMINES FOR FEREORMING CONSOLE I/O ALVD PAPER TAPE I/O.
PROGRAM ORGANIZATION
$=================$

THE LISTING IS ORGANIZED IN THE FOLLOWING WAY FIRS' THE EASIC MONITOR EUNCTYONS TOGETHER WITH THE CONSOLE I/O ARE LOCATED IN THE EIRST IK OR ROM FOLLONED BY LIE PAPER TAPE FUNCTIONS AND I/O IN THE SECOND $1 K$ OF RON. WITHIN THE FIRST ROM IS CONTAINED THE COMMAND RECOGYIZER, WHICH IS TAE HIGHEST LEVEY FOUTINE IN THE PROGRAM. NEXI THE ROUTIAES TO IMPLEMENT THE VARIOUS COMHANDS. FINALLY, THE UTILIMY ROUTINES WHICH ACMUAILY DO THE DIRTY WCRK. WITHIN EACH SECTION, THE ROUTINES ARE ORGANIZED IN ALEHABETICAL
ORDER, EY ENTRY POINT OF THE ROUTINE. THE SECOND ROM IS ORGANIZED
IN THE SAME MANNER AS THE FIRST WITH THE ROUTINES BHICH IMPLIMENT


8080 MACRO ASSEMBLER, VER $2.4 \quad$ ERRORS $=0$ PAGE 2
$80 / 10$ MONITOR, VERSION 1.1, 1 NOVEMEER 1976

```
; MORE DETAILED OPERATIONS.
```



```
RGM NEED NGT EE FLUGGED INTO THE EOARD IF ONLY THE BASIC MONITOR
functions are required. honever if the paper tape fuctions are desired
bota rons are requiked.
; TAIS PROGRAM EXPECTS TO RUN IN TEE FIRST 2K OF ADDRESS SPACE.
; If, FOR SORE fEASCN, TiE PROGGAM IS RE-ORG'ED, Chre Sholld
; BE tAKEN to make SURE that the TRANSFER INSTRUCTIONS FOR RST l
; AND RST }7\mathrm{ ARE ADJUSTED APERORRIATELY.
;
; The prograd blso expects that ram locations 3Cogh to 3C3Fa,
; INCLUSIVE, ARE RESERVED FOR THE PROGRANM'S OFN USE. TGESE
; LOCATIONS MAY BE ALTERED, HOWEVER, BY CHANGING THE EQU'ED
; SYMBOL "DATA" AS DESIRED.
LIST OF FUNCTIONS
LI== -= ====&-N
********
    l ST ROM
    GEFCM
    -----
        ECMD
        ccsi
        ICSD
        NCND
        RCXD
        SCMD
        NCND
        MCND
    XCMD
    ADRD
    ADROUT
    bricak
    CI
    C:VVDN
    CO
    CRCUT
    ECHO
    ernor
    FRET
    GETCH
    GETHX
    GETHX
    GETNM
    BILO
```

```
8080 MACRO ASSEMSLER, VER 2.4 ERRORS = C PAGE 3
    80/10 MONITOR, VERSION 1.1, 1 NOVEMEER 1976
```

```
INUST
    WMOUT
    PRVAL
    REGDS
    RGRER
    RSTTE
    sami
    smbe
    STHLE
    valeg
    VaLDL
    ---
    ******
    2 BD ROM
    ********
    RCMD
    CMD
    --
ByTE
DELAY
LEAD
parz
peyte
PEOE
PEOL
Mo
RIC:
R1:
```

ORG
0 B
; ; *****************************************************************
MONITOR EQUATES
;

;
0018
3C3D
3C3D
3FA
925
ooed
eoec
geec

BRCHR EQU
ERLOC EQU
ERLCC EQJ
ERATB EQU
CAD EQU
CNCTL EQU
CNIN EQU
CNOUT EOU

15H
; CODE FOR EREAK CHARACTER (ESCAPE)
3 CBDH : LOCATION OF USER BRANCH INSTRUCTION IN RAM
3 FAH - : LOCATION OF STAPT OF ERANCH TABLE IN ROM
025 H : COMMAND INSTRUCTION FOR USART INITIALIZATION
$\begin{array}{ll}025 H \\ O E D H & \text {; COMMAND INSTRUCTION FOR USAR } \\ \text { (USOL }\end{array}$
; console infut port
geca ; CONSOLE OUTPUT PORT

```
OED
300D
3COJ
0018
602F
ODFE
OEEA
OOCE
E^OF
CO7E
3C2E
C002
0038
C013
*13
301
OLEF
C204
0027
0283



```

; EUNCTION: ICMD

```
; INPUTS: NONE
- OUTPUMS: NONE
; CALLS: ERROR, ECHO, GETCH, VALDL, VALDG, CNVBN, STKLF, GETNM, CROUT
; DESTSOXS: A,E,C,D,E, H,L,F/F'S
; DESCRIPTION: ICMD IMPLEMENTS THE INSERT CODE INTO MEMORY (I) COMMAND.
ICMD:
\begin{tabular}{|c|c|}
\hline \multicolumn{2}{|l|}{OEA9} \\
\hline 20． 9 & QE01 \\
\hline A3d 3 & CD5E 2 \\
\hline ceas & 2EFF \\
\hline ¢2ご & 323A3C \\
\hline 2ัこ3 & D 1 \\
\hline \multicolumn{2}{|l|}{OCE4} \\
\hline Cここ4 & Cこ28（J2） \\
\hline ¢037 & Canget \\
\hline セ2こ． & 79 \\
\hline 0032 & EE1E \\
\hline \＆2こD & CnEs（0） \\
\hline E2こO & CD823 \\
\hline \multicolumn{2}{|l|}{1 1} \\
\hline 80．\({ }^{\text {a }}\) & 1 EAS400 \\
\hline 0956 & cD67（3） \\
\hline & 1 \\
\hline coc9 & 1 D 2530 \\
\hline gocc & CDDE（1） \\
\hline ECCE & 4 F \\
\hline C25\％ & CD48（23） \\
\hline ¢2こう & 3 A 2 A 3 C \\
\hline ces6 & 37 \\
\hline とくこ7 & C2LS \({ }^{(1)}\) \\
\hline 202＊ & 13 \\
\hline \multicolumn{2}{|l|}{2LSE} \\
\hline c¢LS & EEFE \\
\hline CSED & 323A3C \\
\hline COEz & C33（en） \\
\hline \multicolumn{2}{|l|}{O2E3} \\
\hline 2¢E3 & c＝30 03 \\
\hline E0E5 & C3220 \\
\hline \multicolumn{2}{|l|}{OOES} \\
\hline B0E9 & \(\cos 03\) \\
\hline GEEC & C317（2） \\
\hline
\end{tabular}



\begin{tabular}{|c|c|c|c|c|c|c|}
\hline & 0167 & 55 & nov & E,M & & \\
\hline & d168 & 1630 & MVI & D, DATA & & 8 ; fetch address of Save location from \\
\hline & 0. 6 A & 23 & INX & H & & - /Table \\
\hline & Ei6B & \& & MOV & B, M & & fetch length ming from table \\
\hline & cl6C & DS & PUSH & D & S & save fderess of save location \\
\hline & C16D & D5 & pust & D & & \\
\hline & 215E & E1 & P02 & \% & ; & MOVE ADDEESS TO hl \\
\hline & ci6F & C5 & PUS: & E & & SAve lexictit flag \\
\hline & Ci70 & 7 E & MOV & A, 4 & & GEit a bits of register from save location \\
\hline & 8172 & CEC202 & Colle & wour & & DISplay It \\
\hline & 0174 & F1 & fop & PSi & & get back leagti flag \\
\hline & 8175 & F5 & pust & PSW & & SAVE it mgain \\
\hline & ¢176 & E7 & ORA & A & & SE' F/E'S \\
\hline & Q177 & Camp01 & JZ. & XCM20 & & If 8 bit register, nothing more to display \\
\hline & ¢17a & 23 & ECX & H & ; & ELSE, for 16 Bit register, GE't LOWER 8 bits \\
\hline & 0173 & 75 & NOO & A, M & & \\
\hline & 0170 & \(\operatorname{coc} 202\) & CALL & NMOUT & D & dispeay tiem \\
\hline & E17e & & XCM20: & & & \\
\hline & 617 F & CE2D & MVI & C, '-' & & \\
\hline & 0181 & CDF901 & Cisle & ECHO & & USE dASH AS SEPARATOR \\
\hline & 0184 & CD2702 & CALL & GETHX & & See if there is a value to put into register \\
\hline & & 1 & + EALSE & xCN30 & & NO - GO CHECK FOR NEXT REGISTER \\
\hline & ¢187 & 1029561 & + JNic &  & & \\
\hline & 018 A & 74 & nCV & A, D & & \\
\hline \(\stackrel{1}{1}\) & 0188 & 323A3C & STA & temp & & ElSE, SAVE the terminator for now \\
\hline \(\stackrel{\sim}{\omega}\) & 018 E & Fl & POP & PSW & & get beck dengri flag \\
\hline & © 10 F & E1 & POP & H & & put dolness of save location into hl \\
\hline & 0190 & E 7 & ORA & A & & SEP F/F'S \\
\hline & 0191 & CA9601) & J2 & XCM25 & & If 8 bit megister, DRANCH \\
\hline & C194 & 70 & nOV & \(\cdots\) & & Save crper 8 bits \\
\hline & 8155 & 28 & LCX & H & & POINT TO SAVE LOCATION gOR LOKER 8 bits \\
\hline & 0196 & & xCr25: & & & \\
\hline & 2196 & 71 & Sov & M, C & ; & Store all ce 8 bit or lower \(1 / 2\) of 16 bit reg \\
\hline & 0197 & & XCM27: & & & \\
\hline & 8197 & 110306 & LXI & D,RTABS & ; S & SIze of egtry in raib tazle \\
\hline & 019A & E1 & POP & H & & pointer lito register tasie rtab \\
\hline & 8198 & 19 (101 & DAD & D & & Ade entry size to pointer \\
\hline & C19C & C35401) & JMP & xcald & ; & do next register \\
\hline & 0195 & & xcm30: & & & \\
\hline & 0198 & 7 A & MOV & A, D & & GET TERMINATOR \\
\hline & 01 AO & 323 3 3 C & STA & TEMP & & SAVE IN MEMORY \\
\hline & 8143 & D1 & POP & D & ; & clear stack of lengta glag and address \\
\hline & 01 d 4 & D1 & POP & - & & /OF SAVE Location \\
\hline & 0145 & C39 \(\sqrt{81}\) & - JMP & XCM27 & ; & GO INCREMENT REGISTER TABLE POINTER \\
\hline & & & & & & \\
\hline & & & \multicolumn{4}{|l|}{\multirow[t]{2}{*}{\begin{tabular}{l}
 \\
;
\end{tabular}}} \\
\hline & & & & & & \\
\hline & & & \multirow[t]{2}{*}{: UTILITY ROUTINES} & \multicolumn{3}{|r|}{\multirow[t]{2}{*}{Utility routines}} \\
\hline & & & & & & \\
\hline
\end{tabular}
```

; ;********************************************************************
;
.*********************************************************************
;
FUNCNION ADRD
INQUNS: HL - ADDRESS TO BE DISELAYED
OMMPCTS: NONE
CALLS: NMOUm
DESIFOYS: A
DESCRIPNION: ADRD OUTPUTS TO THE CONSOLE THE ADDRESS
;
ADRD:

```
\(\begin{array}{ll}01 \pi 5 & 7 C \\ 0159 & C D C 202 \\ \text { G1AC } & 7 \mathrm{D}\end{array}\)
E1.2 \(\operatorname{ccc} 2(62)\)
8250
\(\stackrel{7}{2}\)


80/10 MONITOR, VERSION 1.1, 1 NOVEMBER 1976


```

880 MACRO ASSEMBLER, VER 2.4 ERRORS =0 PAGE 17
80/10 MONITOR, VFRSION 1.1, 1 NOVEMBER 1976
INPUTS: NONE
; CALLE: NOMHINGG
; CALLS: NONGING
DESCRIPTICN: FRET IS JUMPED TO BY ANY ROUTINE THAT WISIES TO
DESCRIPMICH: FRET IS JUMPED TO BY ANY ROUTINE THAT WISHES TO
FALSE, LEHOTING EAILURE, AND THEN RETURNS TO THE
FALSE, LEHOTTNG EAILURE, AND THEN RETURNS TO THE
;
ERET
221D
215
215
37
37 STC
; EIRST SET CARRY TRUE

- THEN COUPLEMENY IT TO MAKE IT FALSE
RET ; RETURN APPRORRIATELY
;
;
;
; EUNCTION: GENCH
INPUTS: NONE
OUAPUZS: C - NEXT CHARACTER IN INPUT STREAM
CALLS: CI
CALLS: CI
DESCRIPTION: GETCH RETURNS TBE NEXT CGARACTER IN THE INPUT STREAM
; D
GETCH:
0220
0223
\&225
E67
C9
;
YS: CARRY
CAL
STC ; ; THEN COMPLENENT IT T
;*****************************************************************************
;
TO THE CALLING PROGRAM.
N
GETCH:
CLLL CF
CI
CI ; GET CHARACTER EROM TERMINAL
CELL
PRTYO : GET CNAR OFF FARITY BIT IN CASE
NNI
PRTYO : TURN OFF FARITY BIT IN CASE SET BY
; GET CHARGCTER EROM TERMINAL
MOV
RET
8226
;
;**********************************************************************
;**
FUNCTION: GETHX
FUNCTION: GET
INPUTS: NONE
; INP
OUTPUTS: EC - IG BIT INTEGER
EC - IG BIT INTEGER
CARRY - I IF FIRST CIMARACIER NOT DELIMIMER
;
CALLS: GETCH, ECIHO,VALDL,VALDG,CNVBN,ERROR
DESTROYS: A,B,C,D,E,E/F'S
DESIROYS: A,B,C,D,E,F/F'S
DESCRIPTION: GETEX ACCEPTS A STRING OE HEX DIGITS FROM THE INPUT
STRINAM AND RETURNS THEIR VALUE AS A I6 BIT BINARY
INTHEGER. IF MORE THAN 4 HEX DIGINS ARE ENTERED,
ONIY THE LAST A ARE USED. THE NUMBER TEKMINATES WHEN
A VALID DELIMITER IS ENCOUNTERED, THE DELIMITER IS
ALSO RETURNED AS AN OULTPUTT OF THE FUNCTION. TLLEGAL
CHARACTERS (NOT HEX DIGITS OR DELIMITERS) CAUSE AN

```

8080 KACRO ASSEMBLER, VER 2.4
8\&/10 MONITOR, VERSION 1.1. 1 NOVEMBER 1976


```

    0299 3D GNM30:
    829A
029B
829C
8290
E-21

```
```

| DCR | A | decrenent residual count |
| :---: | :---: | :---: |
| RM |  | If NEGATIVE, PROPER RESULTS ON |
| POP | H | ; ELSE, GET RETURN addr |
| XTHL |  | Replace mop result with return |
| JMP | GNm 30 |  |

```
;
```

;

```
;
;
;
;
********************************************************************
********************************************************************
********************************************************************
;
;
;
FUNCTIOR: HILO
FUNCTIOR: HILO
FUNCTIOR: HILO
INPUTS: DE - 16 BIT IMMEGER
INPUTS: DE - 16 BIT IMMEGER
INPUTS: DE - 16 BIT IMMEGER
NNEUN: HE - 16 BIT MWmEGER
NNEUN: HE - 16 BIT MWmEGER
NNEUN: HE - 16 BIT MWmEGER
OUTPUTS: CARRY - O IF HL<DE
OUTPUTS: CARRY - O IF HL<DE
OUTPUTS: CARRY - O IF HL<DE
N - IF HL>=DE
N - IF HL>=DE
N - IF HL>=DE
CALLS: NOTHING
CALLS: NOTHING
CALLS: NOTHING
DESTROYS:A,F/E'S
DESTROYS:A,F/E'S
DESTROYS:A,F/E'S
DESCRIPTION: HILO COMPARES THE 2 16 BIT INTEGERS IN HL AND DE, THE
DESCRIPTION: HILO COMPARES THE 2 16 BIT INTEGERS IN HL AND DE, THE
DESCRIPTION: HILO COMPARES THE 2 16 BIT INTEGERS IN HL AND DE, THE
;
;
;
;
;
;
HILO:
HILO:
HILO:
\begin{tabular}{ll}
\(A 2 A O\) & \\
\(B 2 A D\) & \(C 5\) \\
\(C 2 A D\) & 47
\end{tabular}
@2A2 23
02&3 7C
C22.4 B5
c2%5
C2A6 37
02&7 CAFR(02)
G2A7
32AA
2A.B 93
2AC 7C
32AD 9A
C2AE 3F
G2AF 78
OEG Cl
021 C9
```



```
DCR A ; DECRENENT RESIDUAL COUNX
```

DCR A ; DECRENENT RESIDUAL COUNX

```
DCR A ; DECRENENT RESIDUAL COUNX
POP H ; ELSE, GET RETURN ADER
POP H ; ELSE, GET RETURN ADER
POP H ; ELSE, GET RETURN ADER
TRY AGAIN
TRY AGAIN
TRY AGAIN
                                    INTEGERS ARE TREATED AS UNSIGNED NUMBERS. THE CARRY
                                    INTEGERS ARE TREATED AS UNSIGNED NUMBERS. THE CARRY
                                    INTEGERS ARE TREATED AS UNSIGNED NUMBERS. THE CARRY
                                    BIT IS SET ACCORDING TO TKE RESULT OE THE COMPARISON.
                                    BIT IS SET ACCORDING TO TKE RESULT OE THE COMPARISON.
                                    BIT IS SET ACCORDING TO TKE RESULT OE THE COMPARISON.
            MUSH
            MUSH
            MUSH
            MOV A,H : WANT TO TEST FOR O RESULE AFTER
            MOV A,H : WANT TO TEST FOR O RESULE AFTER
            MOV A,H : WANT TO TEST FOR O RESULE AFTER
            ORA L :/INCRENENTING
            ORA L :/INCRENENTING
            ORA L :/INCRENENTING
            OCX H : RESTORE HL
            OCX H : RESTORE HL
            OCX H : RESTORE HL
            ; SET CARRY
            ; SET CARRY
            ; SET CARRY
            Jz HILO5
            Jz HILO5
            Jz HILO5
            MOV A,L ; IF NOT, MOVE MS SEF PRORERLY
            MOV A,L ; IF NOT, MOVE MS SEF PRORERLY
            MOV A,L ; IF NOT, MOVE MS SEF PRORERLY
            M,L i IE NOT,MOVE i TO A
            M,L i IE NOT,MOVE i TO A
            M,L i IE NOT,MOVE i TO A
    SUB E ; SURTRACT E
    SUB E ; SURTRACT E
    SUB E ; SURTRACT E
    SOV A,H : MOVE H TO A
    SOV A,H : MOVE H TO A
    SOV A,H : MOVE H TO A
    S3E 0: SUBTEACT D HIRA BOREOW
    S3E 0: SUBTEACT D HIRA BOREOW
    S3E 0: SUBTEACT D HIRA BOREOW
            CMC : COMPLIMENT CARRY FOR CORRECT CARRY BI'S VALUE
            CMC : COMPLIMENT CARRY FOR CORRECT CARRY BI'S VALUE
            CMC : COMPLIMENT CARRY FOR CORRECT CARRY BI'S VALUE
HILO5:
HILO5:
HILO5:
    MOV A,B ; EESTORE A
    MOV A,B ; EESTORE A
    MOV A,B ; EESTORE A
    POP B ; RESTORE BC
    POP B ; RESTORE BC
    POP B ; RESTORE BC
    RET ; EXIT
    RET ; EXIT
    RET ; EXIT
;
;
;
;**
;**
;**
;
;
;
: FUNCTION INUST
: FUNCTION INUST
: FUNCTION INUST
    INEUNS: NONE
    INEUNS: NONE
    INEUNS: NONE
    OUTPUMS: ROTHING
    OUTPUMS: ROTHING
    OUTPUMS: ROTHING
CALLS: NOTHTNG
CALLS: NOTHTNG
CALLS: NOTHTNG
CALIS: NCTHING
CALIS: NCTHING
CALIS: NCTHING
- DESTROYS: A,H,L,SP
- DESTROYS: A,H,L,SP
- DESTROYS: A,H,L,SP
; DESCRIPTION: INUST OUTPUTS TO TEE USART THE COMMAND FORD
```

; DESCRIPTION: INUST OUTPUTS TO TEE USART THE COMMAND FORD

```
; DESCRIPTION: INUST OUTPUTS TO TEE USART THE COMMAND FORD
```

```
8080 MACRO ASSEMELER, VER 2.4 ERRORS = 0 PAGE 21
80/10 MONITOR, VERSION 1.1, 1 NOVIMDER }197
```

AND INITIALIZES THE STACK POINTER.

```
iNUST:
```

iNUST:
8282
0234
0256
3259
2こC
2DF
E-22

| $02 C 2$ |  |
| :--- | :--- |
| $02 C 2$ | $E 5$ |
| $22 C 3$ | $6 F$ |
| $02 C 4$ | $E F$ |
| $22 C 5$ | $E F$ |
| $02 C 6$ | $0 F$ |
| $C 2 C 7$ | $C D E 5 Q 2$ |
| $22 C 2$ | $C D E 9 G 1$ |
| $22 C D$ | $E 1$ |
| $02 C E$ | $C D E 502$ |
| $22 D 1$ | $C D F 901$ |
| $02 D 4$ | $C 9$ |

    MVI A,CMD
    MVI A,CMD
    DSED OUT CNCTL ; OUTPUT COMMAND NORD TO USART
    DSED OUT CNCTL ; OUTPUT COMMAND NORD TO USART
    2162%哖
    312E3C
    C31E60
    I,MSTAK-44 ; LOAD PCINAER TO STACK
    I,MSTAK-44 ; LOAD PCINAER TO STACK
    SHLD SSAVE ; INITIALIZE USER STACK POINIEER
    SHLD SSAVE ; INITIALIZE USER STACK POINIEER
    LXI SP,:STAK ; INITIALYZE NONITOR STACK
    LXI SP,:STAK ; INITIALYZE NONITOR STACK
    J!P SOMSG ; GO TO PRINT SIGNON MESSAGE
    J!P SOMSG ; GO TO PRINT SIGNON MESSAGE
    ;
;
;
;
************************************************************************
************************************************************************
•
•
EUNCmION: NMOUT
EUNCmION: NMOUT
INPU_S: A - 8 SII INTEGER
INPU_S: A - 8 SII INTEGER
OUMPUMS: NONE
OUMPUMS: NONE
CANLS: ECriO, PRVMT
CANLS: ECriO, PRVMT
DESmzovs: M, b,C-DE
DESmzovs: M, b,C-DE
DESTRCNS: A,B,C,E/E'S
DESTRCNS: A,B,C,E/E'S
DESCRIPMICN: NOUTT CONVERTS THE 8 BIT, UNSIGNED INTEGER IN IRE
DESCRIPMICN: NOUTT CONVERTS THE 8 BIT, UNSIGNED INTEGER IN IRE
; DESCRIPARN: A KEGISTER INTO 2 ASCII CHARNCTERS, THE ASCII CHARACTERS
; DESCRIPARN: A KEGISTER INTO 2 ASCII CHARNCTERS, THE ASCII CHARACTERS
AKE THE ONES FEPRESENMING THE 8 BITS. THESE TNO
AKE THE ONES FEPRESENMING THE 8 BITS. THESE TNO
CHARACMERS ARE SENT TO THE CONSOLE AT THE CURRENT PRINT
CHARACMERS ARE SENT TO THE CONSOLE AT THE CURRENT PRINT
POSITTON OF THE CONSOLE.
POSITTON OF THE CONSOLE.
;
;
PUSH PSW : SAVE ARGUMENT
PUSH PSW : SAVE ARGUMENT
8202
PUSH
PUSH
RRC
RRC
RSC
RSC
RRC ; GET UPYER \& BITS TO LOW \& BIT POSITIONS
RRC ; GET UPYER \& BITS TO LOW \& BIT POSITIONS
CELL PRVAL ;COAVBRT LONER G BITS TO ASCII
CELL PRVAL ;COAVBRT LONER G BITS TO ASCII
CALL EC:O : SENO TO TEEYINAL
CALL EC:O : SENO TO TEEYINAL
FOP FSK; GET BACK ARGUMENT
FOP FSK; GET BACK ARGUMENT
CALL PRVAL
CALL PRVAL
CALE ECHO
CALE ECHO
RET
RET
RET
RET
;
;
;
;
;
;
FUNCRION: PRVAL
FUNCRION: PRVAL
INPUES: A - INTEGER, RANGE E TO E
INPUES: A - INTEGER, RANGE E TO E
INPUES: A - INTEGER, RANGE E
INPUES: A - INTEGER, RANGE E
OUTPUTS: A - AS
OUTPUTS: A - AS
DESTKOYS: NOTHING
DESTKOYS: NOTHING
DESCRIPTION: PRVAL CONVERTS A. NUMBER IN THE RANGE O TO F HEX TO
DESCRIPTION: PRVAL CONVERTS A. NUMBER IN THE RANGE O TO F HEX TO
THE CORRESPONDING ASCII CHARACTER, G-9,A-F. PRVAL
THE CORRESPONDING ASCII CHARACTER, G-9,A-F. PRVAL
DOES {OT CHECK THE VALIDITY OF ITS INPUT ARGUMENT.

```
                    DOES {OT CHECK THE VALIDITY OF ITS INPUT ARGUMENT.
```




```
E-25
```

```
;
```

;
;
;
;
;
RSTTF:
RSTTF:
8327
032B D1
032C
032D
E 32E 2m3838
0331 F9
0332 2A363C
0335 E5
0336 2A3436
8339
033A

```







```

        8&80 FIACRO ASSEMDLER, VER 2.4.4, 1 NOVEMBERRRORS = 0 PAGE 31
            8&/10 MONITOR, VERSION 1.1, 1 NOVEMBER 1976
    ```

```

8080 MACRO ASSEMBLER, VER 2.4 ERRORS = 0 PAGE 32
80/10 MONITOR, VERSION 1.1, 1 NOVEMBER 1976
: DESTROYS: F/E'S
; DESCRIPTION: DELAY PROVIDES A PROGRANMED DELAY OF 1 MILLISECOND
;
DELAY:

```

```

4B4
4R5 C28404
4B8
0459

```

\begin{tabular}{ll}
\(04 B A\) & \\
\(64 B A\) & \(063 C\) \\
\(343 C\) & \\
\(84 B C\) & \(0 E 00\) \\
\(04 B E\) & \(C D 3 F 35\) \\
\(84 C 1\) & 65 \\
\(64 C 2\) & \(C 2 E C 04\) \\
\(84 C 5\) & \(C 9\)
\end{tabular}
```

                    : D
                                    FOR TAPE FEADER OPERATION
                            , ONEMS
                                    B : DECREMENM INNER COUNTER
    C23404
    Cl
    DELI:
DCR
JNZ
MNZ
DELI ; JUMP IE NOT LONE
RET
- RESTORE BC REGISTERS
; RETURN tO CALLING ROUTINE
;
i
FUNCTION LEAD
INPUNS: NONE
INPUNS: NONE
OUTPUTS: NONE
CALLS: PO
DESTROYS: B,C,F/F'S
DESCRIPTIOM: LEAD OUTPUTS 6O NULL CHARACNERS TO PAPER TAPE TO FORM A
LEAD:
LEADER.
MVI B,60 ; LOAD B WITA A COUNT OF 60
EEOS:
MVI C,O
MVLLL FO : PUNCU NULL CHARACTER
DCR F B ; DECREMENT COUNT
JN2 LEG5 : DO IT AGAIN IF NOT LONE
;
;*********************************************************************
EUNCTION EADR
INDUTS: HL - ADDRESS TO BE PUNChED
OUMPUSS: NCNE
; CALLS: PBYTE
CAL

- DESTROYS: A
DESCRIPTION: PADR PUNCHES ON THE TELETYPEWRITER THE ADDRESS
; DESCRIPTION: PADR PUNCHES ON THE TELETYPEWRIT
:
PADR:
MOV A,H P PUNCH FIRST HALF OF ADDRESS
04C6 7C PADR:
MOV A,L : PUNCB SECOND HALP OF ADDRESS

```
```

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```


- FUNCTION RICH
INPUTS: NONE
OURPUAS: A - ZERO, CARRY - I IF END OF FILE
a - Character, carry - O if vadid character
CALLS: RI
DESTRGYS: A,F/F'S
DESCRIPAION: RICH TESTS EOR AN END OF EILE CONDITION.
i
8513 CDICOS
\(\begin{array}{ll}0513 & \text { CD1C05 } \\ 2516 & \text { DA1282 }\end{array}\)
8519
2510
E67E
C 9
\(E-36\)
RICH:

JC ERTOR
ANI PKTYE
- READ A CHARACTER FROM TAPE
    ANI PKTYE
    RET \(\quad\); REMOVE PARITY BIN ROUN TO CALLING ROULE
;
;
;
; FUNCTION RI
INPUMS: NONE
OUMPULS: A - ZLRO, CARRY - 1 IF END OF FILE
                            A - CHARACTER, CARRY - B IF VALID CHARACTER
CALLS: DELAY
DESTROYS: A,F/F'S
DESCRIPAION: RI READS A CHARACTER FROM THE TTY TAPE READER
;
RI:
PUSH B ; SAVE BC
    - READ IN USAFT sTATUS
    READ IA USART STATUS BUFEER EMPTY
    RIOS ; TRY AGAIN IF HOT EMPTY
    A, mTYADV : ADVARCE THE TAPE
    Anicme ; OUTPUT THE ADVANCE COMNAND
    B: 4 E ; HETIALI2E TIMER FOR 40 MS
    DELAY : DELAY FOR 1 MILLTSECONDS
    B ( DECREMEND TIMER
RIE7 ; JUNP IF TIMER NOT EXPIRED
A,CMD : STOP THE READER ADVANCE
CNCTL : OUTPUT STOP COMMAND
B, 250 : INITIALIZE TIMER \(F O R 250\) MS.
COAST ; INPUT REAEER STATUS
RBR ; CHECK FOR RECEIVER BUFFER READY
KII5 ; YES - DATA IS READY
DELAY ; DELAY 1 KS
B : DECRENENT TTMER
RIIG - JUMF IF TIMER NOT EXPIRED
A - 2ERO A
    2ERO A
    ; SET CARKY INDICATING EOF

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\section*{NO PEOGRAM ERRORS}

80/10 NONITGR, VERSION 1.1. 1 NOVEMBER 1976

SYMBOL \(2 A B L E\)
* 01

- 02

03
- 84

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[^0]:    ${ }^{1}$ In this role, cable modifications must be made to conform with RS232 standards.

